

## 具有集成偏置电源的 LM36272 双通道 LCD 背光驱动器

### 1 特性

- 可驱动多达两个并联的白色发光二极管 (LED) 串 ( $V_{OUT}$  最大值为 29V)
- 11 位指数和线性调光控制
- 脉宽调制 (PWM) 和  $I^2C$  亮度控制
- 采用 4.7 $\mu$ H 到 15 $\mu$ H 电感的背光操作
- 背光和液晶显示屏 (LCD) 偏置效率高达 92%
- 可编程 LCD 偏置电压 ( $\pm 4V$  到  $\pm 6.5V$ , 分辨率为 50mV), 每个输出的电流高达 80mA
- 60 $\mu$ A 到 30mA 范围内的 LED 电流匹配度为 0.2%
- 60 $\mu$ A 到 30mA 范围内的 LED 电流精度为 1%
- 输入电压范围: 2.7V 至 5V

### 2 应用

- LED 数最多可达 16 个的 LCD 面板
- 智能手机
- 平板电脑和游戏平板电脑
- 家庭自动化面板

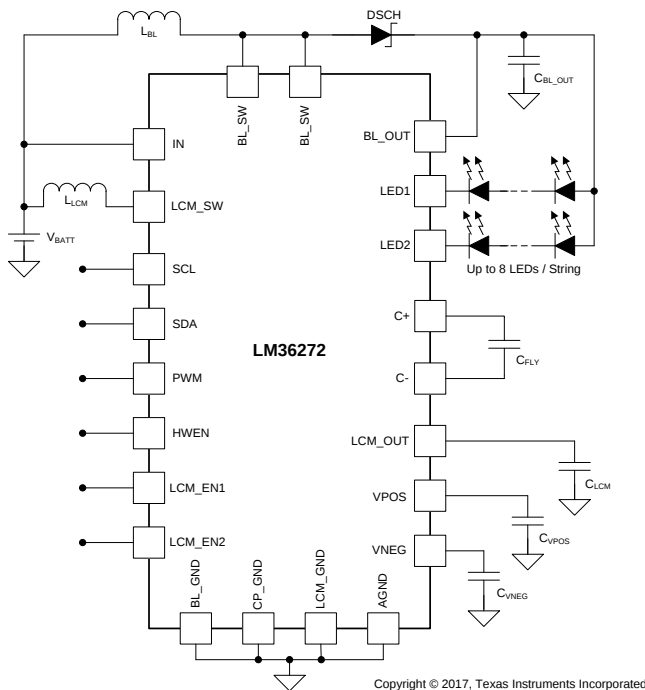
### 3 说明

LM36272 是一款集成式双通道 WLED 驱动器及 LCD 偏置电源。LM36272 拥有超紧凑外形、高效率、高集成度和可编程性等特性, 因此适用于各种应用, 而且无需更换硬件, 同时还能够最大限度地减小整体解决方案尺寸。

背光升压转换器可提供电源以偏置两个并联 LED 串, 总输出电压最高可达 29V。11 位 LED 电流可通过  $I^2C$  总线进行编程, 并且/或者可通过介于 60 $\mu$ A 和 30mA 之间的逻辑电平 PWM 输入进行控制。每个 LED 串均可单独使能或禁用, 从而实现区域调光功能。采用 4.7 $\mu$ H 到 15 $\mu$ H 的电感即可高效操作背光升压转换器, 从而优化效率和解决方案尺寸。

LCD 偏置升压转换器为正低压降稳压器 (LDO) 和反向电荷泵供电。正负偏置电源均提供了可编程的输出电压 ( $\pm 4V$  到  $\pm 6.5V$ , 步长为 50mV) 以及高达  $\pm 80mA$  的电流能力。自动排序功能可通过编程设定从正到负偏置激活的延迟, 并且具有附加的可编程电压转换率控制。凭借两种唤醒模式, 两个偏置输出可通过单一外部信号进行控制, 并且能够以超低的静态电流消耗保持工作状态。

简化原理图

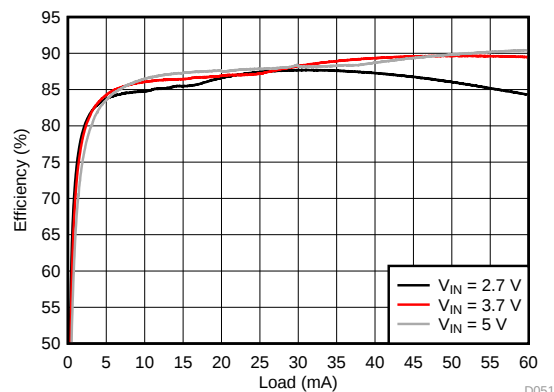


器件信息(1)

| 器件型号    | 封装         | 封装尺寸 (最大值)      |
|---------|------------|-----------------|
| LM36272 | DSBGA (24) | 2.44mm × 1.67mm |

(1) 要了解所有可用封装, 请参见数据表末尾的可订购产品附录。

背光效率, 2P8S



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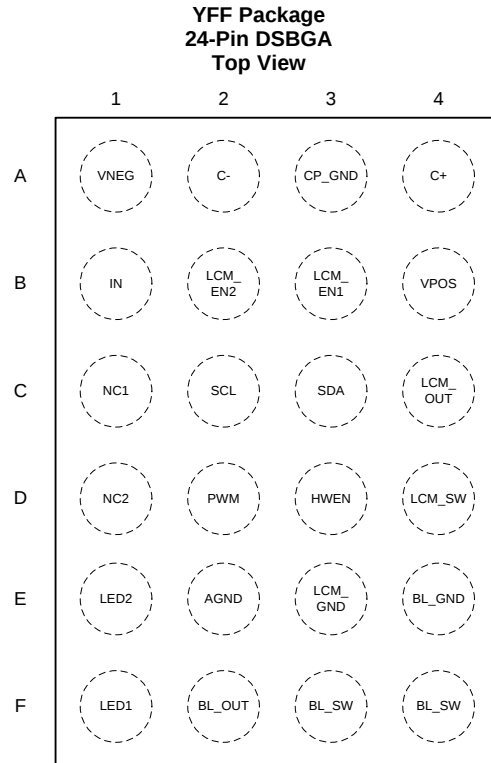
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## 4 修订历史记录

注：之前版本的页码可能与当前版本有所不同。

|                                                                                                                             |             |
|-----------------------------------------------------------------------------------------------------------------------------|-------------|
| <b>Changes from Revision C (June 2017) to Revision D</b> .....                                                              | <b>Page</b> |
| • 已添加 added silicon rev A1 to revision register. ....                                                                       | <b>37</b>   |
| <b>Changes from Revision B (March 2017) to Revision C</b> .....                                                             | <b>Page</b> |
| • 已更改 将完整的数据表首次公开发布到网站 .....                                                                                                | <b>1</b>    |
| <b>Changes from Revision A (January 2017) to Revision B</b> .....                                                           | <b>Page</b> |
| • Changed row(s) in <i>Abs Max</i> table: BL_SW from 30 V to 35 V, BL_OUT and current sink inputs (LEDX) remain at 30 V ... | <b>5</b>    |
| <b>Changes from Original (February 2016) to Revision A</b> .....                                                            | <b>Page</b> |
| • 已更改 POA 上的“可订购器件”后缀从“YFRR”更改为“YFFR” .....                                                                                 | <b>1</b>    |

## 5 Pin Configuration and Functions



### Pin Functions

| PIN    |         | TYPE | DESCRIPTION                                                                                                     |
|--------|---------|------|-----------------------------------------------------------------------------------------------------------------|
| NUMBER | NAME    |      |                                                                                                                 |
| A1     | VNEG    | O    | Inverting charge pump output. Bypass VNEG with a 10-μF ceramic capacitor to CP_GND.                             |
| A2     | C-      | O    | Inverting charge-pump flying capacitor negative connection                                                      |
| A3     | CP_GND  | —    | Charge pump GND. Connect the CNEG capacitor negative terminal to this pin.                                      |
| A4     | C+      | O    | Inverting charge-pump flying capacitor positive connection                                                      |
| B1     | IN      | I    | Input voltage connection. Bypass IN with a 10-μF ceramic capacitor to GND.                                      |
| B2     | LCM_EN2 | I    | Enable for LCD bias negative output; 300-kΩ internal pulldown resistor between LCM_EN2 and GND.                 |
| B3     | LCM_EN1 | I    | Enable for LCD bias positive output; 300-kΩ internal pulldown resistor between LCM_EN1 and GND.                 |
| B4     | VPOS    | O    | Positive LCD bias output. Bypass VPOS with a 10-μF ceramic capacitor to GND.                                    |
| C1     | NC2     | —    | No connect; leave this pin disconnected                                                                         |
| C2     | SCL     | I    | Serial clock connection for I <sup>2</sup> C-compatible interface                                               |
| C3     | SDA     | I/O  | Serial clock connection for I <sup>2</sup> C-compatible interface                                               |
| C4     | LCM_OUT | O    | LCD bias boost output voltage. Bypass LCM_OUT with a 10-μF ceramic capacitor to LCM_GND.                        |
| D1     | NC1     | —    | No connect; leave this pin disconnected                                                                         |
| D2     | PWM     | I    | PWM input for duty cycle current control; 300-kΩ internal pulldown resistor between PWM and GND.                |
| D3     | HWEN    | I    | Active high chip enable; 300-kΩ internal pulldown resistor between HWEN and GND.                                |
| D4     | LCM_SW  | O    | LCD bias boost inductor connection                                                                              |
| E1     | LED2    | I    | Current sink 2 input. Connect the cathode of LED string 2 to this pin. Leave this pin disconnected if not used. |

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**Pin Functions (continued)**

| PIN    |         | TYPE | DESCRIPTION                                                                                                            |
|--------|---------|------|------------------------------------------------------------------------------------------------------------------------|
| NUMBER | NAME    |      |                                                                                                                        |
| E2     | AGND    | —    | Analog ground connection. Connect AGND directly to GND on the PCB.                                                     |
| E3     | LCM_GND | —    | LCD bias boost GND connection. Connect LCM_GND to the negative terminal of the LCD bias output capacitor.              |
| E4     | BL_GND  | —    | Backlight boost output capacitor GND connection                                                                        |
| F1     | LED1    | I    | Current sink 1 input. Connect the cathode of LED string 1 to this pin. Leave this pin disconnected if not used.        |
| F2     | BL_OUT  | O    | Backlight boost output voltage sense connection. Connect to the positive terminal of backlight boost output capacitor. |
| F3     | BL_SW   | O    | Backlight boost inductor connection                                                                                    |
| F4     | BL_SW   | O    | Backlight boost inductor connection                                                                                    |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

|                                                      | MIN                | MAX | UNIT |
|------------------------------------------------------|--------------------|-----|------|
| Voltage on IN, HWEN, LCM_EN1, LCM_EN2, SCL, SDA, PWM | −0.3               | 6   | V    |
| Voltage on LCM_SW, LCM_OUT, VPOS, C+                 | −0.3               | 9   | V    |
| Voltage on VNEG, C−                                  | −7                 | 0.3 | V    |
| Voltage on BL_SW                                     | −0.3               | 35  | V    |
| Voltage on BL_OUT, LED1, LED2                        | −0.3               | 30  | V    |
| Continuous power dissipation                         | Internally limited |     |      |
| Maximum junction temperature, T <sub>J(MAX)</sub>    |                    | 150 | °C   |
| Storage temperature, T <sub>stg</sub>                | −45                | 150 | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to the potential at the AGND pin.

### 6.2 ESD Ratings

|                    |                         | VALUE                                                                          | UNIT  |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

|                                                              | MIN | MAX | UNIT |
|--------------------------------------------------------------|-----|-----|------|
| Input voltage, V <sub>IN</sub>                               | 2.7 | 5   | V    |
| Operating ambient temperature, T <sub>A</sub> <sup>(3)</sup> | −40 | 85  | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to the potential at the AGND pin.
- (3) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature (T<sub>A-MAX</sub>) is dependent on the maximum operating junction temperature (T<sub>J-MAX-OP</sub> = 125°C), the maximum power dissipation of the device in the application (P<sub>D-MAX</sub>), and the junction-to-ambient thermal resistance of the part/package in the application (R<sub>θJA</sub>), as given by the following equation: T<sub>A-MAX</sub> = T<sub>J-MAX-OP</sub> − (R<sub>θJA</sub> × P<sub>D-MAX</sub>).

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | LM36272     | UNIT |
|-------------------------------|----------------------------------------------|-------------|------|
|                               |                                              | DSBGA (YFF) |      |
|                               |                                              | (24 PINS)   |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 63.1        | °C/W |
| R <sub>θJC</sub>              | Junction-to-case (top) thermal resistance    | 0.4         | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 11.6        | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 1.6         | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 11.6        | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report.

## 6.5 Electrical Characteristics

Unless otherwise specified, typical limits apply at 25°C, minimum and maximum limits apply over the full operating ambient temperature range ( $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ ), and  $V_{IN} = 3.6\text{ V}$ .

| PARAMETER                                            |                                                                  | TEST CONDITIONS                                                                                                                              |              | MIN   | TYP  | MAX  | UNIT |
|------------------------------------------------------|------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|--------------|-------|------|------|------|
| CURRENT CONSUMPTION                                  |                                                                  |                                                                                                                                              |              |       |      |      |      |
| I <sub>SD</sub>                                      | Shutdown current                                                 | HWEN = 0                                                                                                                                     |              | 0.2   |      | 2.8  | μA   |
| I <sub>Q</sub>                                       | Quiescent current, device not switching                          | HWEN = V <sub>IN</sub> , LCM boost disabled                                                                                                  |              | 1     |      | 7    | μA   |
| I <sub>LCM_EN</sub>                                  | Bias power no load supply current                                | VPOS, VNEG enabled with no load, backlight boost disabled, typical application circuit (not ATE tested)                                      |              | 0.5   |      | 10   | μA   |
| BACKLIGHT LED CURRENT SINKS (LED1, LED2, LED3, LED4) |                                                                  |                                                                                                                                              |              |       |      |      |      |
| I <sub>LED_MAX</sub>                                 | Maximum output current (per string)                              | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V, linear or exponential mode                                                                                    |              | 30    |      |      | mA   |
| I <sub>LED</sub>                                     | LED current accuracy <sup>(1)</sup>                              | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V, 60 μA < I <sub>LED</sub> < 30 mA, linear or exponential mode                                                  |              | −3%   |      | 3%   |      |
| I <sub>MATCH</sub>                                   | I <sub>LED</sub> current matching <sup>(2)</sup>                 | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V, 60 μA ≤ I <sub>LED</sub> ≤ 30 mA, linear or exponential mode                                                  |              | −2%   |      | 0.2% | 2%   |
| I <sub>LED_MIN</sub>                                 | Minimum LED current (per string)                                 | Linear or exponential mode                                                                                                                   |              | 60    |      |      | μA   |
| I <sub>STEP</sub>                                    | LED current step size (code to code)                             | Exponential mode <sup>(3)</sup>                                                                                                              |              | 0.3%  |      |      |      |
|                                                      |                                                                  | Linear mode                                                                                                                                  |              | 14.63 |      |      | μA   |
| BACKLIGHT BOOST                                      |                                                                  |                                                                                                                                              |              |       |      |      |      |
| OVP threshold                                        |                                                                  | ON threshold, 2.7 V ≤ V <sub>IN</sub> ≤ 5 V                                                                                                  | 011 to 111   | 28.5  | 29   | 29.5 | V    |
|                                                      |                                                                  |                                                                                                                                              | 010          | 24.5  | 25   | 25.5 |      |
|                                                      |                                                                  |                                                                                                                                              | 001          | 20.5  | 21   | 21.5 |      |
|                                                      |                                                                  |                                                                                                                                              | 000          | 16.3  | 17   | 17.7 |      |
| OVP hysteresis                                       |                                                                  | OFF threshold                                                                                                                                |              | 0.5   |      |      | V    |
| Efficiency                                           | Boost efficiency                                                 | V <sub>IN</sub> = 3.6 V, I <sub>BLED</sub> = 5 mA/string, (P <sub>OUT</sub> /P <sub>IN</sub> ), Typical Application Circuit (not ATE tested) |              | 90%   |      |      |      |
| V <sub>HR</sub>                                      | Regulated current-sink headroom voltage (boost feedback voltage) | I <sub>LED</sub> = 30 mA                                                                                                                     |              | 310   |      |      | mV   |
|                                                      |                                                                  | I <sub>LED</sub> = 5 mA                                                                                                                      |              | 120   |      |      | mV   |
| V <sub>HR_MIN</sub>                                  | Current-sink minimum headroom voltage                            | I <sub>LED</sub> = 95% of nominal, I <sub>LED</sub> = 5 mA                                                                                   |              | 30    |      | 50   | mV   |
| R <sub>DSON</sub>                                    | NMOS switch on resistance                                        | I <sub>SW</sub> = 250 mA                                                                                                                     |              | 0.2   |      |      | Ω    |
| I <sub>CL</sub>                                      | NMOS switch current limit                                        | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V                                                                                                                | 00           | 792   | 900  | 1008 | mA   |
|                                                      |                                                                  |                                                                                                                                              | 01           | 1056  | 1200 | 1344 | mA   |
|                                                      |                                                                  |                                                                                                                                              | 10           | 1320  | 1500 | 1680 | mA   |
|                                                      |                                                                  |                                                                                                                                              | 11           | 1584  | 1800 | 2016 | mA   |
| f <sub>BL_SW</sub>                                   | Switching frequency                                              | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V                                                                                                                | 500-kHz mode | 450   | 500  | 550  | kHz  |
|                                                      |                                                                  |                                                                                                                                              | 1-MHz mode   | 900   | 1000 | 1100 |      |
| D <sub>MAX</sub>                                     | Maximum duty cycle                                               | V <sub>IN</sub> = 2.7 V, f <sub>LED_SW</sub> = 1 MHz                                                                                         |              | 93%   | 94%  |      |      |
| DEVICE PROTECTION                                    |                                                                  |                                                                                                                                              |              |       |      |      |      |
| TSD                                                  | Thermal shutdown                                                 | Not ATE tested                                                                                                                               |              | 140   |      |      | °C   |

(1) Output current accuracy is the difference between the actual value of the output current and programmed value of this current.

(2) LED current matching is the maximum difference between any string current and the average string current, divided by the average string current. This is calculated as  $(I_{LEDX} - I_{LED\_AVE}) / I_{LED\_AVE} \times 100$ .

(3) LED current step size from code to code in exponential mode is typically 0.304%, given as  $(1 - (I_{LED(CODE+1)} / I_{LED(CODE)}))$ .

## Electrical Characteristics (continued)

Unless otherwise specified, typical limits apply at 25°C, minimum and maximum limits apply over the full operating ambient temperature range ( $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ ), and  $V_{IN} = 3.6\text{ V}$ .

| PARAMETER                                  |                                                                                    | TEST CONDITIONS                                                                                                                                                       | MIN   | TYP  | MAX  | UNIT |
|--------------------------------------------|------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
| <b>DISPLAY BIAS (LCM BOOST)</b>            |                                                                                    |                                                                                                                                                                       |       |      |      |      |
| $V_{OVP\_LCM}$                             | LCM bias boost overvoltage protection                                              | On threshold, $2.7\text{ V} \leq V_{IN} \leq 5\text{ V}$                                                                                                              |       | 7.8  |      | V    |
| $f_{LCM\_SW}$                              | Switching frequency <sup>(4)</sup>                                                 | $2.7\text{ V} \leq V_{IN} \leq 5\text{ V}$ (continuous conduction mode)                                                                                               |       | 2500 |      | kHz  |
| $V_{LCM\_OUT}$                             | LCM boost output voltage range                                                     |                                                                                                                                                                       | 4     |      | 7.15 | V    |
|                                            | Efficiency                                                                         | $V_{IN} = 3.6\text{ V}$ , $V_{LCM\_OUT} = 5.9\text{ V}$ , 6 mA<br>$I_{LCM\_OUT} < 160\text{ mA}$ , Typical<br>Application Circuit (not ATE tested)                    |       | 92%  |      |      |
|                                            | Output voltage step size                                                           |                                                                                                                                                                       |       | 50   |      | mV   |
| $I_{LCM\_BOOST\_CL}$                       | Valley current limit                                                               |                                                                                                                                                                       |       | 1000 |      | mA   |
| $R_{DS(on)\_LCM}$                          | High-side MOSFET on resistance                                                     | $V_{IN} = V_{GS} = 3.6\text{ V}$                                                                                                                                      |       | 170  |      | mΩ   |
|                                            | Low-side MOSFET on Resistance                                                      | $V_{IN} = V_{GS} = 3.6\text{ V}$                                                                                                                                      |       | 290  |      |      |
| $V_{LCM\_OUT\_RIPPLE}$                     | Peak-to-peak ripple voltage <sup>(4)</sup>                                         | $I_{LOAD\_LCM\_BOOST} = 5\text{ mA}$ and 50 mA,<br>$C_{BST} = 20\text{ }\mu\text{F}$                                                                                  |       | 50   |      | mVpp |
| $V_{LCM\_OUT\_LINE\_TRANSIENT}$            | LCM_OUT line transient response <sup>(4)</sup>                                     | $V_{IN} + 500\text{ mVp-p}$ AC square wave, $T_r = 100\text{ mV}/\mu\text{s}$ , 200 Hz, 12.5% DS at 5 mA, $I_{LOAD} = 5\text{ mA}$ , $C_{IN} = 10\text{ }\mu\text{F}$ | -50   | ±25  | 50   | mV   |
| $V_{LCM\_OUT\_LOAD\_TRANSIENT}$            | LCM_OUT load transient response <sup>(4)</sup>                                     | 0 mA to 150 mA, $t_{RISE/FALL} = 100\text{ mA}/\mu\text{s}$ ,<br>$C_{IN} = 10\text{ }\mu\text{F}$                                                                     | -150  |      | 150  | mV   |
| $t_{LCM\_OUT\_ST}$                         | Start-up time (LCM_OUT),<br>$V_{LCM\_OUT} = 10\%$ to 90% <sup>(4)</sup>            | $C_{LCM\_OUT} = 20\text{ }\mu\text{F}$                                                                                                                                |       |      | 1000 | μs   |
| <b>DISPLAY BIAS POSITIVE OUTPUT (VPOS)</b> |                                                                                    |                                                                                                                                                                       |       |      |      |      |
| $V_{VPOS}$                                 | Programmable output voltage range                                                  |                                                                                                                                                                       | 4     |      | 6.5  | V    |
|                                            | Output voltage step size                                                           |                                                                                                                                                                       |       | 50   |      | mV   |
|                                            | Output voltage accuracy                                                            | Output voltage = 5.4 V                                                                                                                                                | -1.5% |      | 1.5% |      |
| $I_{VPOS\_MAX}$                            | Maximum output current                                                             |                                                                                                                                                                       | 80    |      |      | mA   |
| $I_{VPOS\_CL}$                             | Output current limit                                                               |                                                                                                                                                                       |       | 180  |      | mA   |
| $I_{RUSH\_PK\_VPOS}$                       | Peak start-up inrush current <sup>(4)</sup>                                        | $V_{LCM\_OUT} = 6.3\text{ V}$ , $V_{VPOS} = 5.8\text{ V}$ ,<br>$C_{VPOS} = 10\text{ }\mu\text{F}$ (nominal)                                                           |       |      | 250  | mA   |
| $V_{VPOS\_LINE\_TRANSIENT}$                | LDO_VPOS line transient response <sup>(4)</sup>                                    | $V_{IN} + 500\text{ mVp-p}$ AC square wave, $T_r = 100\text{ mV}/\mu\text{s}$ , 200 Hz at 25 mA, $C_{IN} = 10\text{ }\mu\text{F}$ (nominal)                           | -50   |      | 50   | mV   |
| $V_{VPOS\_LOAD\_TRANSIENT}$                | LDO_VPOS load transient response <sup>(4)</sup>                                    | Load current step 0 mA to 50 mA,<br>$C_{VPOS} = 10\text{ }\mu\text{F}$ (nominal)                                                                                      | -50   |      | 50   | mV   |
| $V_{VPOS\_DC\_REG}$                        | DC load regulation <sup>(4)</sup>                                                  | $0\text{ mA} \leq I_{LOAD\_VPOS} \leq I_{LOAD\_VPOS\_MAX}$                                                                                                            |       |      | 20   | mV   |
| $V_{DO\_VPOS}$                             | VPOS dropout voltage <sup>(5)</sup>                                                | $I_{LOAD\_VPOS} = I_{LOAD\_VPOS\_MAX}$<br>$V_{VPOS} = 5.7\text{ V}$                                                                                                   |       |      | 160  | mV   |
| $PSSR_{VPOS}$                              | Power supply rejection ratio (LDO_VPOS) <sup>(4)</sup>                             | $f = 10\text{ Hz}$ to 500 kHz at $I_{MAX}/2$<br>$V_{LCM\_OUT} - V_{VPOS} \geq 300\text{ mV}$                                                                          | 25    |      |      | dB   |
| $t_{ST\_VPOS}$                             | Start-up time (LDO_VPOS) <sup>(6)</sup><br>$V_{VPOS} = 10\%$ to 90% <sup>(4)</sup> | $C_{VPOS} = 10\text{ }\mu\text{F}$                                                                                                                                    |       | 800  |      | μs   |
| $R_{PD\_VPOS}$                             | Output pulldown resistor (VPOS)                                                    | VPOS pulldown in shutdown                                                                                                                                             | 30    | 80   | 270  | Ω    |
| Pulldown resistance on LCM_EN1             |                                                                                    | Not ATE tested                                                                                                                                                        |       | 300  |      | kΩ   |

(4) Limits set by characterization and/or simulation only.

(5)  $V_{IN\_VPOS} - V_{VPOS}$  when  $V_{VPOS}$  has dropped 100 mV below target.

(6) Typical value only for information.

## Electrical Characteristics (continued)

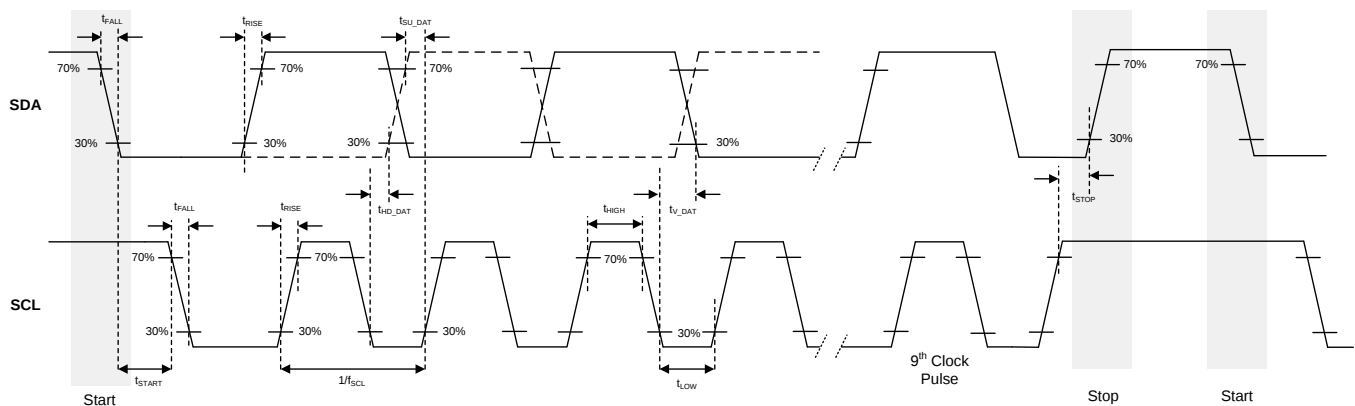
Unless otherwise specified, typical limits apply at 25°C, minimum and maximum limits apply over the full operating ambient temperature range ( $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ ), and  $V_{IN} = 3.6\text{ V}$ .

| PARAMETER                                                 |                                                                                | TEST CONDITIONS                                                                      | MIN   | TYP             | MAX  | UNIT |
|-----------------------------------------------------------|--------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|-------|-----------------|------|------|
| DISPLAY BIAS NEGATIVE OUTPUT (VNEG)                       |                                                                                |                                                                                      |       |                 |      |      |
| V <sub>NEG_SHORT</sub>                                    | NEG output short circuit protection                                            | V <sub>NEG</sub> to CP_GND, VNEG rises to % of target                                | 84%   |                 |      |      |
| V <sub>VNEG</sub>                                         | Efficiency <sup>(6)</sup>                                                      | V <sub>LCM_OUT</sub> = 5.7 V, V <sub>NEG</sub> = −5.4 V, I <sub>NEG</sub> > −5 mA    | 92%   |                 |      |      |
|                                                           | Programmable output voltage range                                              |                                                                                      | −6.5  |                 | −4   | V    |
|                                                           | Output voltage step size                                                       |                                                                                      | 50    |                 |      | mV   |
|                                                           | Output accuracy                                                                | Output voltage = −5.4 V                                                              | −1.5% |                 | 1.5% |      |
| I <sub>LOAD_VNEG_MAX</sub>                                | Maximum output current                                                         | V <sub>LCM_OUT</sub> = 5.9 V, V <sub>NEG</sub> = −5.4 V                              | 80    |                 |      | mA   |
| I <sub>VNEG_CL</sub>                                      | Output current limit                                                           |                                                                                      | 135   |                 |      | mA   |
| R <sub>DSON_VNEG</sub>                                    | CP FET ON resistance                                                           | Q1                                                                                   | 350   |                 |      | mΩ   |
|                                                           |                                                                                | Q2                                                                                   | 240   |                 |      |      |
|                                                           |                                                                                | Q3                                                                                   | 240   |                 |      |      |
| V <sub>VNEG_RIPPLE</sub>                                  | Peak-to-peak ripple voltage <sup>(4)</sup>                                     | I <sub>NEG</sub> = −5 mA and −50 mA, C <sub>VNEG</sub> = 10 μF (nominal)             | 60    |                 |      | mVpp |
| V <sub>VNEG_LINE_TRANSIENT</sub>                          | VNEG line transient response <sup>(4)</sup>                                    | V <sub>IN</sub> + 500 mVp-p AC square wave, 100 mV/μs 200 Hz, 12.5% duty at 5 mA     | −50   | ±25             | 50   | mV   |
| V <sub>VNEG_LOAD_TRANSIENT</sub>                          | V <sub>VNEG</sub> load transient response <sup>(4)</sup>                       | 0 to −50 mA step, t <sub>RISE/FALL</sub> = 1 μs, C <sub>VNEG</sub> = 10 μF (nominal) | 100   |                 |      | mV   |
| t <sub>SU_VNEG</sub>                                      | V <sub>VNEG</sub> start-up time, V <sub>VNEG</sub> = 10% to 90% <sup>(4)</sup> | V <sub>VNEG</sub> = −6.5 V, C <sub>VNEG</sub> = 10 μF (nominal)                      | 1     |                 |      | ms   |
| R <sub>VNEG</sub>                                         | Output pullup resistor (VNEG to CP_GND) <sup>(4)</sup>                         | VNEG pullup in shutdown                                                              | 6     | 20              |      | Ω    |
| Pulldown resistance on LCM_EN2                            |                                                                                | Not ATE tested                                                                       | 300   |                 |      | kΩ   |
| PWM INPUT                                                 |                                                                                |                                                                                      |       |                 |      |      |
| f <sub>PWM_INPUT</sub>                                    | PWM input frequency <sup>(6)</sup>                                             | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V                                                        | 50    | 50000           |      | Hz   |
| t <sub>MIN_ON</sub>                                       | Minimum pulse ON time <sup>(4)</sup>                                           | 24-MHz sample rate                                                                   | 183.3 |                 |      | ns   |
|                                                           |                                                                                | 4-MHz sample rate                                                                    | 1100  |                 |      |      |
|                                                           |                                                                                | 1-MHz sample rate                                                                    | 4400  |                 |      |      |
| t <sub>MIN_OFF</sub>                                      | Minimum pulse OFF timet <sup>(4)</sup>                                         | 24-MHz sample rate                                                                   | 183.3 |                 |      | ns   |
|                                                           |                                                                                | 4-MHz sample rate                                                                    | 1100  |                 |      |      |
|                                                           |                                                                                | 1-MHz sample rate                                                                    | 4400  |                 |      |      |
| t <sub>START-UP</sub>                                     | Turnon delay from PWM = 0 to PWM = 50% duty cycle                              | 4-MHz sample rate                                                                    | 3.5   |                 |      | ms   |
| PWM <sub>RES</sub>                                        | PWM input resolution                                                           | 50 Hz < f <sub>PWM</sub> < 11 kHz                                                    | 11    |                 |      | bits |
| t <sub>GLITCH</sub>                                       | PWM input glitch rejection                                                     | Filter = 00                                                                          | 0     |                 |      | ns   |
|                                                           |                                                                                | Filter = 01                                                                          | 100   |                 |      |      |
|                                                           |                                                                                | Filter = 10                                                                          | 150   |                 |      |      |
|                                                           |                                                                                | Filter = 11                                                                          | 200   |                 |      |      |
| LOGIC INPUTS (PWM, HWEN, EN_POS, EN_NEG, SCL, SDA, EN_BL) |                                                                                |                                                                                      |       |                 |      |      |
| V <sub>IL</sub>                                           | Input logic low                                                                | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V                                                        | 0     | 0.4             |      | V    |
| V <sub>IH</sub>                                           | Input logic high                                                               | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V                                                        | 1.2   | V <sub>IN</sub> |      | V    |
| LOGIC OUTPUTS (SDA)                                       |                                                                                |                                                                                      |       |                 |      |      |
| V <sub>OL</sub>                                           | Output logic low                                                               | 2.7 V ≤ V <sub>IN</sub> ≤ 5 V, I <sub>OL</sub> = 3 mA                                | 0.4   |                 |      | V    |

## 6.6 I<sup>2</sup>C Timing Requirements (Fast Mode)

Over operating free-air temperature range; limits apply over  $2.5\text{ V} \leq V_{\text{IN}} \leq 5\text{ V}$  (unless otherwise noted). See [图 1](#).

|                        |                                          |                                                                                                                   | MIN  | MAX  | UNIT          |
|------------------------|------------------------------------------|-------------------------------------------------------------------------------------------------------------------|------|------|---------------|
| $t_{\text{LOW\_SCL}}$  | SCL low clock period                     |                                                                                                                   | 0.5  |      | $\mu\text{s}$ |
| $t_{\text{HIGH\_SCL}}$ | SCL high clock period                    |                                                                                                                   | 0.26 |      | $\mu\text{s}$ |
| $f_{\text{SCL}}$       | SCL clock frequency                      |                                                                                                                   | 1    |      | MHz           |
| $t_{\text{SU\_DAT}}$   | Data in setup time to SCL high           |                                                                                                                   | 50   |      | ns            |
| $t_{\text{V\_DAT}}$    | Data valid time                          |                                                                                                                   |      | 0.45 | $\mu\text{s}$ |
| $t_{\text{HD\_DAT}}$   | Data out stable after SCL low            |                                                                                                                   | 0    |      |               |
| $t_{\text{START}}$     | SDA low setup time to SCL low (start)    |                                                                                                                   | 260  |      | ns            |
| $t_{\text{STOP}}$      | SDA high hold time after SCL high (stop) |                                                                                                                   | 260  |      | ns            |
| $t_{\text{RISE}}$      | SDA/SCL rise time                        | $V_{\text{PULLUP}} = 1.8\text{ V}$ , $R_{\text{PULLUP}} = 1\text{ k}\Omega$ ,<br>$C_{\text{BUS}} = 100\text{ pF}$ |      | 120  | ns            |
| $t_{\text{FALL}}$      | SDA/SCL fall time                        | $V_{\text{PULLUP}} = 1.8\text{ V}$ , $R_{\text{PULLUP}} = 1\text{ k}\Omega$ ,<br>$C_{\text{BUS}} = 100\text{ pF}$ |      | 120  | ns            |



**图 1. I<sup>2</sup>C Timing Parameters**

## 6.7 Typical Characteristics

Ambient temperature is 25°C and  $V_{IN}$  is 3.7 V unless otherwise noted.

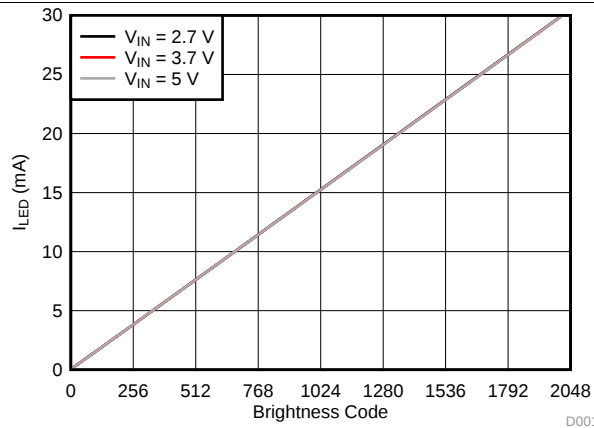


图 2. Backlight LED Current, Linear Control

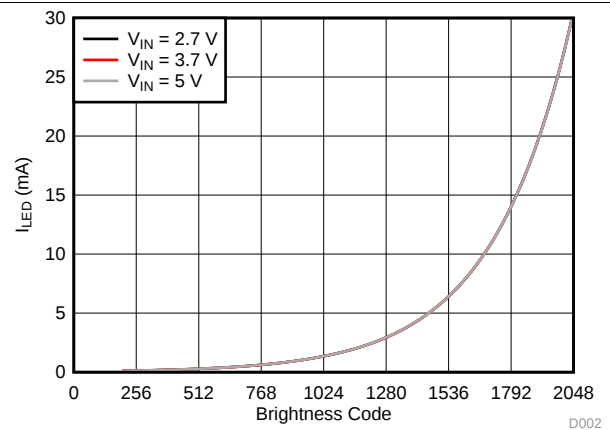


图 3. Backlight LED Current, Exponential Control

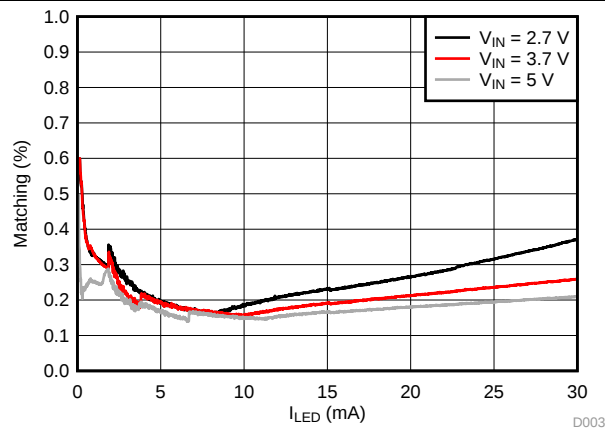


图 4. Backlight LED Current Matching

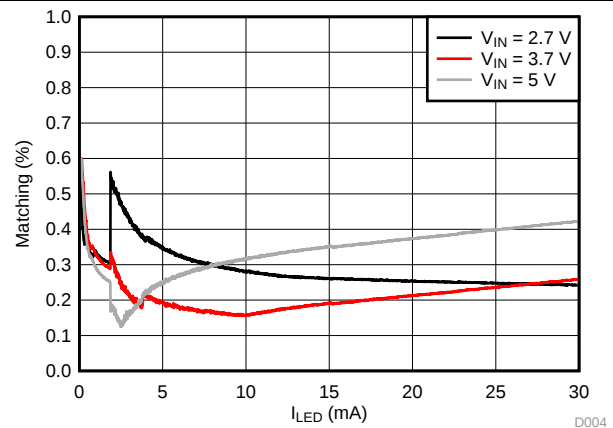


图 5. Backlight LED Current Matching

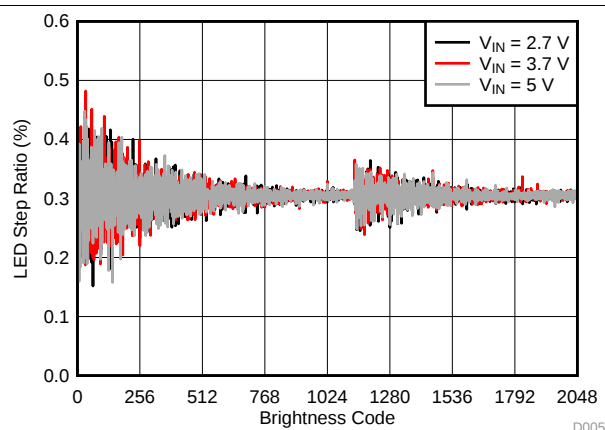


图 6. Backlight LED Current-Step Ratio

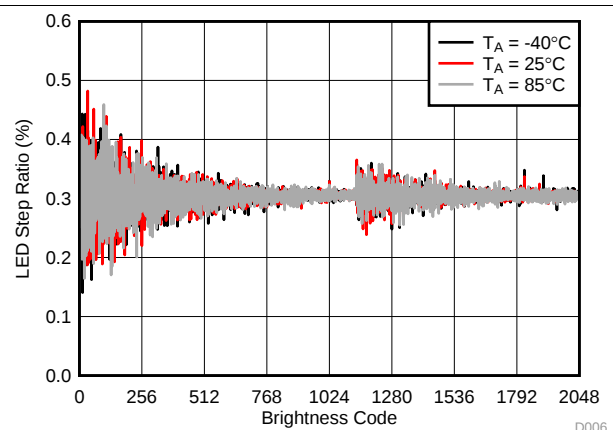


图 7. Backlight LED Current-Step Ratio

## Typical Characteristics (接下页)

Ambient temperature is 25°C and  $V_{IN}$  is 3.7 V unless otherwise noted.

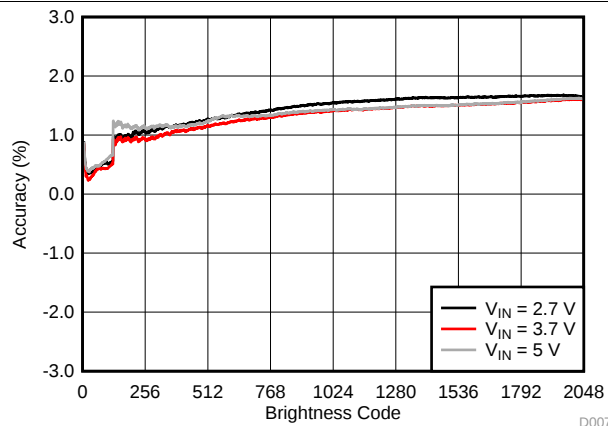


图 8. Backlight LED Current Accuracy

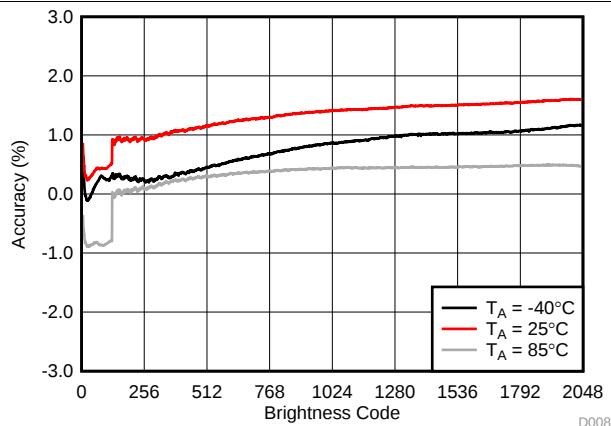
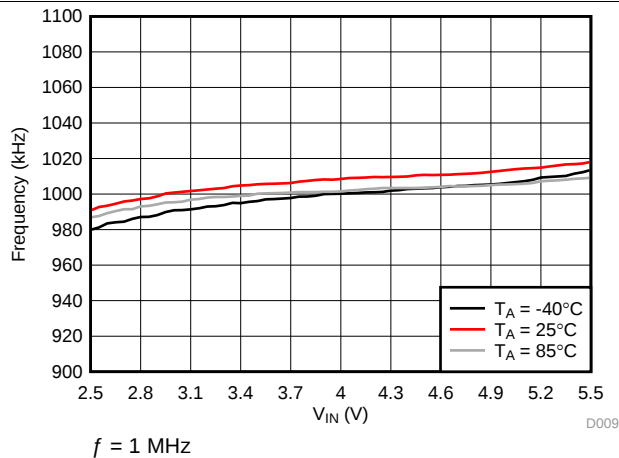
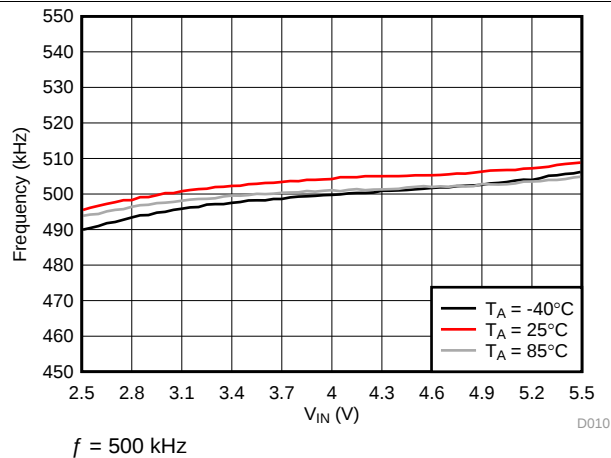


图 9. Backlight LED Current Accuracy



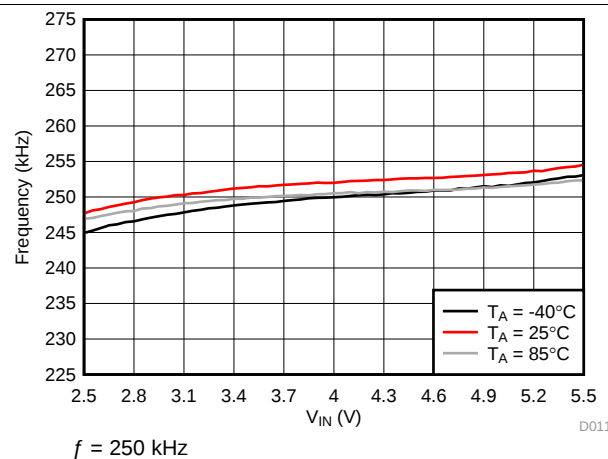
$f = 1 \text{ MHz}$

图 10. Backlight Boost Frequency



$f = 500 \text{ kHz}$

图 11. Backlight Boost Frequency



$f = 250 \text{ kHz}$

图 12. Backlight Boost Frequency

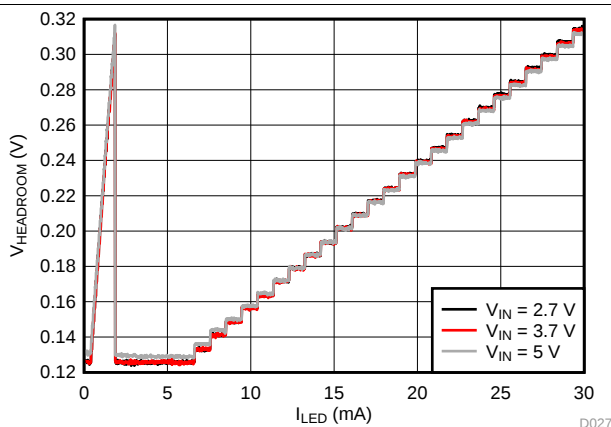


图 13. Backlight Regulated Headroom Voltage

## Typical Characteristics (接下页)

Ambient temperature is 25°C and  $V_{IN}$  is 3.7 V unless otherwise noted.

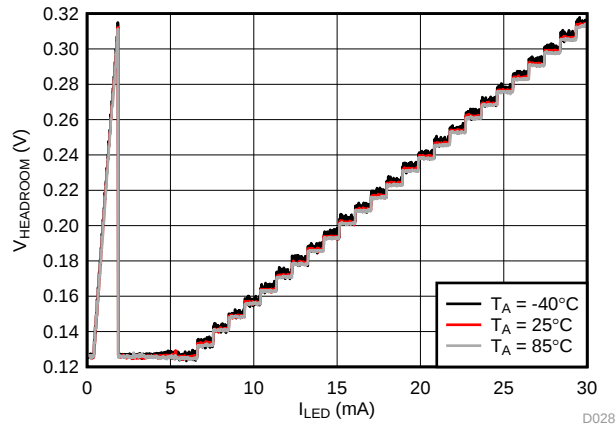
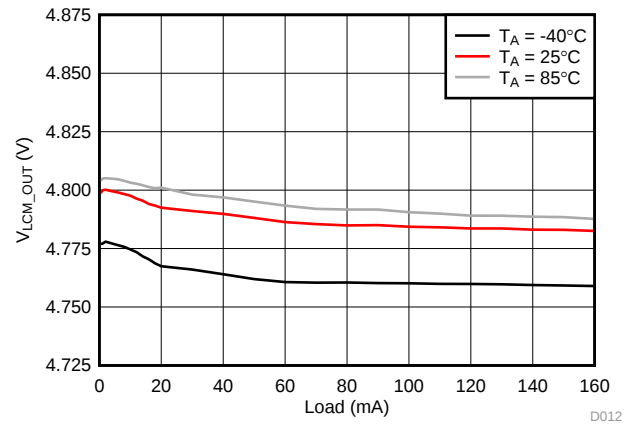
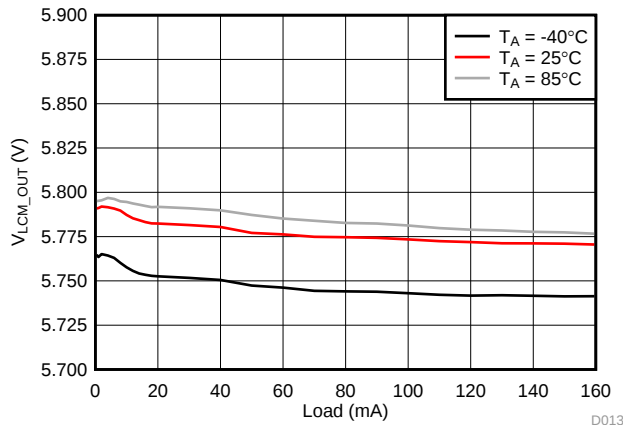


图 14. Backlight Regulated Headroom Voltage



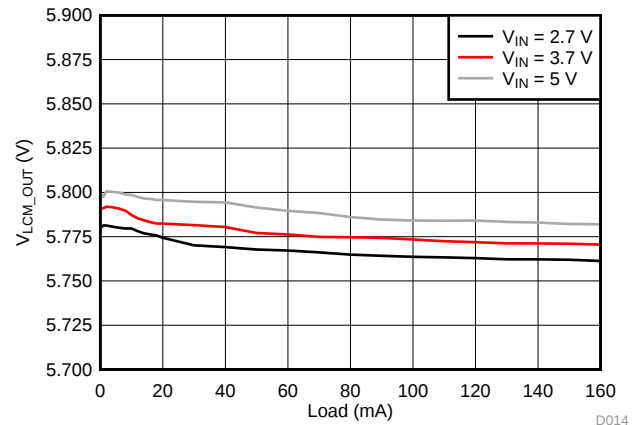
$V_{LCM\_OUT} = 4.8 \text{ V}$

图 15.  $V_{LCM\_OUT}$  Load Regulation



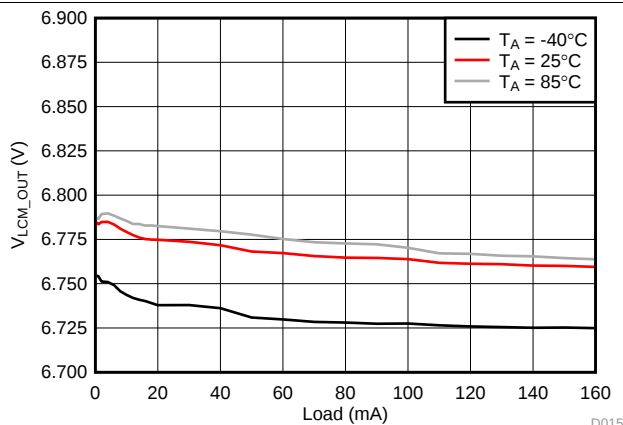
$V_{LCM\_OUT} = 5.8 \text{ V}$

图 16.  $V_{LCM\_OUT}$  Load Regulation



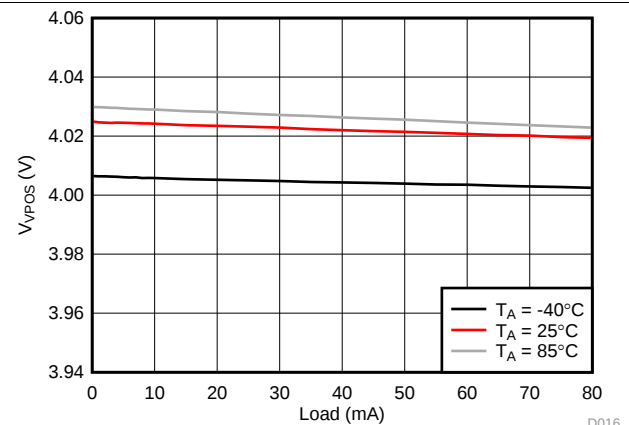
$V_{LCM\_OUT} = 5.8 \text{ V}$

图 17.  $V_{LCM\_OUT}$  Load Regulation



$V_{LCM\_OUT} = 6.8 \text{ V}$

图 18.  $V_{LCM\_OUT}$  Load Regulation



$V_{VPOS} = 4 \text{ V}$      $V_{LCM\_OUT} = 4.3 \text{ V}$

图 19.  $V_{VPOS}$  Load Regulation

## Typical Characteristics (接下页)

Ambient temperature is 25°C and  $V_{IN}$  is 3.7 V unless otherwise noted.

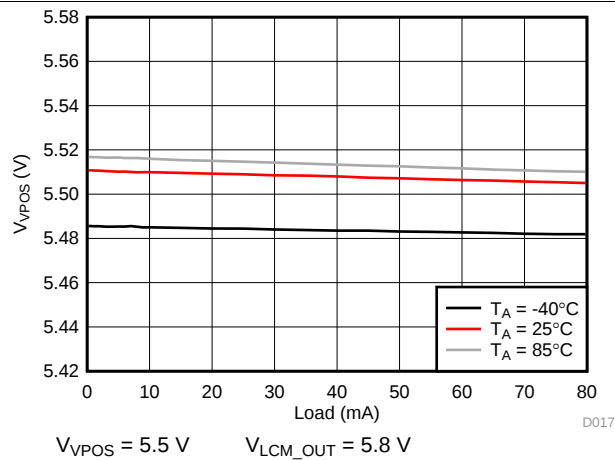


图 20.  $V_{VPOS}$  Load Regulation

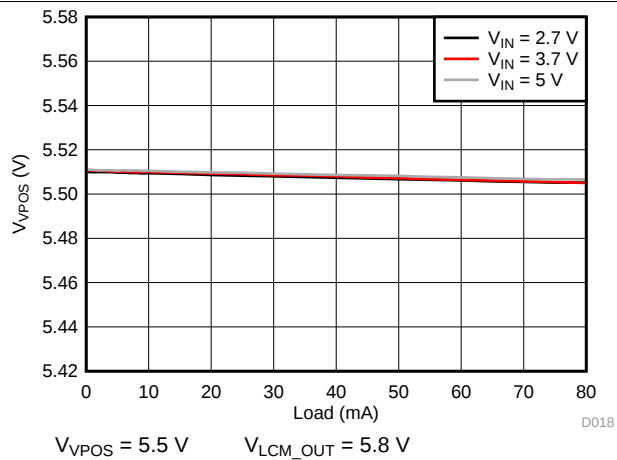


图 21.  $V_{VPOS}$  Load Regulation

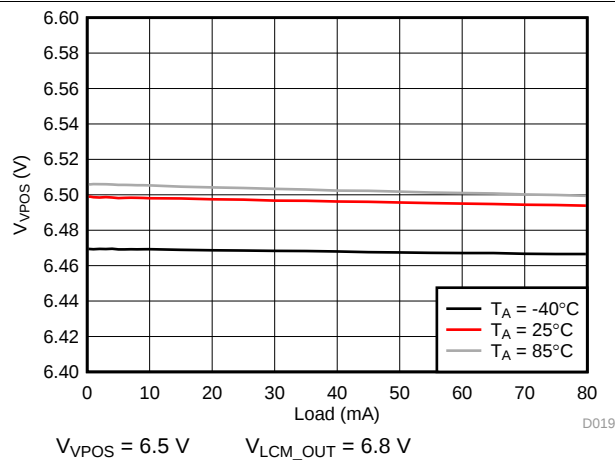


图 22.  $V_{VPOS}$  Load Regulation

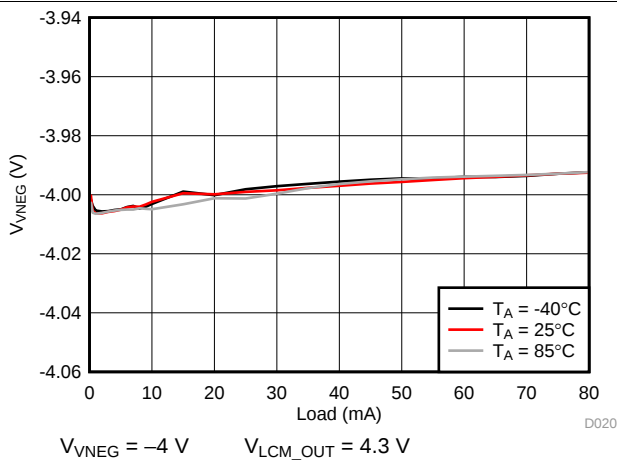


图 23.  $V_{VNEG}$  Load Regulation

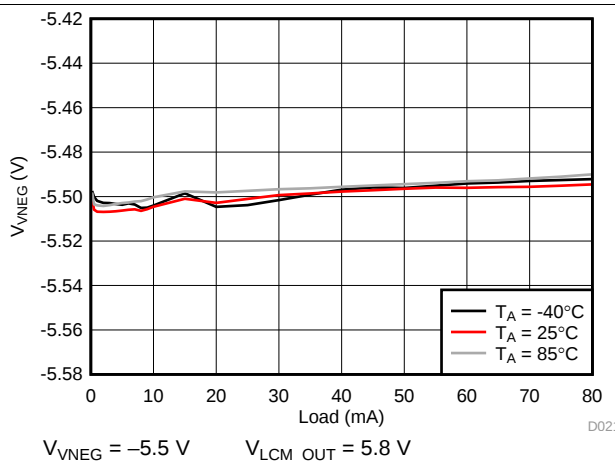


图 24.  $V_{VNEG}$  Load Regulation

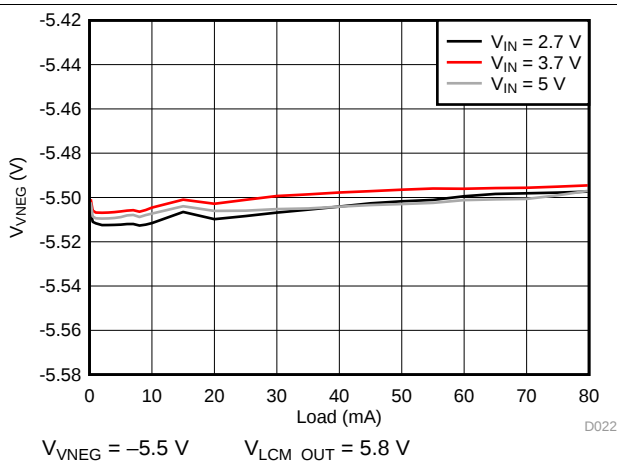


图 25.  $V_{VNEG}$  Load Regulation

## Typical Characteristics (接下页)

Ambient temperature is 25°C and  $V_{IN}$  is 3.7 V unless otherwise noted.

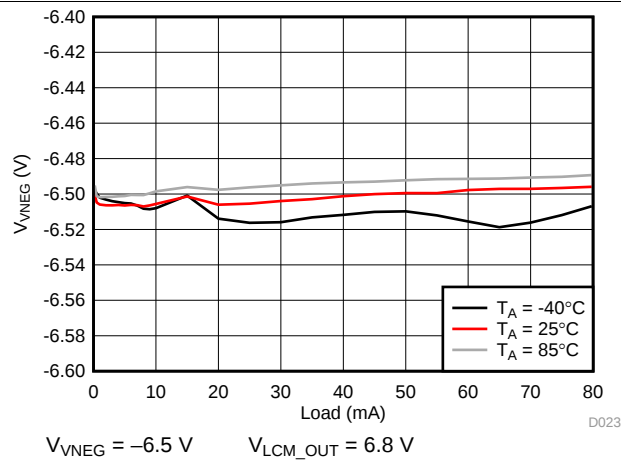


图 26.  $V_{VNEG}$  Load Regulation

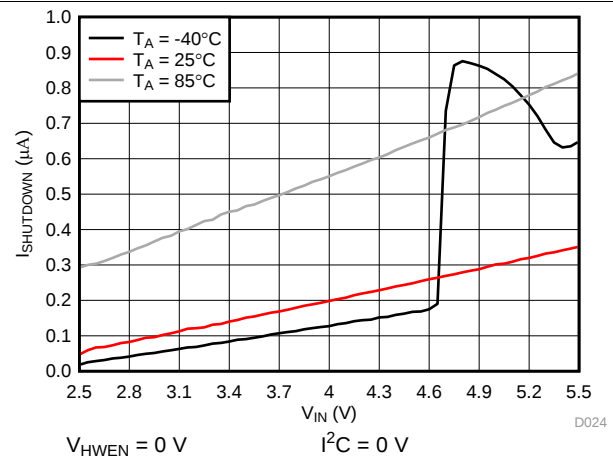


图 27.  $I_q$  Shutdown

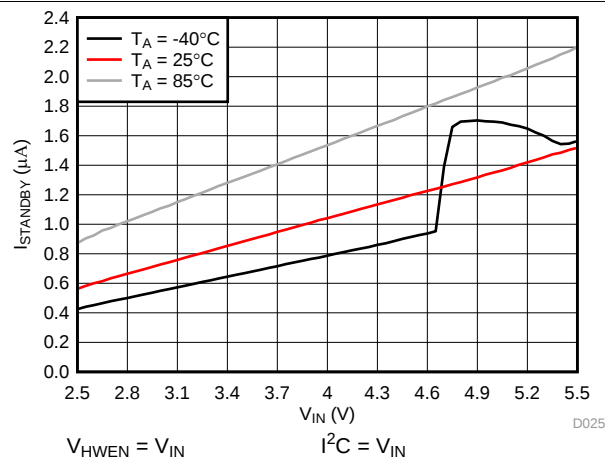


图 28.  $I_q$  Standby

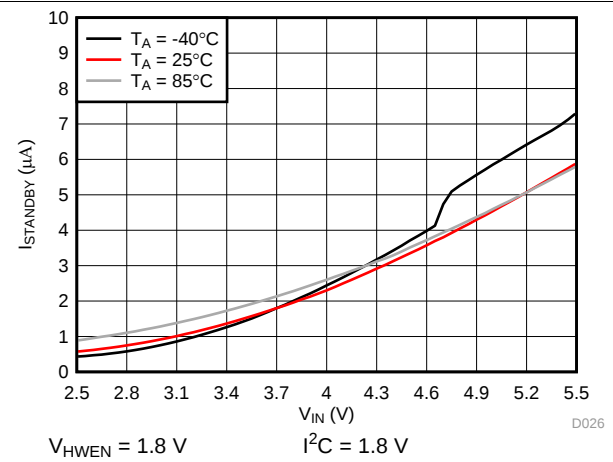


图 29.  $I_q$  Standby

## 7 Detailed Description

### 7.1 Overview

The LM36272 is a single-chip, complete backlight and LCM power solution. The device operates over the 2.7-V to 5-V input voltage range.

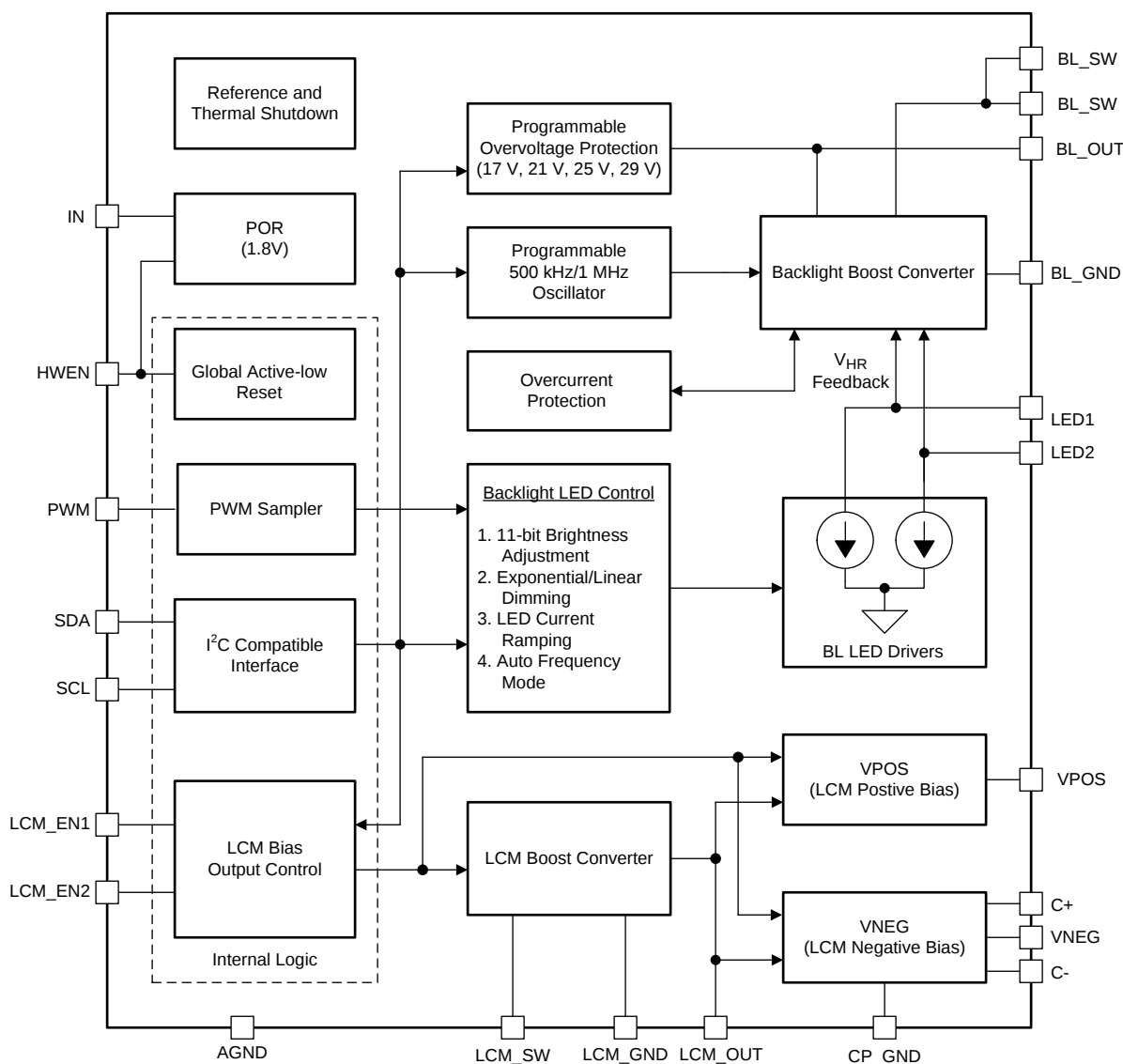
The backlight block consists of an inductive boost plus two current sink white-LED drivers designed to power from one to two LED strings with up to eight LEDs each (up to 28 V typical), with a maximum of 30 mA per string. A higher number of LEDs per string can be supported if the total output power requirement for the boost does not exceed 2.5 Watts. The power for the LED strings comes from an integrated asynchronous backlight boost converter with three selectable switching frequencies to optimize performance or solution area. LED current is regulated by the low-headroom current sinks. The inductive backlight boost automatically adjusts its output voltage to keep the active current sinks in regulation, while minimizing current sink headroom voltage. The 11-bit LED current is set via an I<sup>2</sup>C interface, via a logic level PWM input, or a combination of both.

The LCM bias power portion of the LM36272 consists of a synchronous LCM bias boost converter, inverting charge pump, and an integrated LDO. The LCM positive bias voltage VPOS (up to 6.5 V) is post-regulated from the LCM bias boost converter output voltage. The LCM negative bias voltage VNEG (down to –6.5 V) is generated from the LCM bias boost converter output using a regulated inverting charge pump.

The LM36272 flexible control interface consists of an HWEN active low reset input, LCM\_EN1 and LCM\_EN2 inputs for VPOS and VNEG enable control, PWM input for content adaptive backlight control (CABC), and an I<sup>2</sup>C-compatible interface.

Additionally, there is a flag register with flag and status bits. The user can read back this register and determine if a fault or warning message has been generated.

## 7.2 Functional Block Diagram



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## 7.3 Features Description

### 7.3.1 Enabling the LM36272

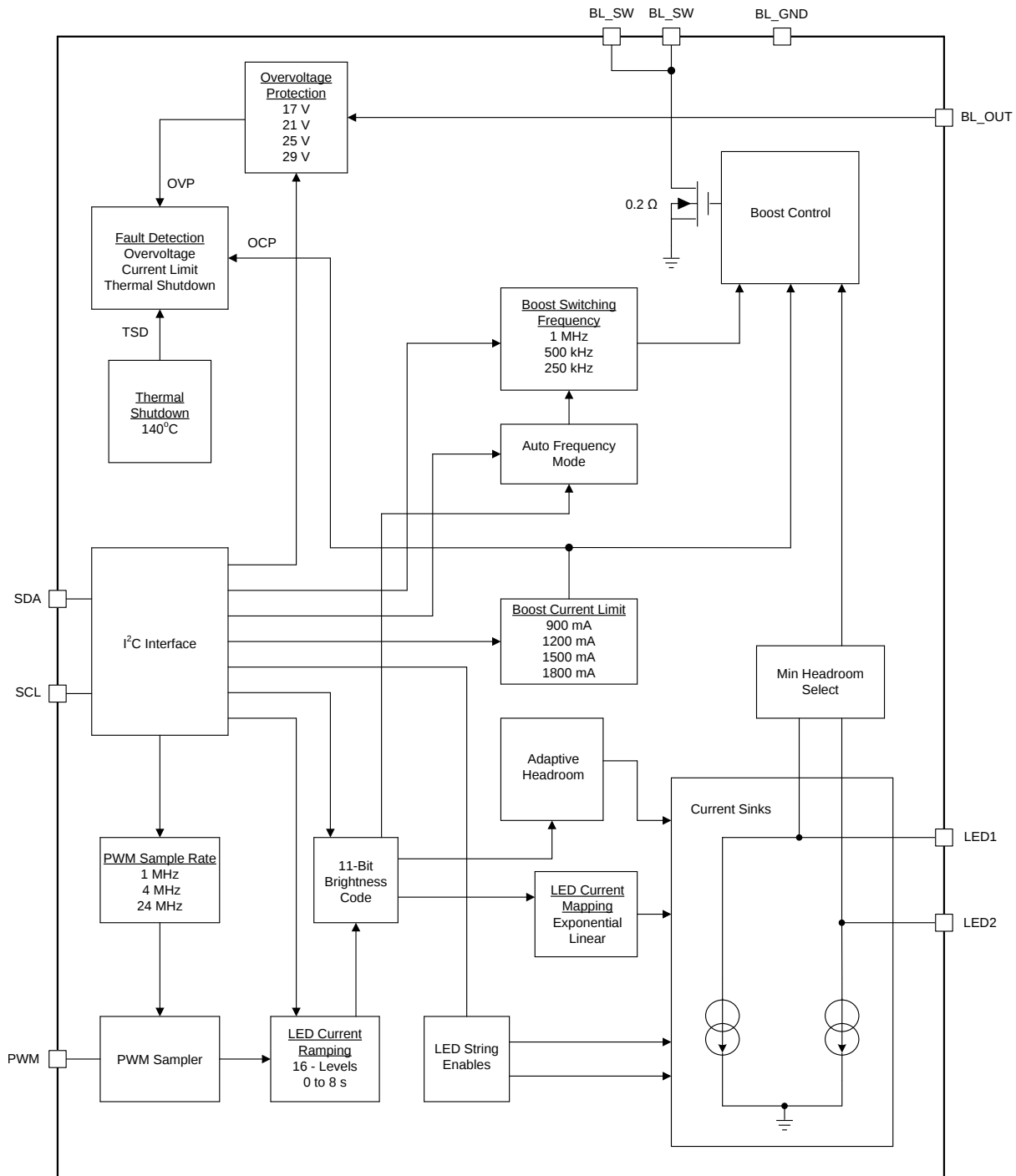
The LM36272 has a logic level input HWEN which serves as the master enable/disable for the device. When HWEN is low the device is disabled, the registers are reset to their default state, the I<sup>2</sup>C bus is inactive, and the device is placed in a low-power shutdown mode. When HWEN is forced high the device is enabled, and I<sup>2</sup>C writes are allowed to the device.

## Features Description (接下页)

### 7.3.2 Backlight

The high voltage required by the LED strings is generated with an asynchronous backlight boost converter. An adaptive voltage control loop automatically adjusts the output voltage based on the voltage over the LED drivers LED1 and LED2. The LM36272 has three switching frequency modes, 1 MHz, 500 kHz, and 250 kHz. These are set via the BL\_FREQ Select bit, register 0x03 bit[7] and by utilizing the auto-frequency feature (refer to [Auto Switching Frequency](#)). Operation in low-frequency mode results in better efficiency at lighter load currents due to the decreased switching losses. Operation in high-frequency mode gives better efficiency at higher load currents due to the reduced inductor current ripple and the resulting lower conduction losses in the MOSFET and inductor.

## Features Description (接下页)



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**图 30. Backlight Block Diagram**

### 7.3.2.1 Current Sink Enable

Each current sink in the device has a separate enable input. This allows for a one-string or two-string application. Once the correct LED string configuration is programmed and a non-zero code is written to the brightness registers, the device can be enabled by writing the backlight enable bit high (register 0x08 bit[4]).

## Features Description (接下页)

The default settings for the device are backlight enable bit set to 0, all backlight strings disabled, PWM input disabled, linear mapped mode, and the brightness level set to 30 mA per string.

When PWM is enabled, the LM36272 actively monitors the PWM input. After a non-zero PWM duty cycle is detected, the LM36272 multiplies the duty cycle with the programmed I<sup>2</sup>C brightness code to give an 11-bit brightness value between 60  $\mu$ A and 30 mA. 图 31 and 图 32 describe the start-up timing for operation with I<sup>2</sup>C controlled current and with PWM controlled current.

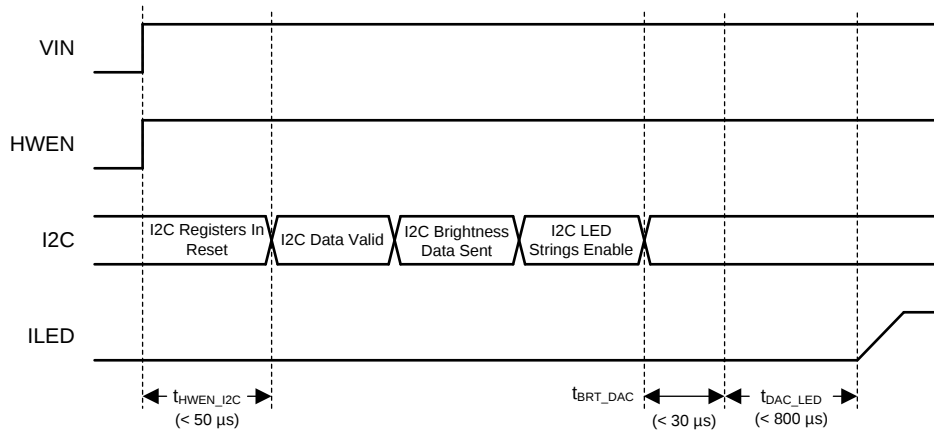


图 31. Enabling the LM36272 via I<sup>2</sup>C

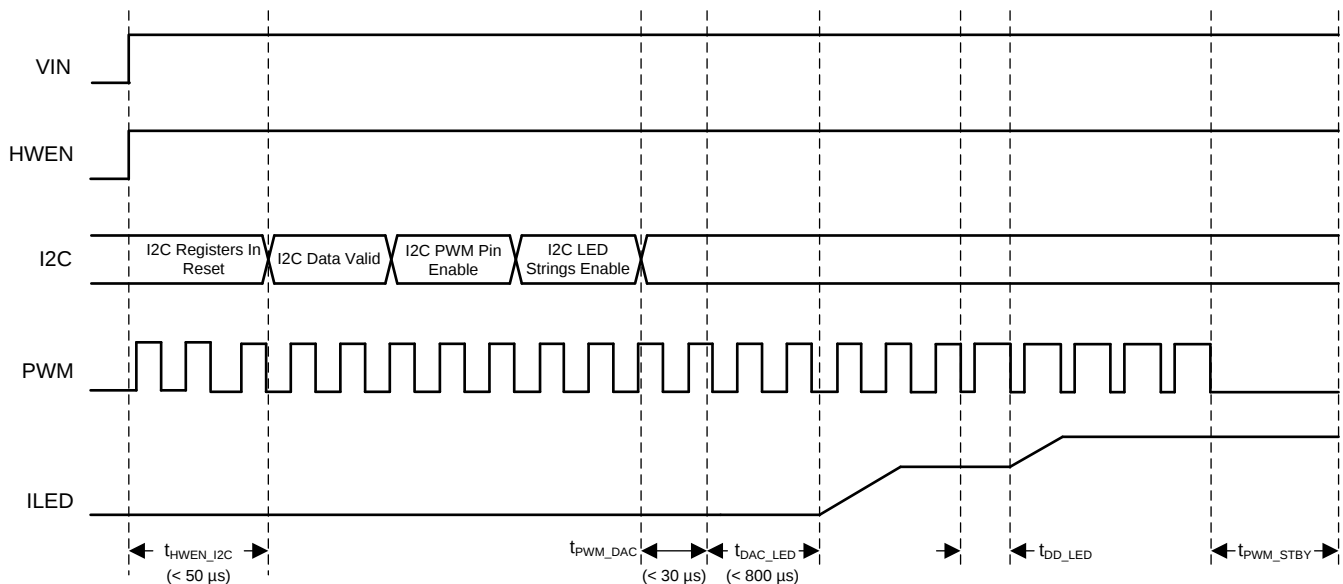


图 32. Enabling the LM36272 via PWM

The LM36272 backlight can be enabled or disabled in various ways. When disabled, the device is considered shut down, and the quiescent current drops to  $I_{SHDN}$ . When the device is in standby, it returns to the  $I_{STANDBY}$  current level retaining all programmed register values. 表 1 describes the different backlight operating states for the LM36272.

## Features Description (接下页)

**表 1. Backlight Operating Modes**

| HWEN | BL_EN<br>0x08[4] | PWM INPUT      | I <sup>2</sup> C<br>BRIGHTNESS<br>0x05[7:0]<br>0x04[2:0] | CURRENT<br>SINK<br>ENABLES<br>0x08[1:0] | PWM EN<br>0x02[0] | PWM RAMP<br>0x02[1] | FEEDBACK<br>DISABLES<br>0x10[4:3] | MAPPING MODE<br>0x02[3]                 | ACTION                                                                                                                                            |
|------|------------------|----------------|----------------------------------------------------------|-----------------------------------------|-------------------|---------------------|-----------------------------------|-----------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|
| 0    | X                | X              | X                                                        | X                                       | X                 | X                   | X                                 | X                                       | Shutdown                                                                                                                                          |
| 1    | 0                | X              | X                                                        | X                                       | X                 | X                   | X                                 | X                                       | Standby <sup>(1)</sup>                                                                                                                            |
| 1    | 1                | X              | 0x000                                                    | 00                                      | X                 | X                   | X                                 | X                                       | Standby <sup>(1)</sup>                                                                                                                            |
| 1    | 1                | X              | ≥0x001                                                   | ≥01                                     | 0                 | X                   | <11                               | 0 = Exponential Mode<br>1 = Linear Mode | -Backlight boost enabled<br>-Selected current sink(s) enabled<br>-I <sup>2</sup> C control only                                                   |
| 1    | 1                | Duty cycle = 0 | X                                                        | ≥01                                     | 1                 | X                   | <11                               | X                                       | Standby <sup>(1)</sup>                                                                                                                            |
| 1    | 1                | Duty cycle > 0 | ≥0x001                                                   | ≥01                                     | 1                 | 0                   | <11                               | 0 = Exponential Mode<br>1 = Linear Mode | -Backlight boost enabled<br>-Selected current sink(s) enabled<br>-I <sup>2</sup> C × PWM (after ramper)<br>-No ramp between PWM duty-cycle change |
| 1    | 1                | Duty cycle > 0 | ≥0x001                                                   | ≥01                                     | 1                 | 1                   | <11                               | 0 = Exponential Mode<br>1 = Linear Mode | -Backlight boost enabled<br>-Selected current sink(s) enabled<br>-I <sup>2</sup> C × PWM (before ramper)                                          |
| 1    | 1                | Duty cycle > 0 | ≥0x001                                                   | ≥01                                     | 1                 | 0                   | 11                                | 0 = Exponential Mode<br>1 = Linear Mode | -Backlight boost disabled<br>-Selected current sink(s) enabled<br>-I <sup>2</sup> C × PWM (after ramper)                                          |
| 1    | 1                | Duty cycle > 0 | ≥0x001                                                   | ≥01                                     | 1                 | 1                   | 11                                | 0 = Exponential Mode<br>1 = Linear Mode | -Backlight boost disabled<br>-Selected current sink(s) enabled<br>-I <sup>2</sup> C × PWM (before ramper)                                         |

(1) Standby implies the backlight boost and current sinks are shut down. Register writes are still possible. Shutdown implies that the device is in reset and no I<sup>2</sup>C communication is possible.

### 7.3.2.2 Brightness Mapping

There are two different ways to map the brightness code (or PWM duty cycle) to the LED current: linear and exponential mapping.

#### 7.3.2.2.1 Linear Mapping

For linear mapped mode the LED current increases proportionally to the 11-bit brightness code and follows the relationship:

$$I_{LED} = 45.37 \mu A + 14.63 \mu A \times \text{Code} \quad (1)$$

This is valid from codes 1 to 2047. Code 0 programs 0 current. Code is an 11-bit code that can be the I<sup>2</sup>C brightness code or the product of the I<sup>2</sup>C brightness code and the PWM duty cycle.

#### 7.3.2.2.2 Exponential Mapping

In exponential mapped mode the LED current follows the relationship:

$$I_{LED} = 60 \mu A \times 1.003040572^{\text{Code}} \quad (2)$$

This results in an LED current step size of approximately 0.304% per code. This is valid for codes from 1 to 2047. Code 0 programs 0 current. Code is an 11-bit code that can be the I<sup>2</sup>C brightness code or the product of the I<sup>2</sup>C brightness code and the PWM duty cycle. [图 33](#) details the LED current exponential response.

The 11-bit (0.304%) per code step is small enough such that the transition from one code to the next in terms of LED brightness is not distinguishable to the eye. This, therefore, gives a perfectly smooth brightness increase between adjacent codes.

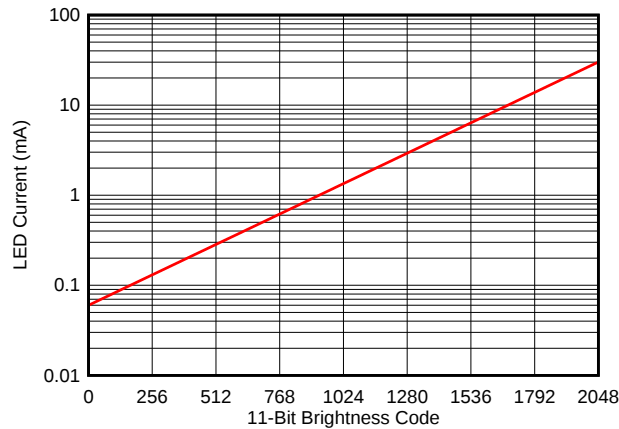


图 33. LED Current vs Brightness Code (Exponential Mapping)

### 7.3.2.3 Backlight Brightness Control Modes

The LM36272 has 2 brightness control modes:

1. I<sup>2</sup>C only brightness control
2. I<sup>2</sup>C × PWM brightness control

#### 7.3.2.3.1 I<sup>2</sup>C Brightness Control (PWM Pin Disabled)

If the PWM pin is disabled the I<sup>2</sup>C brightness registers are in control of the LED current, and the PWM input is disabled. The brightness data (BRT) is the concatenation of the two brightness registers (3 LSBs) and (8 MSBs) (registers 0x04 and 0x05, respectively). The LED current only changes when the MSBs are written, meaning that to do a full 11-bit current change via I<sup>2</sup>C, first the 3 LSBs are written and then the 8 MSBs are written. In this mode the ramper only controls the time from one I<sup>2</sup>C brightness set-point to the next 图 34.

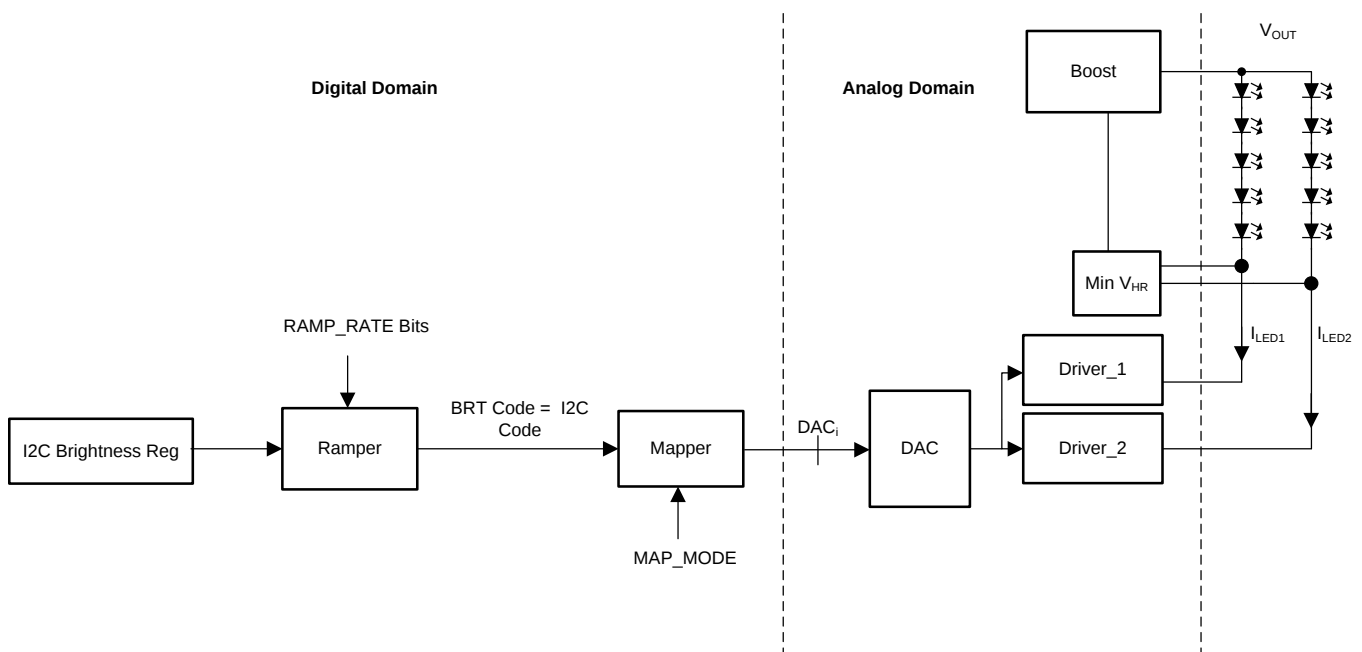


图 34. I<sup>2</sup>C Only Brightness Control

### 7.3.2.3.2 I<sup>2</sup>C × PWM Brightness Control (PWM Pin Enabled)

If the PWM pin is enabled both the I<sup>2</sup>C brightness code and the PWM duty-cycle control the LED current.

With linear mapping the PWM duty cycle-to-current response is approximated by 公式 3:

$$I_{LED} = 45.37 \mu A + 14.63 \mu A \times I^2C \text{ BRGT CODE} \times PWM \text{ D/C} \quad (3)$$

With exponential mapping the PWM duty cycle-to-current response is approximated by 公式 4:

$$I_{LED} = 60 \mu A \times 1.003040572^{I^2C \text{ BRGT CODE} \times PWM \text{ D/C}} \quad (4)$$

#### 7.3.2.3.2.1 PWM Ramper

The PWM ramp option (register 0x02 bit[1]) determines whether the ramper is active or inactive during a change in PWM duty cycle.

The ramper smooths the transition from one brightness value to another. Ramp time can be adjusted from 0 ms to 8000 ms with LED Current Ramp [3:0] bits (register 0x03 bits [6:3]). Ramp time is used for sloping both up and down. Ramp time always remains the same regardless of the amount of change in brightness.

In PWM mode the behavior of the ramper depends on the state of the PWM Ramp bit (register 0x02, bit [1]). If the PWM Ramp bit is set to 0, there is no LED current ramping between PWM duty cycle changes. The PWM duty cycle is multiplied with the I<sup>2</sup>C brightness code at the output of the ramper (see 图 35). If this bit is set to 1, ramping is achieved between I<sup>2</sup>C × PWM currents (see 图 36).

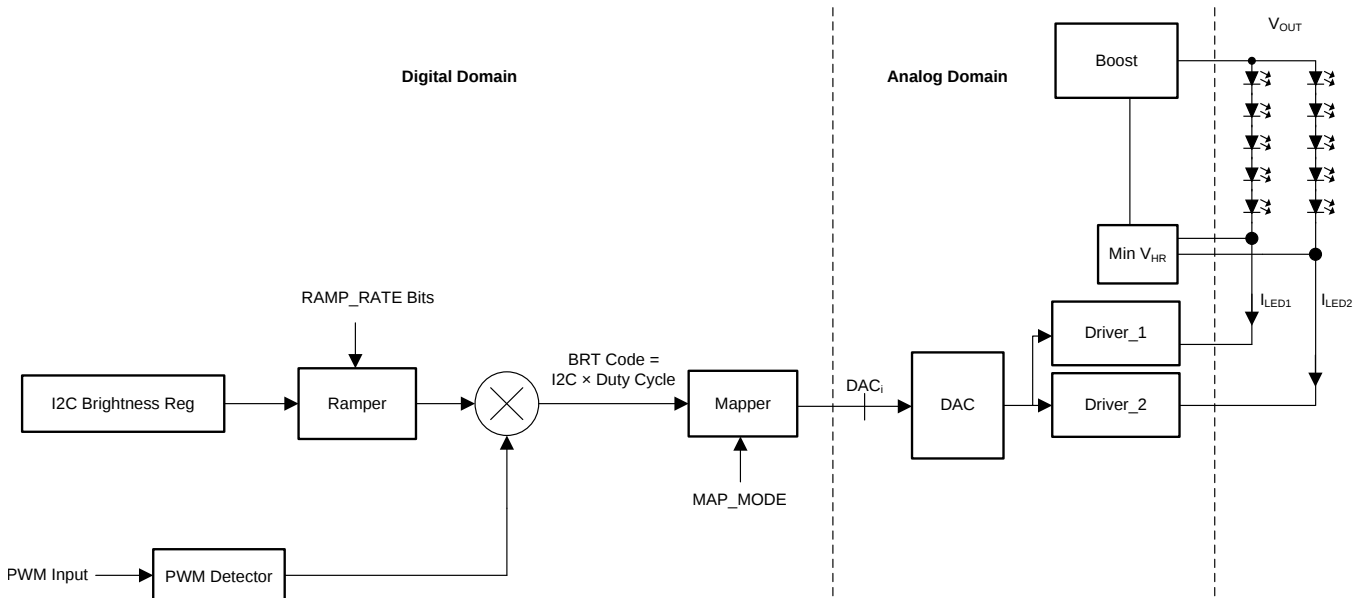


图 35. (I<sup>2</sup>C + PWM) Brightness Control, PWM Ramper Disabled

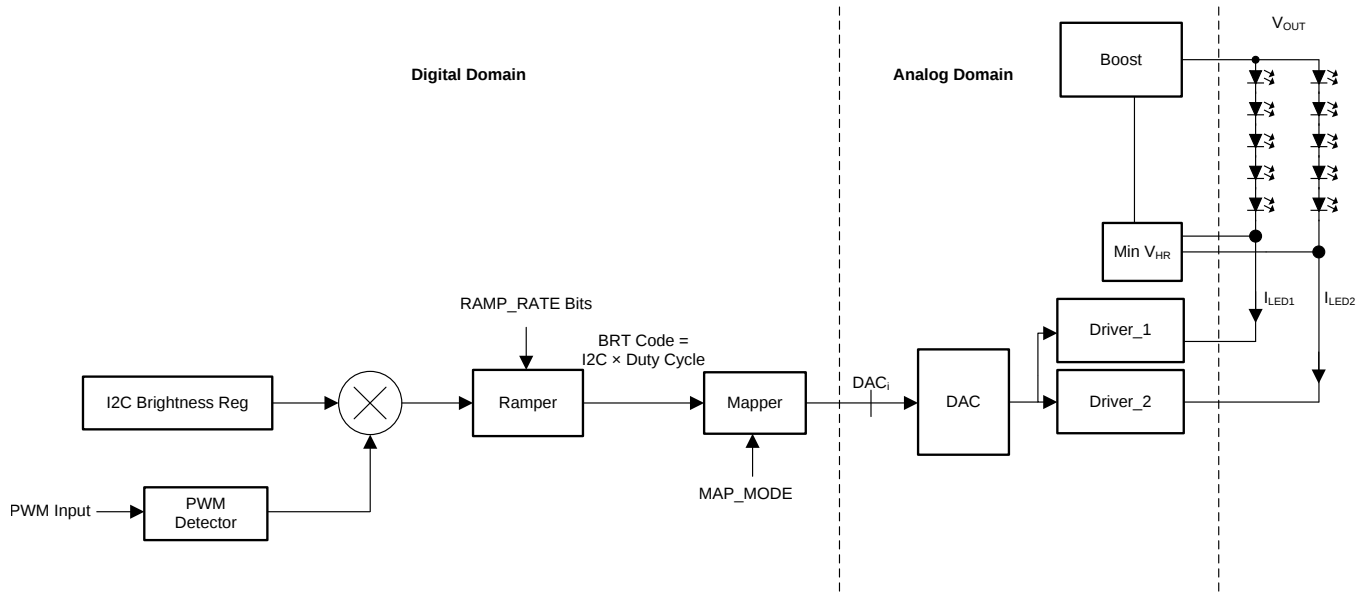


图 36. (I<sup>2</sup>C + PWM) Brightness Control, PWM Ramper Enabled

### 7.3.2.4 Boost Switching Frequency

The M36272 has two programmable switching frequencies: 500 kHz and 1 MHz. These are set via the Backlight Configuration 2 register (register 0x03 bit [7]). Operation at 1 MHz is primarily beneficial when efficiency at high load current is more important. For maximum efficiency across the entire load current range the device incorporates an automatic frequency shift mode (see [Auto Switching Frequency](#)).

#### 7.3.2.4.1 Minimum Inductor Select

The LM36272 can use inductors in the range of 4.7  $\mu$ H to 15  $\mu$ H. In order to optimize the converter response to changes in  $V_{IN}$  and load, the Backlight Boost L Select bits (register 0x11 bits [7:6]) must be selected depending on the nominal value of inductance chosen.

### 7.3.2.5 Boost Feedback Gain Select

The Boost Integral and Proportional Feedback Gain Select bits in Option 2 register (bits [3:2] and bits[5:4] in register 0x11) contain adjustment parameters for the LM36272 internal loop gain. The optimized settings using a 1- $\mu$ F capacitor at BL\_OUT are the default settings of 01 and 11 for Integral and Proportional, respectively.

### 7.3.2.6 Auto Switching Frequency

To take advantage of frequency vs load dependent losses, the LM36272 can automatically change the boost switching frequency based on the programmed brightness code. In addition to the register programmable switching frequencies of 500 kHz and 1 MHz, the auto-frequency mode also incorporates a low-frequency selection of 250 kHz. It is important to note that the 250-kHz frequency is only accessible in auto-frequency mode and has a maximum boost duty cycle ( $D_{MAX}$ ) of 50%.

Auto-frequency mode operates by using two programmable registers (Backlight Auto Frequency Low Threshold (register 0x06) and Backlight Auto Frequency High Threshold (register 0x07)). The high threshold determines the switchover from 1 MHz to 500 kHz. The low threshold determines the switchover from 500 kHz to 250 kHz. Both the High and Low Threshold registers take an 8-bit code which is compared against the 8 MSB of the brightness register (register 0x05). 表 2 details the boundaries for this mode.

表 2. Auto Switching Frequency Operation

| BRIGHTNESS CODE MSBs (Register 0x05 bits[7:0])         | BOOST SWITCHING FREQUENCY    |
|--------------------------------------------------------|------------------------------|
| < Auto Frequency Low Threshold (register 06 Bits[7:0]) | 250 kHz ( $D_{MAX} = 50\%$ ) |

**表 2. Auto Switching Frequency Operation (接下页)**

| BRIGHTNESS CODE MSBs (Register 0x05 bits[7:0])                                                                     | BOOST SWITCHING FREQUENCY |
|--------------------------------------------------------------------------------------------------------------------|---------------------------|
| > Auto Frequency Low Threshold (Register 06 Bits[7:0]) and < Auto Frequency High Threshold (Register 07 Bits[7:0]) | 500 kHz                   |
| ≥ Auto Frequency High Threshold (register 07 Bits[7:0])                                                            | 1 MHz                     |

Automatic-frequency mode is enabled whenever there is a non-zero code in either the Auto-Frequency High or Auto-Frequency Low registers. To disable the auto-frequency shift mode, set both registers to 0x00. When automatic-frequency select mode is disabled, the switching frequency operates at the programmed frequency (Register 0x03 bit[7]) across the entire LED current range. 表 3 provides a guideline for selecting the auto frequency threshold settings at  $V_{IN} = 3.7$  V. The actual setting must be verified in the application and optimized for the desired input voltage range.

**表 3. Auto Frequency Threshold Settings Examples,  $V_{IN} = 3.7$  V**

| CONDITION<br>( $V_f = 3.35$ V at $I_{LED} = 30$ mA) | INDUCTOR<br>( $\mu$ H) | RECOMMENDED AUTO FREQUENCY<br>HIGH THRESHOLD | RECOMMENDED AUTO FREQUENCY<br>LOW THRESHOLD |
|-----------------------------------------------------|------------------------|----------------------------------------------|---------------------------------------------|
| 2 × 4 LEDs                                          | 10                     | 0x65 (12 mA)                                 | 0x43 (8 mA)                                 |
| 2 × 5 LEDs                                          | 10                     | 0x5C (11 mA)                                 | 0x42 (7.9 mA)                               |
| 2 × 6 LEDs                                          | 10                     | 0x54 (10 mA)                                 | 0x3F (7.5 mA)                               |
| 2 × 7 LEDs                                          | 10                     | 0x4F (9.4 mA)                                | 0x36 (6.5 mA)                               |
| 2 × 8 LEDs                                          | 10                     | 0x65 (12 mA)                                 | 0x3F (7.5 mA)                               |

### 7.3.2.7 PWM Input

The PWM input is a sampled input which converts the input duty cycle information into an 11-bit brightness code. The use of a sampled input eliminates any noise and current ripple that traditional PWM controlled LED drivers are susceptible to. It also allows the PWM duty cycle to LED current response to have the same high accuracy and matching that is offered in the I<sup>2</sup>C brightness control.

The PWM input uses logic level thresholds with  $V_{IH\_MIN} = 1.25$  V and  $V_{IL\_MAX} = 0.4$  V. Because this is a sampled input, there are limits on the maximum PWM input frequency as well as the resolution that can be achieved.

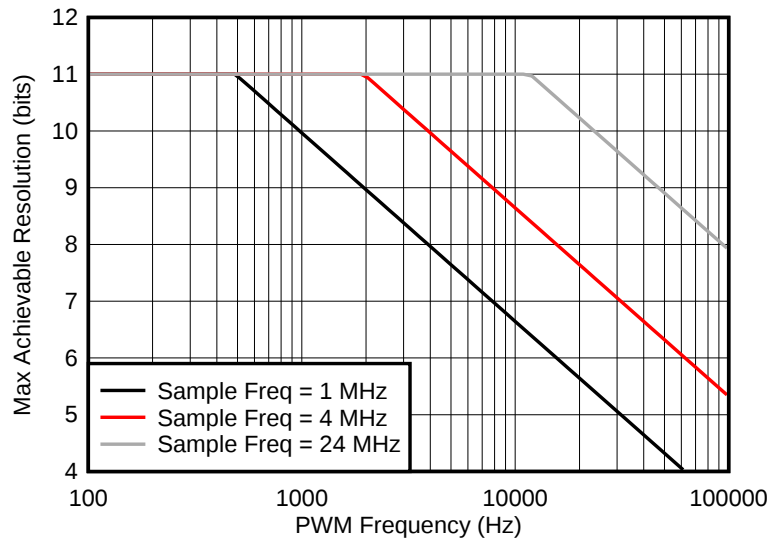
#### 7.3.2.7.1 PWM Sample Frequency

There are three selectable sample rates for the PWM input. The choice of sample rate depends on three factors:

1. Required PWM resolution (input duty cycle to brightness code, with 11 bits maximum)
2. PWM input frequency
3. Efficiency

##### 7.3.2.7.1.1 PWM Resolution and Input Frequency Range

The PWM input frequency range is 50 Hz to 50 kHz. To achieve the full 11-bit maximum resolution of PWM duty cycle to the LED brightness code (BRT), the input PWM duty cycle must be ≥ 11 bits, and the PWM sample period ( $1/f_{SAMPLE}$ ) must be smaller than the minimum PWM input pulse width. 图 37 shows the possible brightness code resolutions based on the input PWM frequency. The minimum PWM frequency for each PWM sample rate is described in [PWM Timeout](#).



**图 37. PWM Sample Rate, Resolution, and PWM Input Frequency**

#### 7.3.2.7.1.2 PWM Sample Rate and Efficiency

Efficiency is maximized when the lowest  $f_{\text{SAMPLE}}$  is chosen because this lowers the quiescent operating current of the device. 表 4 describes the typical efficiency tradeoffs for the different sample clock settings.

**表 4. PWM Sample Rate Trade-Offs**

| PWM SAMPLE RATE ( $f_{\text{SAMPLE}}$ ) |             | TYPICAL INPUT CURRENT, DEVICE ENABLED<br>$I_{\text{LED}} = 10 \text{ mA/string, } 2 \times 6 \text{ LEDs}$ | TYPICAL EFFICIENCY              |
|-----------------------------------------|-------------|------------------------------------------------------------------------------------------------------------|---------------------------------|
| 0x03 Bit[2]                             | 0x12 Bit[0] | $f_{\text{SW}} = 1 \text{ MHz}$                                                                            | $V_{\text{IN}} = 3.7 \text{ V}$ |
| 0                                       | 0           | 1.573 mA                                                                                                   | 87.7%                           |
| 1                                       | 0           | 1.635 mA                                                                                                   | 87.65%                          |
| X                                       | 1           | 2.358 mA                                                                                                   | 87%                             |

#### 7.3.2.7.1.2.1 PWM Sample Rate Example

The number of bits of resolution on the PWM input varies according to the PWM sample rate and PWM input frequency (see 表 5).

**表 5. PWM Resolution vs PWM Sample Rate**

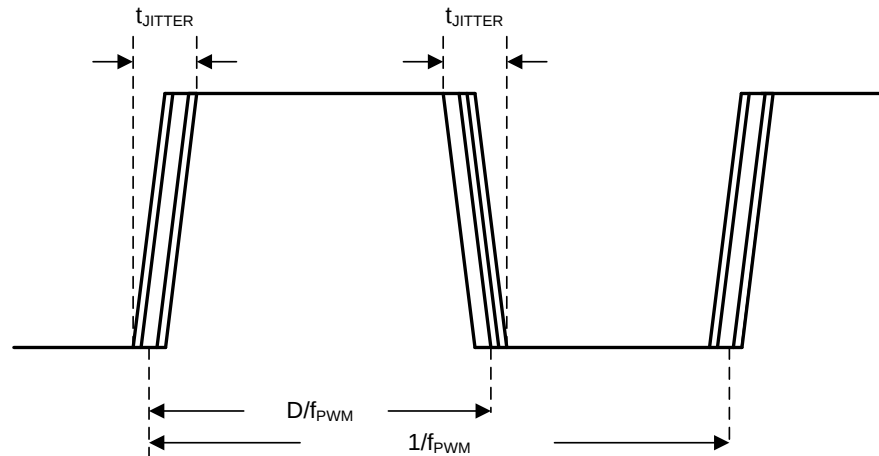
| PWM FREQUENCY (kHz) | RESOLUTION (PWM SAMPLE RATE = 1 MHz) | RESOLUTION (PWM SAMPLE RATE = 4 MHz) | RESOLUTION (PWM SAMPLE RATE = 24 MHz) |
|---------------------|--------------------------------------|--------------------------------------|---------------------------------------|
| 0.4                 | 11                                   | 11                                   | 11                                    |
| 2                   | 9                                    | 11                                   | 11                                    |
| 12                  | 6.4                                  | 8.4                                  | 11                                    |

#### 7.3.2.7.2 PWM Hysteresis

To prevent jitter at the input PWM signal from feeding through the PWM path and causing oscillations in the LED current, the LM36272 offers 4 selectable hysteresis settings. The hysteresis options for the 1-MHz and 4-MHz PWM sample rate settings are 1, 2, 4, and 6 bits and for the 24-MHz PWM sample rate setting 0, 1, 2, and 3 bits. The hysteresis works by forcing a specific number of 11-bit LSB code transitions to occur in the input duty cycle before the LED current changes. 表 6 describes the hysteresis. The hysteresis only applies during the change in direction of brightness currents. Once a change in the direction of the LED current has taken place, the PWM input must overcome the required LSB(s) of the hysteresis setting before the brightness change takes effect. Once the initial hysteresis has been overcome and the direction in brightness change remains the same, the PWM to current response changes with no hysteresis.

**表 6. PWM Input Hysteresis**

| HYSTERESIS SETTING<br>(0x03 Bits[1:0])    | MIN CHANGE IN PWM<br>PULSE WIDTH ( $\Delta t$ )<br>REQUIRED TO CHANGE<br>LED CURRENT, AFTER<br>DIRECTION CHANGE<br>(for $f_{PWM} < 11.7$ kHz) | MIN CHANGE IN PWM<br>DUTY CYCLE ( $\Delta D$ )<br>REQUIRED TO CHANGE<br>LED CURRENT AFTER<br>DIRECTION CHANGE | MIN ( $\Delta I_{LED}$ ), INCREASE FOR INITIAL CODE<br>CHANGE |             |
|-------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------|-------------|
|                                           |                                                                                                                                               |                                                                                                               | EXPONENTIAL MODE                                              | LINEAR MODE |
| 0 LSB (24 MHz sample rate only)           | $1/(f_{PWM} \times 2047)$                                                                                                                     | 0.05%                                                                                                         | 0.30%                                                         | 0.05%       |
| 1 LSB                                     | $1/(f_{PWM} \times 1023)$                                                                                                                     | 0.10%                                                                                                         | 0.61%                                                         | 0.10%       |
| 2 LSBs                                    | $1/(f_{PWM} \times 511)$                                                                                                                      | 0.20%                                                                                                         | 1.21%                                                         | 0.20%       |
| 3 LSBs (24-MHz sample rate only)          | $1/(f_{PWM} \times 255)$                                                                                                                      | 0.39%                                                                                                         | 2.40%                                                         | 0.39%       |
| 4 LSBs (1-MHz and 4-MHz sample rate only) | $1/(f_{PWM} \times 127)$                                                                                                                      | 0.78%                                                                                                         | 4.74%                                                         | 0.78%       |
| 6 LSBs (1-MHz and 4-MHz sample rate only) | $1/(f_{PWM} \times 31)$                                                                                                                       | 3.12%                                                                                                         | 17.66%                                                        | 3.12%       |



- $D$  is  $t_{JITTER} \times f_{PWM}$  or equal to #LSB's =  $\Delta D \times 2048$  codes.
- For 11-bit resolution, #LSBs is equal to a hysteresis setting of  $\text{LN}(\#LSB's)/\text{LN}(2)$ .
- For example, with a  $t_{JITTER}$  of 1  $\mu s$  and a  $f_{PWM}$  of 5 kHz, the hysteresis setting should be:  
 $\text{LN}(1 \mu s \times 5 \text{ kHz} \times 2048)/\text{LN}(2) = 3.35$  (4 LSBs).

**图 38. PWM Hysteresis Example**

### 7.3.2.7.3 PWM Step Response

The LED current response due to a step change in the PWM input is approximately 2 ms to go from minimum LED current to maximum LED current.

### 7.3.2.7.4 PWM Timeout

The LM36272 PWM timeout feature turns off the boost output when the PWM is enabled and there is no PWM pulse detected. The timeout duration changes based on the PWM sample rate selected which results in a minimum supported PWM input frequency. The sample rate, timeout, and minimum supported PWM frequency are summarized in [表 7](#).

表 7. PWM Timeout and Minimum Supported PWM Frequency vs PWM Sample Rate

| SAMPLE RATE | TIMEOUT  | MINIMUM SUPPORTED PWM FREQUENCY |
|-------------|----------|---------------------------------|
| 1 MHz       | 25 msec  | 48 Hz                           |
| 4 MHz       | 3 msec   | 400 Hz                          |
| 24 MHz      | 0.6 msec | 2000 Hz                         |

#### 7.3.2.7.5 PWM-to-Digital Code Readback

In PWM mode, registers 0x12 and 0x13 contain the PWM duty cycle to the 11-bit code conversion information. Register 0x12 contains the 8 LSBs of the brightness code and register 0x13 the 3 MSBs. To translate this reading to the actual LED current setting of the LM36272, convert it to the corresponding duty cycle and multiply it by the brightness level setting in the brightness registers (0x04 and 0x05). For example, if the 11-bit brightness code is set to 0x554 (decimal 1364) and the PWM-to-digital code readback is 0x3FF (decimal 1023) in linear mode, the expected LED current is approximately:  $I_{LED} = 45.37 \mu A + ( ( 1023 / 2047 ) \times 14.63 \times 1364 ) \mu A = 10.018 \text{ mA}$  (approximately 50% duty cycle).

#### 7.3.2.8 Regulated Headroom Voltage

In order to optimize efficiency, current accuracy, and string-to-string matching the LED current sink regulated headroom voltage ( $V_{HR}$ ) varies with the target LED current. 图 39 details the typical variation of  $V_{HR}$  with LED current. This allows for increased solution efficiency as the dropout voltage of the LED driver changes. Furthermore, in order to ensure that all current sinks remain in regulation whenever there is a mismatch in string voltages, the minimum headroom voltage between VLED1, VLED2 becomes the regulation point for the boost converter. For example, if the LEDs connected to LED1 require 12 V and the LEDs connected to LED2 require 12.5 V at the programmed current, then the voltage at LED1 is  $V_{HR} + 0.5 \text{ V}$  and the voltage at LED2 is  $V_{HR}$ . In other words, the boost makes the cathode of the highest voltage LED string the regulation point.

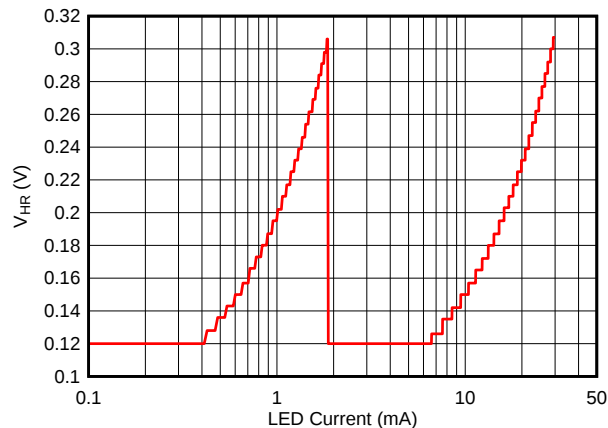


图 39. LM36272 Typical Exponential Regulated Headroom Voltage vs Programmed LED Current

#### 7.3.2.9 Backlight Fault Protection and Faults

##### 7.3.2.9.1 Backlight Overvoltage Protection (OVP)

The LM36272 provides an OVP that monitors the LED boost output voltage ( $V_{BL\_OUT}$ ) and protects BL\_OUT and BL\_SW from exceeding safe operating voltages. The OVP threshold can be set to 17 V, 21 V, 25 V, or 29 V with register 0x02 bits[7:5]. Once an OVP event has been detected, the BL\_OVP flag is set in the Flags Register, and the subsequent behavior depends on the state of bit OVP\_Mode in the Backlight Configuration 1 Register: If OVP\_Mode is set to 0, as soon as  $V_{BL\_OUT}$  falls below the backlight OVP threshold, the LM36272 begins switching again. If OVP\_Mode is set to 1 and the device detects three occurrences of  $V_{BL\_OUT} > V_{OVP\_BL}$  while any of the enabled current sink headroom voltages drops below 40 mV, the Backlight Boost OVP flag is set, the Backlight Enable bit is cleared, and the LM36272 enters standby mode. When the device is shut down due to a Backlight Boost OVP fault, the Flags register must be read back before the device can be reenabled.

### 7.3.2.9.2 Backlight Overcurrent Protection (OCP)

The LM36272 has 4 selectable OCP thresholds (900 mA, 1200 mA, 1500 mA, and 1800 mA). These are programmable in register 0x11 bits[1:0]. The OCP threshold is a cycle-by-cycle current limit and is detected in the internal low-side NFET. Once the threshold is hit the NFET turns off for the remainder of the switching period.

If enough overcurrent threshold events occur, the BL\_OCP Flag (register 0x0F, bit[0]) is set. To avoid transient conditions from inadvertently setting the BL\_OCP Flag, a pulse density counter monitors OCP threshold events over a 128- $\mu$ s period. If 8 consecutive 128- $\mu$ s periods occur where the pulse density count has found 2 or more OCP events, then the BL\_OCP Flag is set.

During device start-up and during brightness code changes, there is a 4-ms blank time where BL OCP events are ignored. As a result, if the device starts up in an overcurrent condition there is an approximate 5-ms delay before the BL\_OCP Flag is set.

## 7.3.3 LCM Bias

### 7.3.3.1 Display Bias Boost Converter ( $V_{VPOS}$ , $V_{VNEG}$ )

A single high-efficiency boost converter provides a positive voltage rail,  $V_{LCM\_OUT}$ , which serves as the power rail for the LCM VPOS and VNEG outputs.

- The  $V_{VPOS}$  output LDO has a programmable range from 4 V up to 6.5 V with 50-mV steps and can supply up to 80 mA.
- The  $V_{VNEG}$  output is generated from a regulated, inverting charge pump and has an adjustable range of –6.5 V up to –4 V with 50-mV steps and a maximum load of 80 mA.

Boost voltage also has a programmable range from 4 V up to 7.15 V with 50-mV steps. Refer to [表 22](#), [表 23](#) and [表 24](#) for  $V_{LCM\_OUT}$ ,  $V_{VPOS}$  and  $V_{VNEG}$  voltage settings. When selecting a suitable boost-output voltage, the following estimation can be used:  $V_{LCM\_OUT} = \max(V_{VPOS}, |V_{VNEG}|) + V_{HR}$ , where  $V_{HR} \geq 200$  mV for lower currents and  $V_{HR} \geq 300$  mV for higher currents. When the device input voltage ( $V_{IN}$ ) is greater than the programmed LCM boost output voltage, the boost voltage is regulated to  $V_{IN} + 100$  mV.  $V_{VPOS}$  and  $V_{VNEG}$  voltage settings cannot be changed while they are enabled.  $V_{VPOS}$  and  $V_{VNEG}$  register setting targets take effect only after the outputs are disabled and re-enabled. However, the  $V_{LCM\_OUT}$  target changes immediately upon a register write.

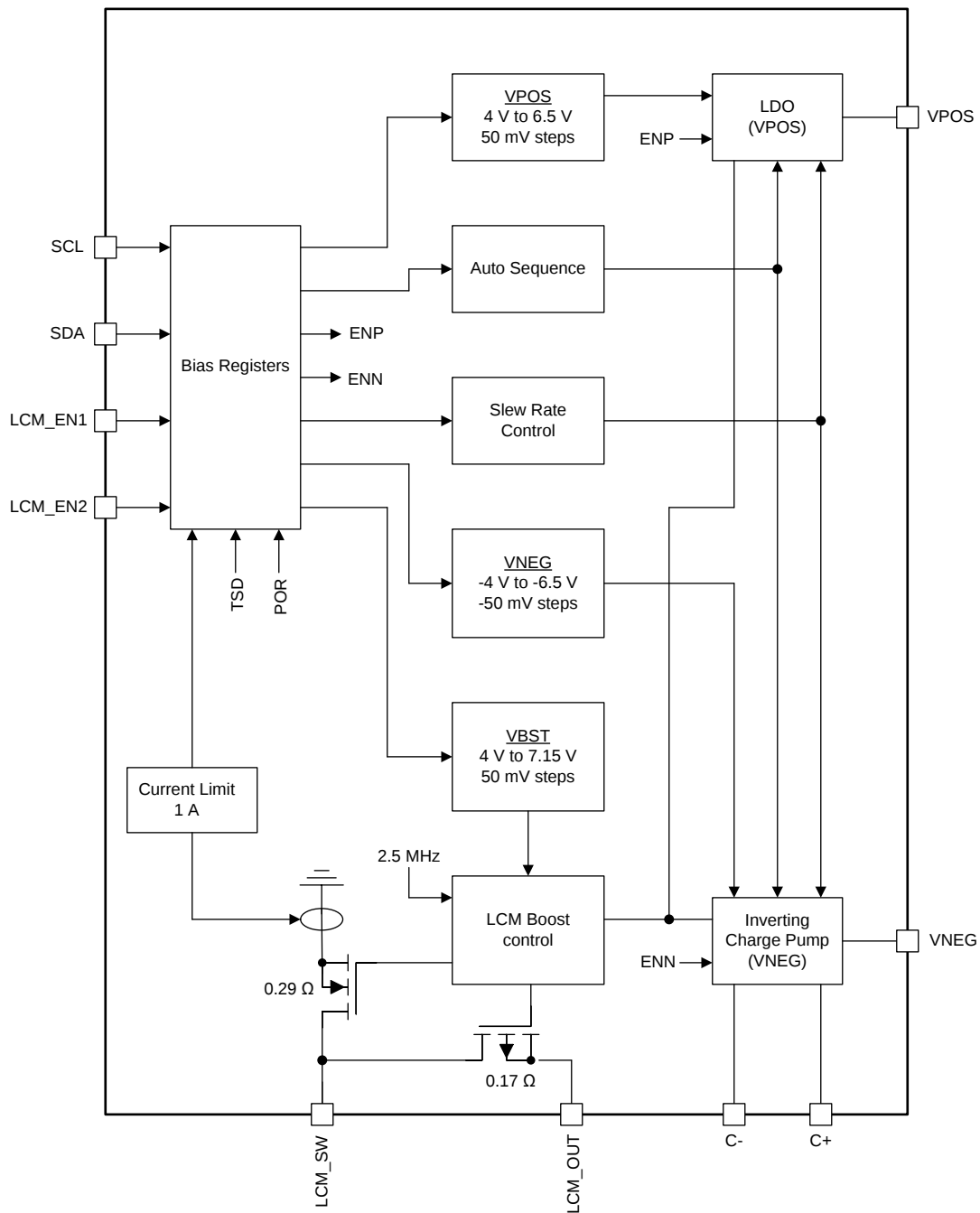


图 40. LCM Boost Block Diagram

The LCM Bias outputs can be controlled either by pins LCM\_EN1 and LCM\_EN2 or register bits VPOS\_EN and VNEG\_EN, register 0x09 bits[2:1]. Setting bit EXT\_EN, register 0x09 bit[0], to 1 allows pins LCM\_EN1 and LCM\_EN2 to control VPOS and VNEG, respectively, while setting this bit to 0 yields control to bits VPOS\_EN and VNEG\_EN. Refer to 表 8 for LCM bias control information.

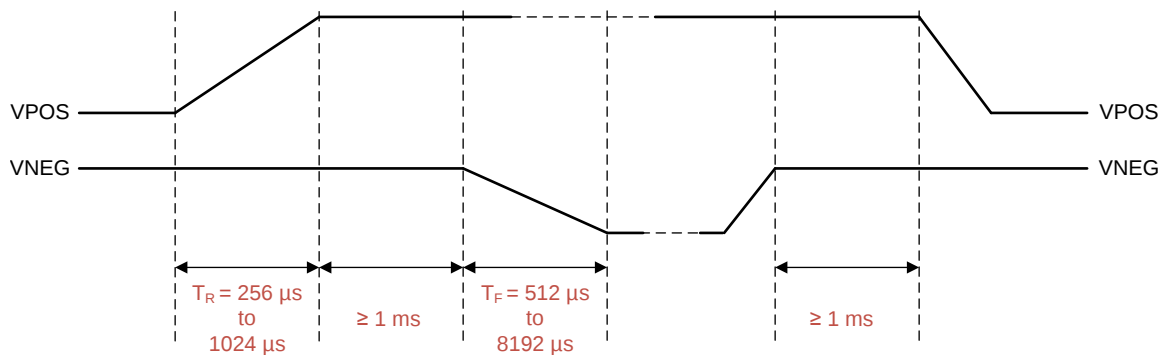
**表 8. LCM Operating Modes**

| HWEN | LCM_EN2<br>INPUT | LCM_EN1<br>INPUT | LCM_EN MODE<br>0x09[7:5] | VPOS_EN<br>0x09[2] | VNEG_EN<br>0x09[1] | EXT_EN<br>0x09[0] | ACTION                                                                                  |
|------|------------------|------------------|--------------------------|--------------------|--------------------|-------------------|-----------------------------------------------------------------------------------------|
| 0    | X                | X                | XXX                      | X                  | X                  | X                 | Device shutdown                                                                         |
| 1    | 0                | 0                | 000                      | X                  | X                  | 1                 | Standby <sup>(1)</sup>                                                                  |
| 1    | X                | X                | 100                      | 0                  | 0                  | 0                 | Standby <sup>(1)</sup>                                                                  |
| 1    | 0                | 1                | 100                      | X                  | X                  | 1                 | VPOS enabled via external input                                                         |
| 1    | 1                | 0                | 100                      | X                  | X                  | 1                 | VNEG enabled via external input                                                         |
| 1    | 1                | 1                | 100                      | X                  | X                  | 1                 | VPOS and VNEG enabled via external input                                                |
| 1    | X                | X                | 100                      | 1                  | 0                  | 0                 | VPOS enabled via I <sup>2</sup> C                                                       |
| 1    | X                | X                | 100                      | 0                  | 1                  | 0                 | VNEG enabled via I <sup>2</sup> C                                                       |
| 1    | X                | X                | 100                      | 1                  | 1                  | 0                 | VPOS and VNEG enabled via I <sup>2</sup> C                                              |
| 1    | X                | X                | 101                      | 1                  | 1                  | 0                 | VPOS and VNEG enabled via I <sup>2</sup> C with auto-sequencing                         |
| 1    | 1                | X                | 101                      | X                  | X                  | 1                 | VPOS and VNEG enabled via LCM_EN2 with auto-sequencing                                  |
| 1    | 1                | X                | 110                      | 1                  | 0                  | X                 | WAKE1<br>V <sub>VPOS</sub> = V <sub>IN</sub><br>V <sub>VNEG</sub> = GND                 |
| 1    | 1                | X                | 110                      | 0                  | 1                  | X                 | WAKE1<br>V <sub>VPOS</sub> = GND<br>V <sub>VNEG</sub> = -V <sub>IN</sub>                |
| 1    | 1                | X                | 110                      | 1                  | 1                  | X                 | WAKE1<br>V <sub>VPOS</sub> = V <sub>IN</sub><br>V <sub>VNEG</sub> = -V <sub>IN</sub>    |
| 1    | 0                | X                | 110                      | 1                  | 1                  | X                 | WAKE1<br>Standby <sup>(1)</sup>                                                         |
| 1    | 1                | X                | 110                      | 0                  | 0                  | X                 | WAKE1<br>Standby <sup>(1)</sup>                                                         |
| 1    | 1                | X                | 111                      | 1                  | 0                  | X                 | WAKE2<br>V <sub>VPOS</sub> = programmed target<br>V <sub>VNEG</sub> = disabled          |
| 1    | 1                | X                | 111                      | 0                  | 1                  | X                 | WAKE2<br>V <sub>VPOS</sub> = disabled<br>V <sub>VNEG</sub> = programmed target          |
| 1    | 1                | X                | 111                      | 1                  | 1                  | X                 | WAKE2<br>V <sub>VPOS</sub> = programmed target<br>V <sub>VNEG</sub> = programmed target |
| 1    | 1                | X                | 111                      | 0                  | 0                  | X                 | WAKE2<br>Standby <sup>(1)</sup>                                                         |
| 1    | 0                | X                | 111                      | 1                  | 1                  | X                 | WAKE2<br>Standby <sup>(1)</sup>                                                         |

(1) Standby implies that VPOS and VNEG are either high impedance or being internally pulled low via the active pulldown, and that the LCM boost is off. Shutdown implies that the device is in reset and no I<sup>2</sup>C communication is possible.

### 7.3.3.2 Auto Sequence Mode

If this mode is selected the LM36272 controls the turnon and turnoff of VPOS and VNEG as shown in 图 41.


**图 41. Auto Sequence Timing**

### 7.3.3.3 Wake-up Mode

If wake-up mode is selected the LM36272 allows on/off control of both VPOS and VNEG with only one external pin (LCM\_EN2). Any combination of VPOS or VNEG can be turned on based on the state of bits VPOS\_EN and VNEG\_EN in register 0x09. In these modes the internal shutdown timing of the VPOS and VNEG blocks is modified to allow for lower quiescent current in standby mode, therefore reducing the average current consumption during a sequence of on/off events.

There are two wake-up modes available on the LM36272: wake1 and wake2.

#### 7.3.3.3.1 Wake1 Mode

In wake1 mode the LM36272 passes  $V_{IN}$  through to the LCM boost output and the enabled VPOS, VNEG outputs. Due to the impedance of the LCM boost, the VPOS LDO and the VNEG charge pump, the respective outputs are regulated close to  $V_{IN}$  only at very light load current and droop below  $V_{IN}$  as the load increases.

#### 7.3.3.3.2 Wake2 Mode

In wake2 mode the LM36272 regulates the LCM boost output as well as the enabled VPOS and VNEG outputs to their programmed voltage.

### 7.3.3.4 Active Discharge

An optional active discharge is available for the VPOS and VNEG output rails. An internal switch resistance for this discharge function is implemented on each output rail. The VPOS active discharge function is enabled with register 0x09 bit[4] and the VNEG active discharge with register 0x09 bit[3].

### 7.3.3.5 LCM Bias Protection and Faults

The LCM bias block of the LM36272 provides three protection mechanisms in order to prevent damage to the device. Note that none of these have any effect on backlight operation.

#### 7.3.3.5.1 LCM Overvoltage (OVP) Protection

The LM36272 provides OVP that monitors the LCM bias boost output voltage ( $V_{LCM\_OUT}$ ) and protects LCM\_OUT and LCM\_SW from exceeding safe operating voltages. The OVP threshold is set to 7.8 V (typical). If an LCM bias overvoltage condition is detected, the LCM\_OVP flag, register 0x0F bit[5], is set. Once the OVP condition is removed, the flag can be cleared with an I<sup>2</sup>C read back of the register. An LCM OVP condition does not cause the LCM bias to shut down; it is a report-only flag.

#### 7.3.3.5.2 VPOS Short-Circuit Protection

If the current at VPOS exceeds 180 mA (typical), the LM36272 sets the VPOS\_SHORT flag, register 0x0F bit[3]. A readback of register 0x0F is required to clear the flag. The outcome of a VPOS\_SHORT detection depends on the configuration of the bias short-circuit mode option, register 0x0A bits[7:6]. The options are report-only flag, shutdown VPOS/VNEG, and shutdown VPOS/VNEG and backlight. To prevent narrow spikes from falsely triggering a VPOS short-circuit condition, the LM36272 provides four programmable VPOS short-circuit filter options: 100  $\mu$ s, 500  $\mu$ s, 1 ms, and 2 ms. These are selected in register 0x0B bits[3:2].

#### 7.3.3.5.3 VNEG Short-Circuit Protection

If the voltage at VNEG rises (towards GND) to above 84% of its programmed value (typical), the LM36272 sets the VNEG\_SHORT flag, register 0x0F bit[2]. A readback of register 0x0F is required to clear the flag. The outcome of a VNEG\_SHORT detection depends on the configuration of the bias short-circuit mode option, register 0x0A bits[7:6]. The options are report-only flag, shut down VPOS/VNEG, and shut down VPOS/VNEG and backlight. To prevent narrow spikes from falsely triggering a VNEG short circuit condition, the LM36272 provides four programmable VNEG short circuit filter options: 100  $\mu$ s, 500  $\mu$ s, 1 ms, and 2 ms. These are selected in register 0x0B bits[1:0].

### 7.3.4 Software Reset

Bit[7] (SWR\_RESET) of the Enable Register (0x08) is a software reset bit. Writing a 1 to this bit resets all I<sup>2</sup>C register values to their default values. Once the LM36272 has finished resetting all registers, it auto-clears the SWR\_RESET bit.

### 7.3.5 HWEN Input

The HWEN pin is a global hardware enable for the LM36272. This pin must be pulled to logic HIGH to enable the device and the I<sup>2</sup>C-compatible interface. There is a 300-k $\Omega$  internal resistor between HWEN and GND. When this pin is at logic LOW, the LM36272 is placed in shutdown, the I<sup>2</sup>C-compatible interface is disabled, and the internal registers are reset to their default state. TI recommends that  $V_{IN}$  has risen above 2.7 V before setting HWEN HIGH.

### 7.3.6 Thermal Shutdown (TSD)

The LM36272 has TSD protection which shuts down the backlight boost, all backlight current sinks, LCM bias boost, inverting charge pump, and the LDO when the die temperature reaches or exceeds 140°C (typical). The I<sup>2</sup>C interface remains active during a TSD event. If a TSD fault occurs the TSD fault is set (register 0x0F bit[6]). The fault is cleared by an I<sup>2</sup>C read of register 0x0F or by toggling the HWEN pin.

## 7.4 Device Functional Modes

### 7.4.1 Modes of Operation

**Shutdown:** The LM36272 is in shutdown when the HWEN pin is low.

**Standby:** After the HWEN pin is set high the LM36272 goes into standby mode. In standby mode, I<sup>2</sup>C writes are allowed but references, bias currents, the oscillator, LCM powers, and backlight are all disabled to keep the quiescent supply current low (2  $\mu$ A typical).

**Normal mode:** Both main blocks of the LM36272 are independently controlled. For enabling each of the blocks in all available modes, see [表 1](#) and [表 8](#).

## 7.5 Programming

### 7.5.1 I<sup>2</sup>C-Compatible Serial Bus Interface

#### 7.5.1.1 Interface Bus Overview

The I<sup>2</sup>C-compatible synchronous serial interface provides access to the programmable functions and registers on the device. This protocol uses a two-wire interface for bidirectional communications between the devices connected to the bus. The two interface lines are the Serial Data Line (SDA) and the Serial Clock Line (SCL). These lines must be connected to a positive supply via a pullup resistor and remain HIGH even when the bus is idle.

Every device on the bus is assigned a unique address and acts as either a Master or a Slave, depending whether it generates or receives the serial clock (SCL).

#### 7.5.1.2 Data Transactions

One data bit is transferred during each clock pulse. Data is sampled during the high state of the SCL. Consequently, throughout the clock's high period, the data remains stable. Any changes on the SDA line during the high state of the SCL and in the middle of a transaction, aborts the current transaction. New data is sent during the low SCL state. This protocol permits a single data line to transfer both command/control information and data using the synchronous serial clock.

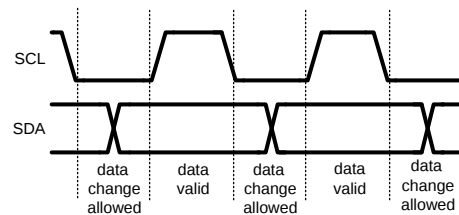


图 42. Data Validity

Each data transaction is composed of a start condition, a number of byte transfers (set by the software), and a stop condition to terminate the transaction. Every byte written to the SDA bus must be 8 bits long and is transferred with the most significant bit first. After each byte, an acknowledge signal must follow. The following sections provide further details of this process.

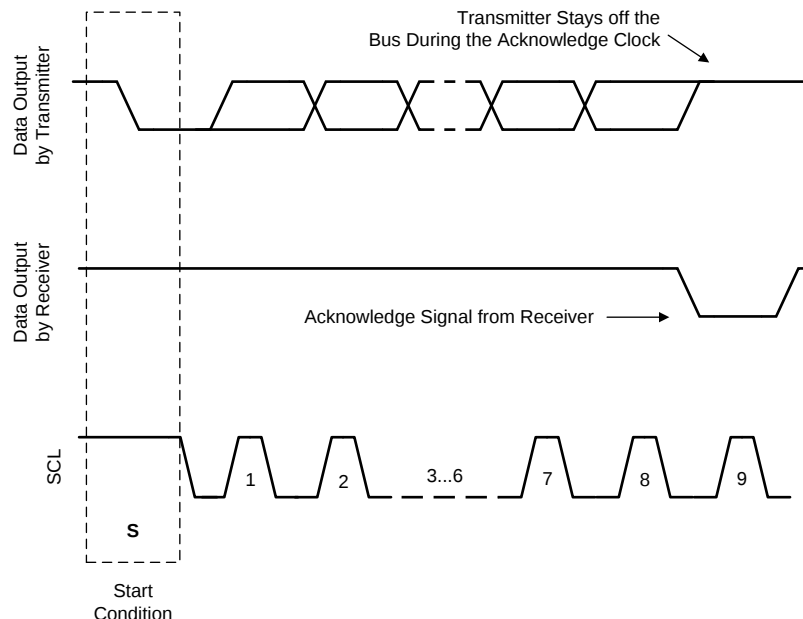


图 43. Acknowledge Signal

## Programming (接下页)

The Master device on the bus always generates the start and stop conditions (control codes). After a Start Condition is generated, the bus is considered busy, and it retains this status until a certain time after a stop condition is generated. A high-to-low transition of the data line (SDA) while the clock (SCL) is high indicates a start condition. A low-to-high transition of the SDA line while the SCL is high indicates a stop condition.

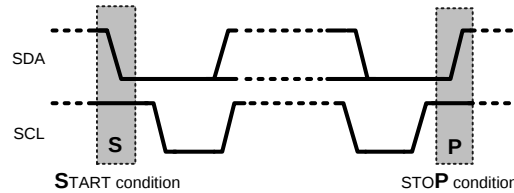


图 44. Start and Stop Conditions

In addition to the first start condition, a repeated start condition can be generated in the middle of a transaction. This allows another device to be accessed, or a register read cycle.

### 7.5.1.3 Acknowledge Cycle

The acknowledge cycle consists of two signals: the acknowledge clock pulse the master sends with each byte transferred, and the acknowledge signal sent by the receiving device.

The master generates the acknowledge clock pulse on the ninth clock pulse of the byte transfer. The transmitter releases the SDA line (permits it to go high) to allow the receiver to send the acknowledge signal. The receiver must pull down the SDA line during the acknowledge clock pulse and ensure that SDA remains low during the high period of the clock pulse, thus signaling the correct reception of the last data byte and its readiness to receive the next byte.

### 7.5.1.4 Acknowledge After Every Byte Rule

The master generates an acknowledge clock pulse after each byte transfer. The receiver sends an acknowledge signal after every byte received.

There is one exception to the *acknowledge after every byte* rule. When the master is the receiver, it must indicate to the transmitter an end of data by not-acknowledging (*negative acknowledge*) the last byte clocked out of the slave. This *negative acknowledge* still includes the acknowledge clock pulse (generated by the master), but the SDA line is not pulled down.

### 7.5.1.5 Addressing Transfer Formats

Each device on the bus has a unique slave address. The LM36272 operates as a slave device with the 7-bit address. If an 8-bit address is used for programming, the 8th bit is 1 for read and 0 for write. The 7-bit address for the device is 0x11.

Before any data is transmitted, the master transmits the address of the slave being addressed. The slave device sends an acknowledge signal on the SDA line, once it recognizes its address. The slave address is the first seven bits after a Start Condition. The direction of the data transfer (R/W) depends on the bit sent after the slave address — the eighth bit.

When the slave address is sent, each device in the system compares this slave address with its own. If there is a match, the device considers itself addressed and sends an acknowledge signal. Depending upon the state of the R/W bit (1: read, 0: write), the device acts as a transmitter or a receiver.

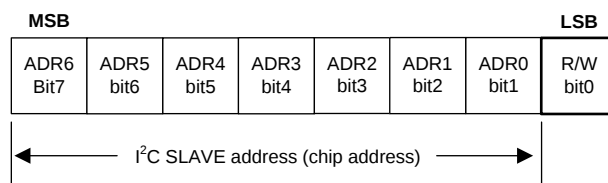


图 45. I<sup>2</sup>C Device Address

## Programming (接下页)

### Control Register Write Cycle

- Master device generates start condition.
- Master device sends slave address (7 bits) and the data direction bit (r/w = 0).
- Slave device sends acknowledge signal if the slave address is correct.
- Master sends control register address (8 bits).
- Slave sends acknowledge signal.
- Master sends data byte to be written to the addressed register.
- Slave sends acknowledge signal.
- If master sends further data bytes the control register address is incremented by one after acknowledge signal.
- Write cycle ends when the master creates stop condition.

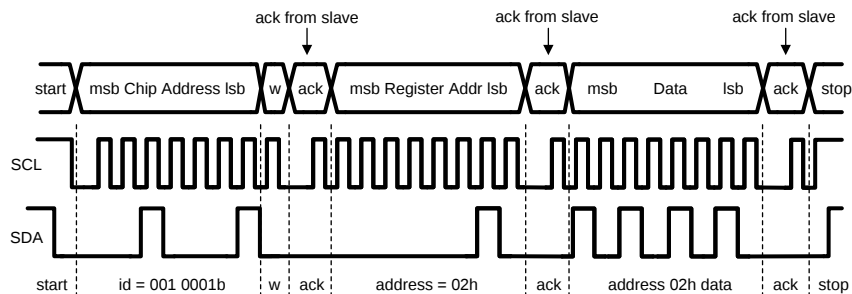
### Control Register Read Cycle

- Master device generates a start condition.
- Master device sends slave address (7 bits) and the data direction bit (r/w = 0).
- Slave device sends acknowledge signal if the slave address is correct.
- Master sends control register address (8 bits).
- Slave sends acknowledge signal
- Master device generates repeated start condition.
- Master sends the slave address (7 bits) and the data direction bit (r/w = 1).
- Slave sends acknowledge signal if the slave address is correct.
- Slave sends data byte from addressed register.
- If the master device sends acknowledge signal, the control register address is incremented by one. Slave device sends data byte from addressed register.
- Read cycle ends when the master does not generate acknowledge signal after data byte and generates stop condition.

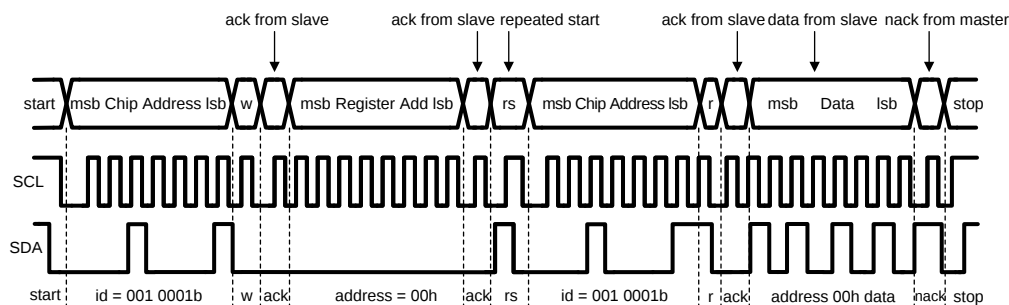
**表 9. I<sup>2</sup>C Data Read/Write<sup>(1)</sup>**

|            | ADDRESS MODE                                                                                                                                                                                                                                                   |
|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Data Read  | <Start Condition><br><Slave Address><r/w = 0>[Ack]<br><Register Addr>[Ack]<br><Repeated Start Condition><br><Slave Address><r/w = 1>[Ack]<br>[Register Data]<Ack or NAck><br>...additional reads from subsequent register address possible<br><Stop Condition> |
| Data Write | <Start Condition><br><Slave Address><r/w = 0>[Ack]<br><Register Addr>[Ack]<br><Register Data>[Ack]<br>...additional writes to subsequent register address possible<br><Stop Condition>                                                                         |

(1) < > = Data from master, [ ] = Data from slave


**图 46. Register Write Format**

When a READ function is to be accomplished, a WRITE function must precede the READ function, as show in the Read Cycle waveform.


**图 47. Register Read Format**

注

w = write (SDA = 0), r = read (SDA = 1), ack = acknowledge (SDA pulled down by either master or slave), rs = repeated start id = 7-bit chip address

### 7.5.1.6 Register Programming

For glitch-free operation, the following bits and/or registers must only be programmed while the LED Enable bits are 0 (Register 0x08, Bit [1:0] = 0) and/or Backlight Enable bit is 0 (Register 0x08, Bit[4] = 0):

1. Register 0x02 Bit[0] (PWM Enable)
2. Register 0x02 Bits[1] (PWM Ramp)
3. Register 0x02 Bit[2] (PWM Config)
4. Register 0x02 Bits[3] (LED Current Mapping)
5. Register 0x03 Bit[1:0] (PWM Hysteresis)
6. Register 0x03 Bit[2] (PWM Sample)
7. Register 0x03 Bit[6:3] (LED Current Ramp)
8. Register 0x10 Bit[0] (PWM HF Sample)
9. Register 0x10 Bit[1] (PWM Glitch Filter)
10. Register 0x10 Bit [4:3] (LED Feedback Enable)
11. Register 0x06 (auto frequency high threshold)
12. Register 0x07 (auto frequency low threshold)

## 7.6 Register Maps

**表 10. Register Default Values**

| I <sup>2</sup> C ADDRESS | REGISTER NAME                             | READ/WRITE | POWER ON/RESET VALUE | SECTION            |
|--------------------------|-------------------------------------------|------------|----------------------|--------------------|
| 0x01                     | Revision Register                         | R          | 0x01                 | <a href="#">Go</a> |
| 0x02                     | Backlight Configuration1 Register         | R/W        | 0x28                 | <a href="#">Go</a> |
| 0x03                     | Backlight Configuration 2 Register        | R/W        | 0x8D                 | <a href="#">Go</a> |
| 0x04                     | Backlight Brightness LSB Register         | R/W        | 0x07                 | <a href="#">Go</a> |
| 0x05                     | Backlight Brightness MSB Register         | R/W        | 0xFF                 | <a href="#">Go</a> |
| 0x06                     | Backlight Auto-Frequency Low Register     | R/W        | 0x00                 | <a href="#">Go</a> |
| 0x07                     | Backlight Auto-Frequency High Register    | R/W        | 0x00                 | <a href="#">Go</a> |
| 0x08                     | Backlight Enable Register                 | R/W        | 0x00                 | <a href="#">Go</a> |
| 0x09                     | Display Bias Configuration 1 Register     | R/W        | 0x18                 | <a href="#">Go</a> |
| 0x0A                     | Display Bias Configuration 2 Register     | R/W        | 0x11                 | <a href="#">Go</a> |
| 0x0B                     | Display Bias Configuration 3 Register     | R/W        | 0x00                 | <a href="#">Go</a> |
| 0x0C                     | LCM Boost Bias Register                   | R/W        | 0x28                 | <a href="#">Go</a> |
| 0x0D                     | VPOS Bias Register                        | R/W        | 0x1E                 | <a href="#">Go</a> |
| 0x0E                     | VNEG Bias Register                        | R/W        | 0x1C                 | <a href="#">Go</a> |
| 0x0F                     | Flags Register                            | R          | 0x00                 | <a href="#">Go</a> |
| 0x10                     | Backlight Option 1 Register               | R/W        | 0x06                 | <a href="#">Go</a> |
| 0x11                     | Backlight Option 2 Register               | R/W        | 0x35                 | <a href="#">Go</a> |
| 0x12                     | PWM-to-Digital Code Readback LSB Register | R          | 0x00                 | <a href="#">Go</a> |
| 0x13                     | PWM-to-Digital Code Readback MSB Register | R          | 0x00                 | <a href="#">Go</a> |

### 7.6.1 Revision Register (Address = 0x01)[Reset = 0x01]

**图 48. Revision Register**

| 7          | 6          | 5          | 4          | 3          | 2          | 1          | 0          |
|------------|------------|------------|------------|------------|------------|------------|------------|
| DEV_REV[6] | DEV_REV[5] | DEV_REV[4] | DEV_REV[3] | DEV_REV[1] | DEV_REV[0] | DEV_REV[1] | DEV_REV[0] |
| R-0        | R-0        | R-0        | R-0        | R-0        | R-0        | R-0        | R-1        |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 11. Revision Register Field Descriptions**

| Bit | Field           | Type | Reset            | Description                                 |
|-----|-----------------|------|------------------|---------------------------------------------|
| 7-5 | DEVICE REVISION | R    | 000000 or 000001 | DEV_REVISION,<br>A0 = 000000<br>A1 = 000001 |
| 1-0 | VENDOR          | R    | 01               | VENDOR, Texas Instruments = 01              |

## 7.6.2 Backlight Configuration1 Register (Address = 0x02)[Reset = 0x28]

**图 49. Backlight Configuration 1 Register**

| 7         | 6         | 5         | 4        | 3        | 2          | 1        | 0          |
|-----------|-----------|-----------|----------|----------|------------|----------|------------|
| BL_OVP[2] | BL_OVP[1] | BL_OVP[0] | OVP_MODE | BLED_MAP | PWM_CONFIG | PWM_RAMP | PWM_ENABLE |
| R/W-0     | R/W-0     | R/W-1     | R/W-0    | R/W-1    | R/W-0      | R/W-0    | R/W-0      |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 12. Backlight Configuration 1 Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                            |
|-----|------------|------|-------|----------------------------------------------------------------------------------------|
| 7-5 | BL_OVP     | R/W  | 001   | Backlight OVP<br>000: 17 V<br>001: 21 V<br>010: 25 V<br>011: 29 V<br>100 to 111 = 29 V |
| 4   | OVP_MODE   | R/W  | 0     | 0: OVP is report only<br>1: OVP causes shutdown                                        |
| 3   | BLED_MAP   | R/W  | 1     | 0: Exponential<br>1: Linear                                                            |
| 2   | PWM_CONFIG | R/W  | 0     | 0: Active high<br>1: Active low                                                        |
| 1   | PWM_RAMP   | R/W  | 0     | 0: No PWM ramp<br>1: LED current ramps with changes in duty cycle                      |
| 0   | PWM_ENABLE | R/W  | 0     | 0: PWM disabled<br>1: PWM enabled                                                      |

## 7.6.3 Backlight Configuration 2 Register (Address = 0x03)[Reset = 0x8D]

**图 50. Backlight Configuration 2 Register**

| 7                     | 6                      | 5                      | 4                      | 3                      | 2                         | 1           | 0           |
|-----------------------|------------------------|------------------------|------------------------|------------------------|---------------------------|-------------|-------------|
| BL BOOST<br>FREQUENCY | LED CURRENT<br>RAMP[3] | LED CURRENT<br>RAMP[2] | LED CURRENT<br>RAMP[1] | LED CURRENT<br>RAMP[0] | PWM SAMPLE <sup>(1)</sup> | PWM HYST[1] | PWM HYST[0] |
| R/W-1                 | R/W-0                  | R/W-0                  | R/W-0                  | R/W-1                  | R/W-1                     | R/W-0       | R/W-1       |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

(1) (Note: register 0x10 bit[0] = 1 enables 24-MHz sample mode.)

**表 13. Backlight Configuration 2 Register Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                          |
|-----|--------------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | BL BOOST FREQUENCY |      | 1     | Sets the backlight boost switch frequency<br>0: 500 kHz<br>1: 1 MHz (Default)                                                                                                                                                                                                                                                                                                                                                        |
| 6-3 | LED CURRENT RAMP   | R/W  | 0001  | Controls backlight LED ramping time. The transient time is a constant time that the backlight takes to transition from an existing programmed code to a new programmed code.<br>0000: 0 $\mu$ s<br>0001: 500 $\mu$ s<br>0010: 750 $\mu$ s<br>0011: 1 ms<br>0100: 2 ms<br>0101: 5 ms<br>0110: 10 ms<br>0111: 20 ms<br>1000: 50 ms<br>1001: 100 ms<br>1010: 250 ms<br>1011: 800 ms<br>1100: 1 s<br>1101: 2 s<br>1110: 4 s<br>1111: 8 s |
| 2   | PWM SAMPLE         | R/W  | 1     | Sets PWM sampling frequency<br>0: 1 MHz<br>1: 4 MHz (Default)<br>0 Note: register 0x10 bit[0] = 1 enables 24-MHz sample mode                                                                                                                                                                                                                                                                                                         |
| 1-0 | PWM HYST           | R/W  | 01    | Sets the minimum change in PWM input duty cycle that results in a change of backlight LED brightness level<br>PWM Sample Frequency = 1 MHz or 4 MHz:<br>00: 1 bit<br>01: 2 bits<br>10: 4 bits<br>11: 6 bits<br>PWM Sample Frequency = 24 MHz:<br>00: 0<br>01: 1 bit<br>10: 2 bits<br>11: 3 bits                                                                                                                                      |

## 7.6.4 Backlight Brightness LSB Register (Address = 0x04)[Reset = 0x07]

**图 51. Backlight Brightness LSB Register**

| 7        | 6 | 5 | 4 | 3 | 2      | 1      | 0      |
|----------|---|---|---|---|--------|--------|--------|
| NOT USED |   |   |   |   | BRT[2] | BRT[1] | BRT[0] |
|          |   |   |   |   | R/W-1  | R/W-1  | R/W-1  |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 14. Backlight Brightness LSB Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                 |
|-----|----------|------|-------|-----------------------------|
| 7-3 | NOT USED |      |       |                             |
| 2-0 | BRT      | R/W  | 111   | 11-bit brightness code LSBs |

## 7.6.5 Backlight Brightness MSB Register (Address = 0x05)[Reset = 0xFF]

**图 52. Backlight Brightness MSB Register**

| 7       | 6      | 5      | 4      | 3      | 2      | 1      | 0      |
|---------|--------|--------|--------|--------|--------|--------|--------|
| BRT[10] | BRT[9] | BRT[8] | BRT[7] | BRT[6] | BRT[5] | BRT[4] | BRT[3] |
| R/W-1   | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 15. Backlight Brightness MSB Register Field Descriptions**

| Bit | Field | Type | Reset    | Description                 |
|-----|-------|------|----------|-----------------------------|
| 7-0 | BRT   | R/W  | 11111111 | 11-bit brightness code MSBs |

## 7.6.6 Backlight Auto-Frequency Low Threshold Register (Address = 0x06)[Reset = 0x00]

**图 53. Backlight Auto-Frequency Low Threshold Register**

| 7       | 6       | 5       | 4       | 3       | 2       | 1       | 0       |
|---------|---------|---------|---------|---------|---------|---------|---------|
| AFLT[7] | AFLT[6] | AFLT[5] | AFLT[4] | AFLT[3] | AFLT[2] | AFLT[1] | AFLT[0] |
| R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 16. Backlight Auto-Frequency Low Threshold Field Descriptions**

| Bit | Field | Type | Reset    | Description                                                 |
|-----|-------|------|----------|-------------------------------------------------------------|
| 7-0 | AFLT  | R/W  | 00000000 | Compared against 8 MSB's of Brightness Code (register 0x05) |

## 7.6.7 Backlight Auto-Frequency High Threshold Register (Address = 0x07)[Reset = 0x00]

**图 54. Backlight Auto-Frequency High Threshold Register**

| 7       | 6       | 5       | 4       | 3       | 2       | 1       | 0       |
|---------|---------|---------|---------|---------|---------|---------|---------|
| AFHT[7] | AFHT[6] | AFHT[5] | AFHT[4] | AFHT[3] | AFHT[2] | AFHT[1] | AFHT[0] |
| R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   | R/W-0   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 17. Backlight Auto-Frequency High Threshold Field Descriptions**

| Bit | Field | Type | Reset    | Description                                                 |
|-----|-------|------|----------|-------------------------------------------------------------|
| 7-0 | AFHT  | R/W  | 00000000 | Compared against 8 MSB's of Brightness Code (register 0x05) |

## 7.6.8 Backlight Enable Register (Address = 0x08)[Reset = 0x00]

图 55. Backlight Enable Register

| 7              | 6        | 5 | 4     | 3        | 2 | 1       | 0       |
|----------------|----------|---|-------|----------|---|---------|---------|
| SOFTWARE_RESET | NOT USED |   | BL_EN | Reserved |   | LED2_EN | LED1_EN |
| R/W-0          | R/W-0    |   | R/W-0 | R/W-0    |   | R/W-0   | R/W-0   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

表 18. Backlight Enable Register Field Descriptions

| Bit | Field          | Type | Reset | Description                                                               |
|-----|----------------|------|-------|---------------------------------------------------------------------------|
| 7   | SOFTWARE_RESET | R/W  | 0     | 0 = No reset<br>1 = Device reset (automatically returns to 0 after reset) |
| 6-5 | NOT USED       |      |       |                                                                           |
| 4   | BL_EN          | R/W  | 0     | 0 = BL disabled (Default)<br>1 = BL enabled                               |
| 3   | Reserved       | R/W  | 0     | Must be written to 0                                                      |
| 2   | Reserved       | R/W  | 0     | Must be written to 0                                                      |
| 1   | LED2_EN        | R/W  | 0     | 0 = Current sink 2 disabled<br>1 = Current sink 2 enabled                 |
| 0   | LED1_EN        | R/W  | 0     | 0 = Current sink 1 disabled<br>1 = Current sink 1 enabled                 |

## 7.6.9 Bias Configuration 1 Register (Address = 0x09)[Reset = 0x18]

图 56. Bias Configuration 1 Register

| 7         | 6         | 5         | 4          | 3          | 2       | 1       | 0      |
|-----------|-----------|-----------|------------|------------|---------|---------|--------|
| LCM_EN[2] | LCM_EN[1] | LCM_EN[0] | VPOS_DISCH | VNEG_DISCH | VPOS_EN | VNEG_EN | EXT_EN |
| R/W-0     | R/W-0     | R/W-0     | R/W-1      | R/W-1      | R/W-0   | R/W-0   | R/W-0  |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

表 19. Bias Configuration 1 Register Field Descriptions

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                     |
|-----|------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:5 | LCM_EN     | R/W  | 000   | 000 = Bias supply off (I <sup>2</sup> C and external)<br>100 = Normal mode<br>101 = Auto sequence<br>110 = Wake1<br>111 = Wake2                                                                                                                                                                 |
| 4   | VPOS_DISCH | R/W  | 1     | 0 = No pulldown on VPOS<br>1 = Pulldown on VPOS when in shutdown                                                                                                                                                                                                                                |
| 3   | VNEG_DISCH | R/W  | 1     | 0 = No pulldown on VNEG<br>1 = Pulldown on VNEG when in shutdown                                                                                                                                                                                                                                |
| 2   | VPOS_EN    | R/W  | 0     | 0 = VPOS disabled<br>1 = VPOS enabled                                                                                                                                                                                                                                                           |
| 1   | VNEG_EN    | R/W  | 0     | 0 = VNEG disabled<br>1 = VNEG enabled                                                                                                                                                                                                                                                           |
| 0   | EXT_EN     | R/W  | 0     | Activates external enables (LCM_EN1 and LCM_EN2)<br>0 = External enables are disabled. VPOS and VNEG can only be enabled via bit VPOS_EN and VNEG_EN, respectively. (Default)<br>1 = External enables are enabled. VPOS and VNEG can only be enabled via pin LCM_EN1 and LCM_EN2, respectively. |

### 7.6.10 Bias Configuration 2 register (Address = 0x0A)[Reset = 0x11]

**图 57. Bias Configuration 2 Register**

| 7                  | 6                  | 5            | 4            | 3            | 2            | 1            | 0            |
|--------------------|--------------------|--------------|--------------|--------------|--------------|--------------|--------------|
| BIAS_SHORT_MODE[1] | BIAS_SHORT_MODE[0] | VPOS_RAMP[1] | VPOS_RAMP[0] | VNEG_RAMP[3] | VNEG_RAMP[2] | VNEG_RAMP[1] | VNEG_RAMP[0] |
| R/W-0              | R/W-0              | R/W-0        | R/W-1        | R/W-0        | R/W-0        | R/W-0        | R/W-1        |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 20. Bias Configuration 2 Register Field Descriptions**

| Bit | Field           | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                 |
|-----|-----------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | BIAS_SHORT_MODE | R/W  | 00    | 0X = Flag only<br>10 = Flag + shutdown VPOS/VNEG<br>11 = Flag + shutdown VPOS/VNEG/Backlight                                                                                                                                                                                                                                                                                                                |
| 5:4 | VPOS_RAMP       | R/W  | 01    | VPOS ramp time, low to high:<br>00 = 256 $\mu$ s<br>01 = 512 $\mu$ s<br>10 = 768 $\mu$ s<br>11 = 1024 $\mu$ s                                                                                                                                                                                                                                                                                               |
| 3:0 | VNEG_RAMP       | R/W  | 0001  | VNEG ramp time, high to low:<br>0000 = 512 $\mu$ s<br>0001 = 1024 $\mu$ s<br>0010 = 1536 $\mu$ s<br>0011 = 2048 $\mu$ s<br>0100 = 2560 $\mu$ s<br>0101 = 3072 $\mu$ s<br>0110 = 3584 $\mu$ s<br>0111 = 4096 $\mu$ s<br>1000 = 4608 $\mu$ s<br>1001 = 5120 $\mu$ s<br>1010 = 5632 $\mu$ s<br>1011 = 6144 $\mu$ s<br>1100 = 6656 $\mu$ s<br>1101 = 7168 $\mu$ s<br>1110 = 7680 $\mu$ s<br>1111 = 8192 $\mu$ s |

### 7.6.11 Bias Configuration 3 Register (Address = 0x0B)[Reset = 0x00]

**图 58. Bias Configuration 3 Register**

| 7        | 6 | 5 | 4 | 3               | 2               | 1               | 0               |
|----------|---|---|---|-----------------|-----------------|-----------------|-----------------|
| NOT USED |   |   |   | VPOS_SC_FILT[1] | VPOS_SC_FILT[0] | VNEG_SC_FILT[1] | VNEG_SC_FILT[0] |
|          |   |   |   | R/W-0           | R/W-0           | R/W-0           | R/W-0           |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 21. Bias Configuration 3 Register Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                       |
|-----|--------------|------|-------|---------------------------------------------------------------------------------------------------|
| 7:4 | NOT USED     |      |       |                                                                                                   |
| 5:4 | VPOS_SC_FILT | R/W  | 00    | VPOS short circuit filter timer<br>00 = 2 ms<br>01 = 1 ms<br>10 = 500 $\mu$ s<br>11 = 100 $\mu$ s |
| 1:0 | VNEG_SC_FILT | R/W  | 00    | VNEG short circuit filter timer<br>00 = 2 ms<br>01 = 1 ms<br>10 = 500 $\mu$ s<br>11 = 100 $\mu$ s |

### 7.6.12 LCM Boost Bias Register (Address = 0x0C)[Reset = 0x28]

**图 59. LCM Boost Bias Register**

| 7        | 6 | 5          | 4          | 3          | 2          | 1          | 0          |
|----------|---|------------|------------|------------|------------|------------|------------|
| NOT USED |   | LCM_OUT[5] | LCM_OUT[4] | LCM_OUT[3] | LCM_OUT[2] | LCM_OUT[1] | LCM_OUT[0] |
|          |   | R/W-1      | R/W-0      | R/W-1      | R/W-0      | R/W-0      | R/W-0      |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 22. LCM Boost Bias Register Field Descriptions**

| Bit | Field    | Type | Reset  | Description                                                                                                                                                                         |
|-----|----------|------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | NOT USED |      |        |                                                                                                                                                                                     |
| 5-0 | LCM_OUT  | R/W  | 101000 | LCM_OUT voltage (50-mV steps): $LCM\_OUT = 4\text{ V} + (\text{Code} \times 50\text{ mV})$<br>000000 = 4 V<br>000001 = 4.55V<br>:<br>101000 = 6 V (Default)<br>:<br>111111 = 7.15 V |

### 7.6.13 VPOS Bias Register (Address = 0x0D)[Reset = 0x1E]

**图 60. VPOS Bias Register**

| 7        | 6 | 5       | 4       | 3       | 2       | 1       | 0       |
|----------|---|---------|---------|---------|---------|---------|---------|
| NOT USED |   | VPOS[5] | VPOS[4] | VPOS[3] | VPOS[2] | VPOS[1] | VPOS[0] |
|          |   | R/W-0   | R/W-0   | R/W-1   | R/W-1   | R/W-1   | R/W-0   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 23. VPOS Bias Register Field Descriptions**

| Bit | Field    | Type | Reset  | Description                                                                                                                                                                                                                 |
|-----|----------|------|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | NOT USED |      |        |                                                                                                                                                                                                                             |
| 5-0 | VPOS     | R/W  | 011110 | VPOS voltage (50-mV steps): $VPOS = 4\text{ V} + (\text{Code} \times 50\text{ mV})$ , 6.5 V max<br>000000 = 4 V<br>000001 = 4.05 V<br>:<br>011110 = 5.5 V (Default)<br>:<br>110010 = 6.5 V<br>110011 to 111111 map to 6.5 V |

### 7.6.14 VNEG Bias Register (Address = 0x0E)[Reset = 0x1C]

**图 61. VNEG Bias Register**

| 7        | 6 | 5       | 4       | 3       | 2       | 1       | 0       |
|----------|---|---------|---------|---------|---------|---------|---------|
| NOT USED |   | VNEG[5] | VNEG[4] | VNEG[3] | VNEG[2] | VNEG[1] | VNEG[0] |
|          |   | R/W-0   | R/W-1   | R/W-1   | R/W-1   | R/W-0   | R/W-0   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 24. VNEG Bias Register Field Descriptions**

| Bit | Field    | Type | Reset  | Description                                                                                                                                                                                                                            |
|-----|----------|------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | NOT USED |      |        |                                                                                                                                                                                                                                        |
| 5-0 | VNEG     | R/W  | 011100 | VNEG voltage (–50-mV steps): $VNEG = -4\text{ V} - (\text{Code} \times 50\text{ mV})$ ,<br>–6.5 V min<br>000000 = –4 V<br>000000 = –4.05 V<br>:<br>011100 = –5.4 V (Default)<br>:<br>110010 = –6.5 V<br>110011 to 111111 map to –6.5 V |

### 7.6.15 Flags Register (Address = 0x0F)[Reset = 0x00]

**图 62. Flags Register**

| 7        | 6   | 5       | 4        | 3          | 2          | 1      | 0      |
|----------|-----|---------|----------|------------|------------|--------|--------|
| NOT USED | TSD | LCM_OVP | NOT USED | VPOS_SHORT | VNEG_SHORT | BL_OVP | BL_OCP |
|          | R-0 | R-0     |          | R-0        | R-0        | R-0    | R-0    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 25. Flags Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                      |
|-----|------------|------|-------|----------------------------------------------------------------------------------|
| 7   | NOT USED   |      |       |                                                                                  |
| 6   | TSD        | R    | 0     | 0 = Normal operation<br>1 = Thermal shutdown triggered (die temperature > 140°C) |
| 5   | LCM_OVP    | R    | 0     | 0 = Normal operation<br>1 = $V_{LCM\_OUT} > 7.8\text{ V}$                        |
| 4   | NOT USED   |      |       |                                                                                  |
| 3   | VPOS_SHORT | R    | 0     | 0 = Normal operation<br>1 = VPOS output has hit the overcurrent threshold        |
| 2   | VNEG_SHORT | R    | 0     | 0 = Normal operation<br>1 = $V_{VNEG} > 0.84 \times V_{VNEG\_target}$            |
| 1   | BL_OVP     | R    | 0     | 0 = Normal operation<br>1 = Backlight boost output > OVP threshold               |
| 0   | BL_OCP     | R    | 0     | 0 = Normal operation<br>1 = Backlight boost switch current > OCP threshold       |

### 7.6.16 Option 1 Register (Address = 0x10)[Reset = 0x06]

**图 63. Option 1 Register**

| 7        | 6        | 5    | 4       | 3       | 2           | 1           | 0                |
|----------|----------|------|---------|---------|-------------|-------------|------------------|
| NOT USED | Reserved |      | LED2_FB | LED1_FB | PWM_FILT[1] | PWM_FILT[0] | PWM_24MHZ_SAMPLE |
| RW-0     | RW-0     | RW-0 | RW-0    | RW-0    | RW-1        | RW-1        | RW-0             |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 26. Option 1 Register Field Descriptions**

| Bit | Field                 | Type | Reset | Description                                                                      |
|-----|-----------------------|------|-------|----------------------------------------------------------------------------------|
| 7   | NOT USED              |      |       |                                                                                  |
| 6   | Reserved              | R/W  | 0     | Must be written to 0                                                             |
| 5   | Reserved              | R/W  | 0     | Must be written to 0                                                             |
| 4   | LED2_FEEDBACK_DISABLE | R/W  | 0     | 0 = Feedback enabled<br>1 = Feedback disabled                                    |
| 3   | LED1_FEEDBACK_DISABLE | R/W  | 0     | 0 = Feedback enabled<br>1 = Feedback disabled                                    |
| 2:1 | PWM_FILT              | R/W  | 11    | PWM Glitch Filter<br>00 = No filter<br>01 = 100 ns<br>10 = 150 ns<br>11 = 200 ns |
| 0   | PWM_24MHz_SAMPLE      | R/W  | 0     | 0 = Low-frequency options (see 0x03 bit[2])<br>1 = 24-MHz PWM sample frequency   |

### 7.6.17 Option 2 Register (Address = 0x11)[Reset = 0x35]

**图 64. Option 2 Register**

| 7              | 6              | 5           | 4           | 3           | 2           | 1                   | 0                   |
|----------------|----------------|-------------|-------------|-------------|-------------|---------------------|---------------------|
| BL_L_SELECT[1] | BL_L_SELECT[0] | BL_SEL_P[1] | BL_SEL_P[0] | BL_SEL_I[1] | BL_SEL_I[0] | BL_CURRENT_LIMIT[1] | BL_CURRENT_LIMIT[0] |
| RW-0           | RW-0           | RW-1        | RW-1        | RW-0        | RW-1        | RW-0                | RW-1                |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 27. Option 2 Register Field Descriptions**

| Bit | Field                         | Type | Reset | Description                                                                                                                                           |
|-----|-------------------------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | BACKLIGHT_BOOST_L_SELECT      | RW   | 00    | 00 = 4.7 $\mu$ H<br>01 = 10 $\mu$ H<br>10 = 15 $\mu$ H<br>11 = 15 $\mu$ H                                                                             |
| 5-4 | BACKLIGHT_SEL_P               | RW   | 11    | These bits must be written to 11 (default values) to ensure backlight boost stability with recommended external components for all LED configurations |
| 3-2 | BACKLIGHT_SEL_I               | RW   | 01    | These bits must be written to 01 (default values) to ensure backlight boost stability with recommended external components for all LED configurations |
| 1-0 | BACKLIGHT_BOOST_CURRENT_LIMIT | RW   | 01    | 00 = 0.9 A<br>01 = 1.2 A<br>10 = 1.5 A<br>11 = 1.8 A                                                                                                  |

**7.6.18 PWM-to-Digital Code Readback LSB Register (Address = 0x12)[Reset = 0x00]**
**图 65. PWM-to-Digital Code Readback LSB Register**

| 7             | 6             | 5             | 4             | 3             | 2             | 1             | 0             |
|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|
| PWM_TO_DIG[7] | PWM_TO_DIG[6] | PWM_TO_DIG[5] | PWM_TO_DIG[4] | PWM_TO_DIG[3] | PWM_TO_DIG[2] | PWM_TO_DIG[1] | PWM_TO_DIG[0] |
| R-0           | R-0           | R-0           | R-0           | R-0           | R-0           | R-0           | R-0           |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 28. PWM-to-Digital Code Readback LSB Register Field Descriptions**

| Bit | Field      | Type | Reset    | Description                                |
|-----|------------|------|----------|--------------------------------------------|
| 7-0 | PWM_TO_DIG | R    | 00000000 | 11-bit PWM-to-digital conversion code LSBs |

**7.6.19 PWM-to-Digital Code Readback MSB Register (Address = 0x13)[Reset = 0x00]**
**图 66. PWM-to-Digital Code Readback MSB Register**

| 7        | 6   | 5   | 4   | 3   | 2              | 1             | 0             |
|----------|-----|-----|-----|-----|----------------|---------------|---------------|
| RESERVED |     |     |     |     | PWM_TO_DIG[10] | PWM_TO_DIG[9] | PWM_TO_DIG[8] |
| R-0      | R-0 | R-0 | R-0 | R-0 | R-0            | R-0           | R-0           |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 29. PWM-to-Digital Code Readback MSB Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                |
|-----|------------|------|-------|--------------------------------------------|
| 7-3 | RESERVED   | R    | 00000 | Reserved                                   |
| 2-0 | PWM_TO_DIG | R    | 000   | 11-bit PWM-to-digital conversion code MSBs |

## 8 Application and Implementation

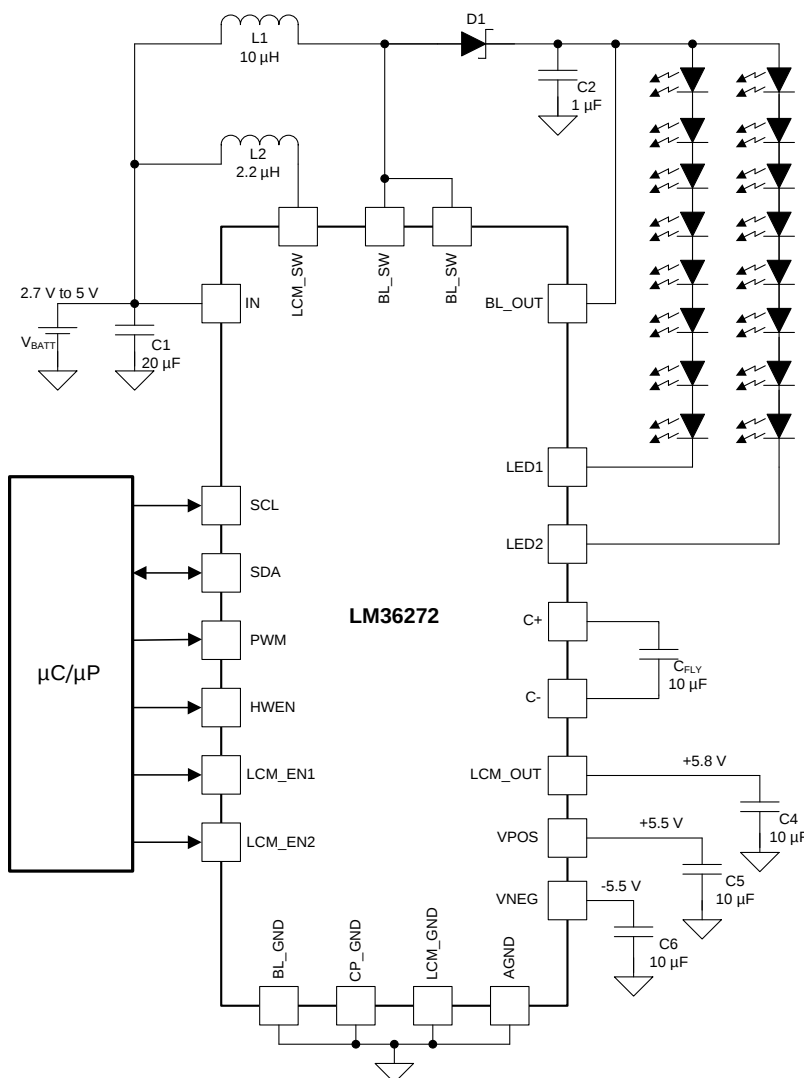
注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 8.1 Application Information

The LM36272 integrates an LCD backlight driver and LCM positive and negative bias voltages into a single device. The backlight boost converter generates the high voltage required for the LEDs. The device can drive one or two LED strings with up to eight white LEDs per string. Positive and negative bias voltages are post-regulated from the LCM bias boost output voltage. The LM36272 offers high performance, is highly configurable, and can support multiple LED configurations as well as independent control of the bias outputs.

## 8.2 Typical Application



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图 67. LM36272 Typical Application

## Typical Application (接下页)

### 8.2.1 Design Requirements

| DESIGN PARAMETER                      | EXAMPLE VALUE                                   |
|---------------------------------------|-------------------------------------------------|
| Input voltage range ( $V_{IN}$ )      | 2.7 V to 4.5 V (single Li-Ion cell battery)     |
| LED parallel/series configuration     | 2 parallel, 6 series                            |
| LED maximum forward voltage ( $V_f$ ) | 3.35 V                                          |
| Backlight LED current                 | maximum 30 mA / string                          |
| Backlight boost maximum voltage       | 29 V                                            |
| Backlight boost SW frequency          | 1 MHz, 500 kHz, 250 kHz (auto-frequency option) |
| Backlight boost inductor              | 10- $\mu$ H, 1.5-A saturation current           |
| Backlight boost Schottky diode        | NSR0530P2T5G                                    |
| LCM boost output voltage              | 5.8 V                                           |
| VPOS output voltage                   | 5.5 V                                           |
| VNEG output voltage                   | -5.5 V                                          |
| LCM boost inductor                    | 2.2- $\mu$ H, 1.5-A saturation current          |

The number of LED strings, number of series LEDs, and minimum input voltage are needed in order to calculate the peak input current. This information guides the designer to make the appropriate backlight boost inductor selection for the application. The LM36272 backlight boost converter output voltage ( $V_{OUT}$ ) is calculated as follows: number of series LEDs  $\times V_f + 0.31$  V. The LM36272 boost converter output current ( $I_{OUT}$ ) is calculated as follows: number of parallel LED strings  $\times 30$  mA. The LM36272 peak input current is calculated using 公式 5.

### 8.2.2 Detailed Design Procedure

#### 8.2.2.1 Component Selection

表 30 shows examples of external components for the LM36272. Boost converter output capacitors can be replaced with dual output capacitors of lower capacitance as long as the minimum effective capacitance requirement is met. DC bias effect of the ceramic capacitors must be taken into consideration when choosing the output capacitors. This is especially true for the high output-voltage backlight-boost converter.

**表 30. Recommended External Components**

| DESIGNATOR                | DESCRIPTION       | VALUE               | EXAMPLE             |
|---------------------------|-------------------|---------------------|---------------------|
| C1, C4, C5, C6, $C_{FLY}$ | Ceramic capacitor | 10 $\mu$ F, 10 V    | C1608X5R0J106M      |
| C2                        | Ceramic capacitor | 1 $\mu$ F, 35 V     | C2012X7R1H105K125AB |
| L1                        | Inductor          | 4.7 $\mu$ H, 1.94 A | VLF504012MT-4R7M    |
| L1                        | Inductor          | 10 $\mu$ H, 1.44 A  | VLF504015MT-100M    |
| L1                        | Inductor          | 15 $\mu$ H, 1.25 A  | VLF504015MT-150M    |
| L2                        | Inductor          | 2.2 $\mu$ H, 1.5 A  | DFE201612P-2R2M     |
| D1                        | Schottky diode    | 30 V, 500 mA        | NSR0530P2T5G        |

#### 8.2.2.1.1 Inductor Selection

The LM36272 backlight boost requires a typical inductance in the range of 4.7  $\mu$ H to 15  $\mu$ H. To ensure boost stability the Backlight Boost L Select bit (register 0x11 bits [7:6]) must be selected depending on the value of inductance chosen. Use the 4.7- $\mu$ H setting with a 6.8- $\mu$ H inductor.

The LCM boost is internally compensated for a typical inductance in the range of 1  $\mu$ H to 2.2  $\mu$ H. If the LCM boost output setting is greater than 6.3 V a 2.2- $\mu$ H inductor must be used.

There are two main considerations when choosing an inductor: the inductor RMS current rating must be greater than the RMS inductor current for the application, and the inductor saturation current must be greater than the peak inductor current for the application. Different saturation current rating specifications are followed by different manufacturers so attention must be given to details. Saturation current ratings are typically specified at 25°C. However, ratings at the maximum ambient temperature of the application should be requested from the

manufacturer. The saturation current must be greater than the sum of the maximum load current and the worst-case average-to-peak inductor current. When the boost device is boosting ( $V_{OUT} > V_{IN}$ ) the inductor is one of the largest area of efficiency loss in the circuit. Therefore, choosing an inductor with the lowest possible series resistance is important, especially for an LCM bias converter. For proper inductor operation and circuit performance, ensure that the inductor saturation and the peak current limit setting of the LM36272 are greater than  $I_{PEAK}$  in 公式 5:

$$I_{PEAK} = \frac{I_{LOAD}}{\eta} \times \frac{V_{OUT}}{V_{IN}} + \Delta I_{LOAD} \text{ where } \Delta I_{LOAD} = \frac{V_{IN} \times (V_{OUT} - V_{IN} \times \eta)}{2 \times f_{SW} \times L \times V_{OUT}} \quad (5)$$

See detailed information in *Understanding Boost Power Stages in Switch Mode Power Supplies* <http://focus.ti.com/lit/an/slva061/slva061.pdf>. *Power Stage Designer™ Tools* can be used for the boost calculation: <http://www.ti.com/tool/powerstage-designer>.

Also, the peak current calculated in 公式 5 is different from the peak inductor current setting ( $I_{SAT}$ ). The NMOS switch current limit setting ( $I_{CL\_MIN}$ ) must be greater than  $I_{PEAK}$  from 公式 5.

### 8.2.2.1.2 Boost Output Capacitor Selection

At least an 1-μF capacitor is recommended for the backlight boost converter output capacitor. A high-quality ceramic type X5R or X7R is recommended. Voltage rating must be greater than the maximum output voltage that is used. The effective output capacitance must always remain higher than 0.4 μF for stable operation.

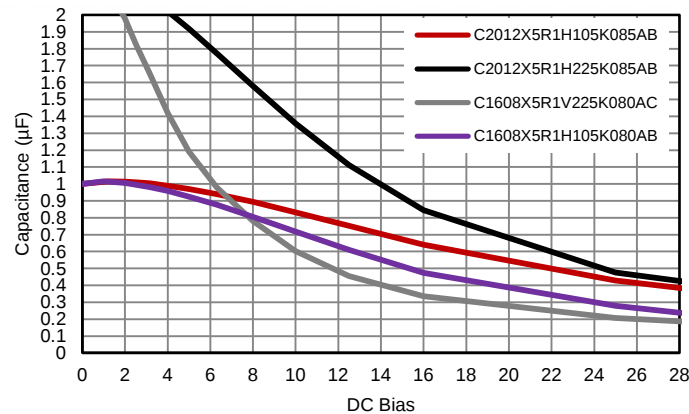
表 31 lists possible backlight output capacitors that can be used with the LM36272. 图 68 shows the DC bias of the four TDK capacitors. The useful voltage range is determined from the effective output voltage range for a given capacitor as determined by 公式 6:

$$\text{DC Voltage Derating} \geq \frac{0.4 \mu\text{F}}{(1 - \text{Tol}) \times (1 - \text{Temp\_co})} \quad (6)$$

**表 31. Recommended Backlight Output Capacitors**

| PART NUMBER         | MANUFACTURER | CASE SIZE | VOLTAGE RATING (V) | NOMINAL CAPACITANCE (μF) | TOLERANCE (%) | TEMPERATURE COEFFICIENT (%) | RECOMMENDED MAX OUTPUT VOLTAGE (FOR SINGLE CAPACITOR) |
|---------------------|--------------|-----------|--------------------|--------------------------|---------------|-----------------------------|-------------------------------------------------------|
| C2012X5R1H105K085AB | TDK          | 0805      | 50                 | 1                        | ±10           | ±15                         | 22                                                    |
| C2012X5R1H225K085AB | TDK          | 0805      | 50                 | 2.2                      | ±10           | ±15                         | 24                                                    |
| C1608X5R1V225K080AC | TDK          | 0603      | 35                 | 2.2                      | ±10           | ±15                         | 12                                                    |
| C1608X5R1H105K080AB | TDK          | 0603      | 50                 | 1                        | ±10           | ±15                         | 15                                                    |

For example, with a 10% tolerance, and a 15% temperature coefficient, the DC voltage derating must be  $\geq 0.4 / (0.9 \times 0.85) = 0.523 \mu\text{F}$ . For the C1608X5R1H225K080AB (0603, 50-V) device, the useful voltage range occurs up to the point where the DC bias derating falls below 0.523 μF, or around 12 V. For configurations where  $V_{OUT}$  is  $> 15 \text{ V}$ , two of these capacitors can be paralleled, or a larger capacitor such as the C2012X5R1H105K085AB must be used.



**图 68. DC Bias Derating for 0805 Case Size and 0603 Case Size 35-V and 50-V Ceramic Capacitors**

For the LCM bias boost output a high-quality 10- $\mu$ F ceramic type X5R or X7R capacitor is recommended. Voltage rating must be greater than the maximum output voltage that is used.

#### 8.2.2.1.3 Input Capacitor Selection

Choosing the correct size and type of input capacitor helps minimize the voltage ripple caused by the switching of the LM36272 boost converters and reduce noise on the input pin that can feed through and disrupt internal analog signals. For the LM36272 a 10- $\mu$ F ceramic input capacitor works well. It is important to place the input capacitor as close to the input (IN) pin as possible. This reduces the series resistance and inductance that can inject noise into the device due to the input switching currents.

## 8.2.3 Application Curves

### 8.2.3.1 Backlight Curves

Ambient temperature is 25°C and  $V_{IN}$  is 3.7 V unless otherwise noted. Backlight system efficiency is defined as PLED / PIN, where PLED is actual power consumed in backlight LEDs. External components are from [表 30](#).

#### 8.2.3.1.1 Two LED Strings

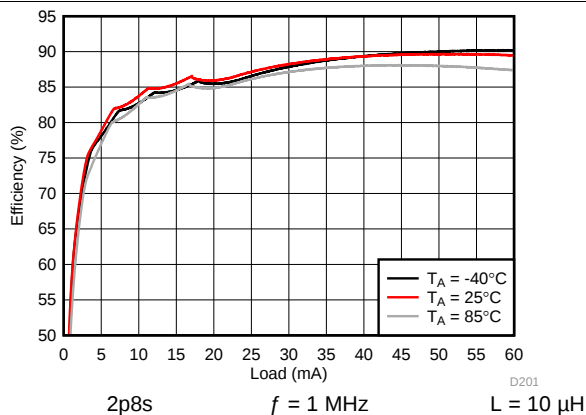


图 69. Backlight Boost Efficiency

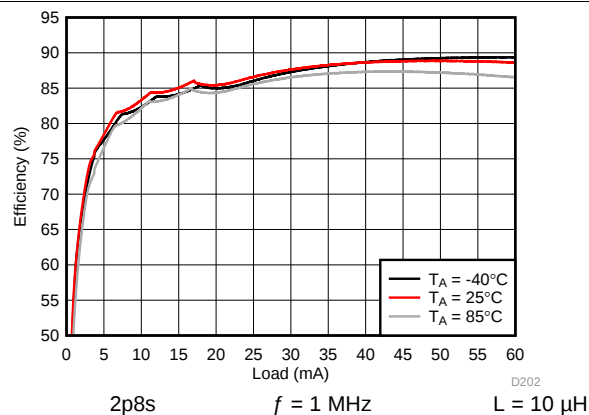


图 70. Backlight System Efficiency

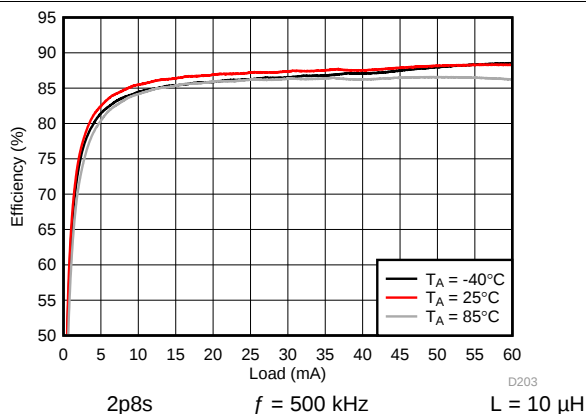


图 71. Backlight Boost Efficiency

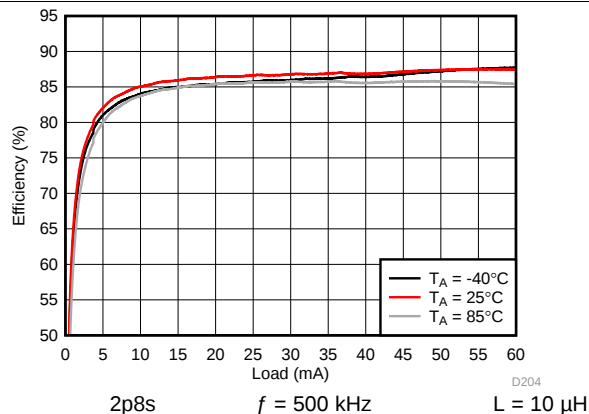


图 72. Backlight System Efficiency

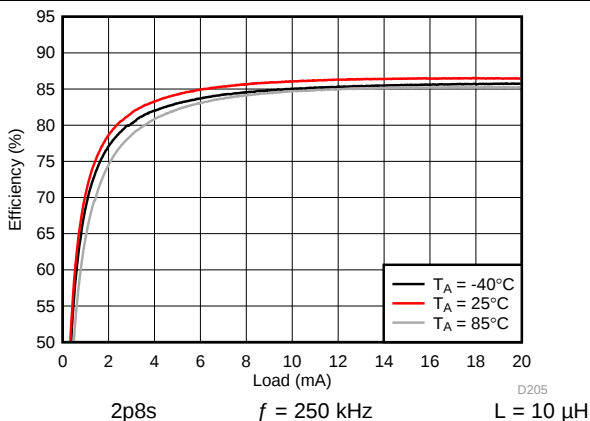


图 73. Backlight Boost Efficiency

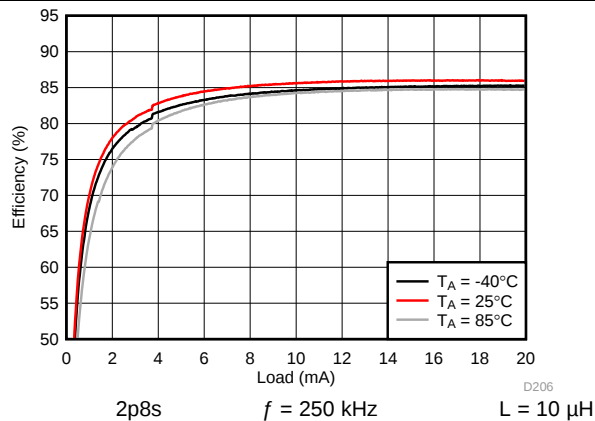


图 74. Backlight System Efficiency

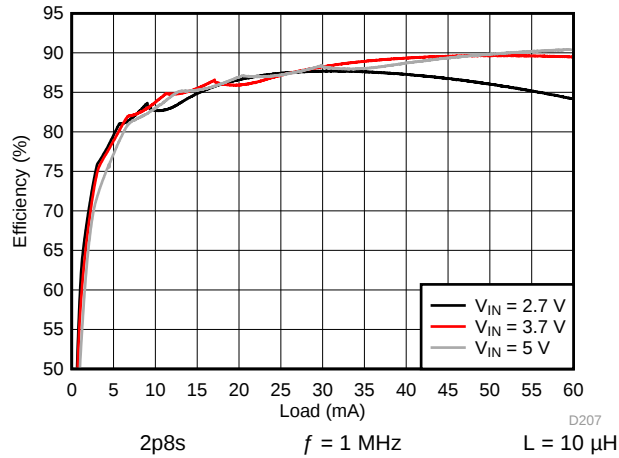


图 75. Backlight Boost Efficiency

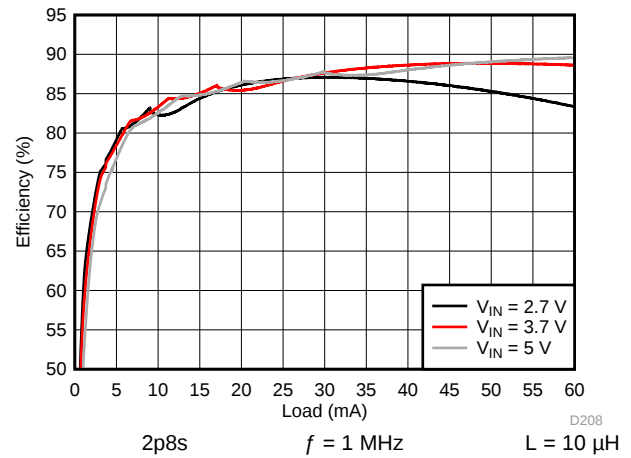


图 76. Backlight System Efficiency

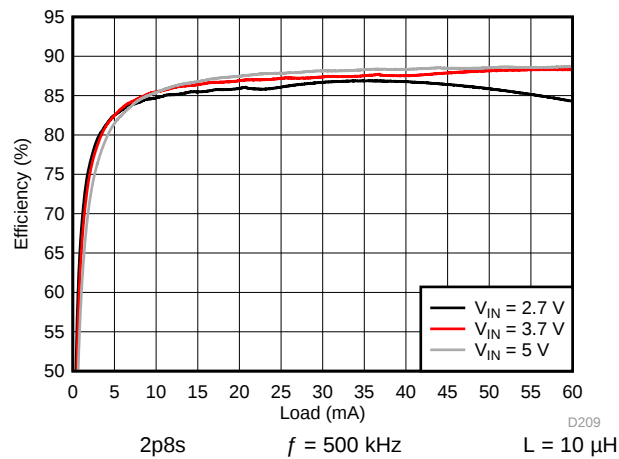


图 77. Backlight Boost Efficiency

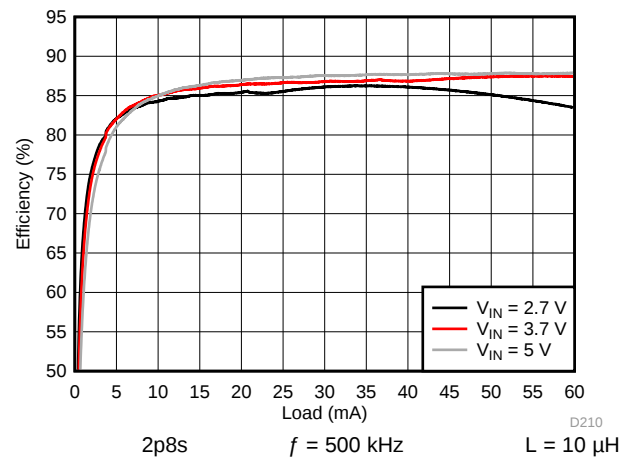


图 78. Backlight System Efficiency

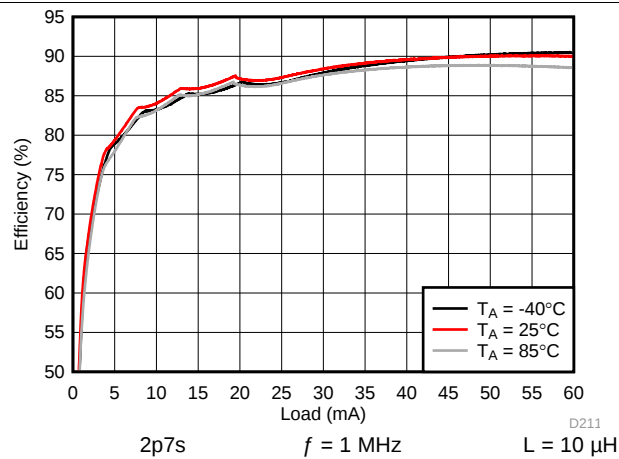


图 79. Backlight Boost Efficiency

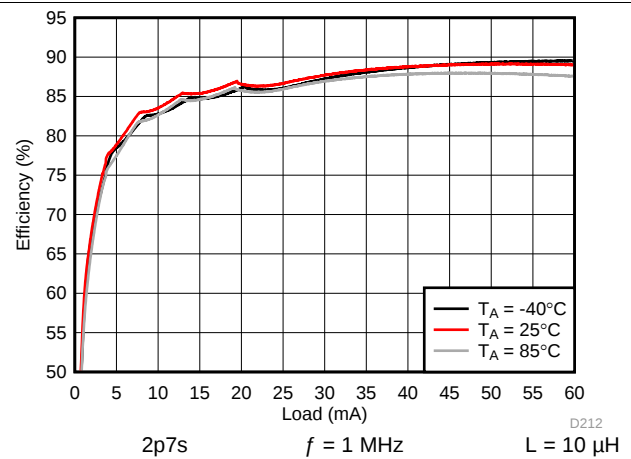


图 80. Backlight System Efficiency

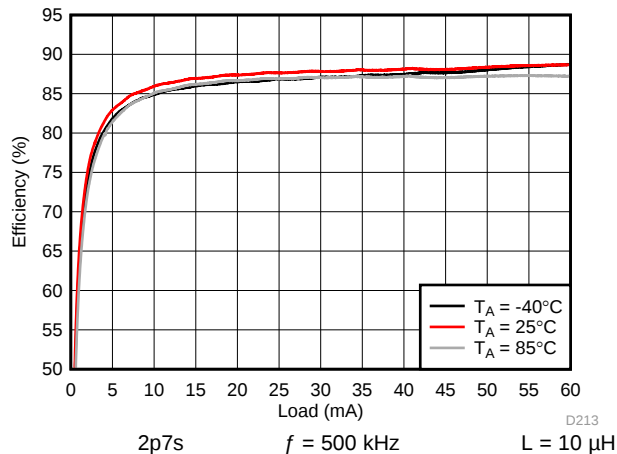


图 81. Backlight Boost Efficiency

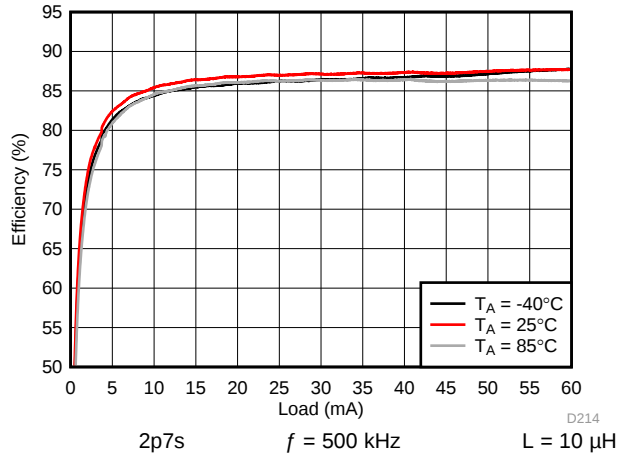


图 82. Backlight System Efficiency

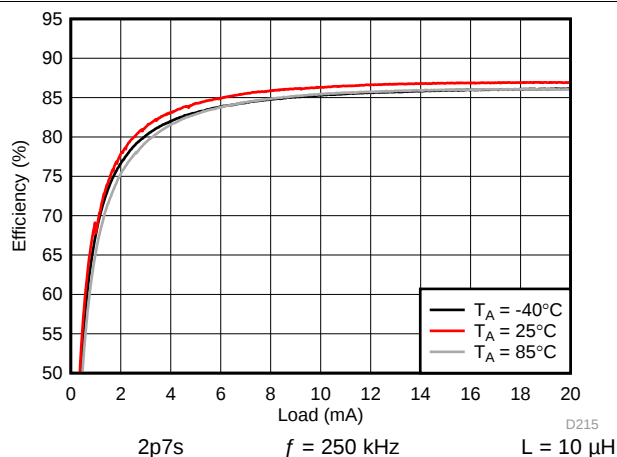


图 83. Backlight Boost Efficiency

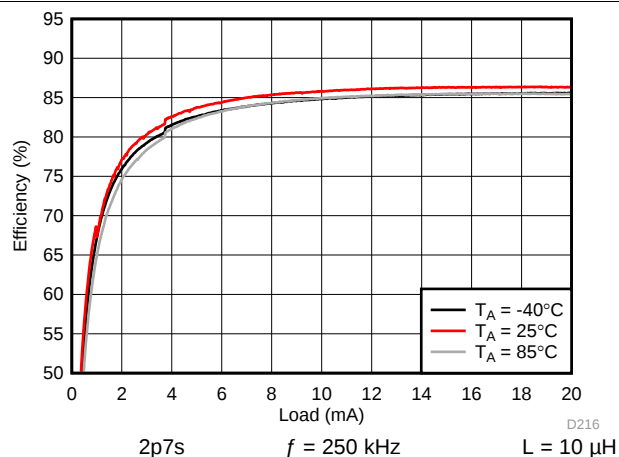


图 84. Backlight System Efficiency

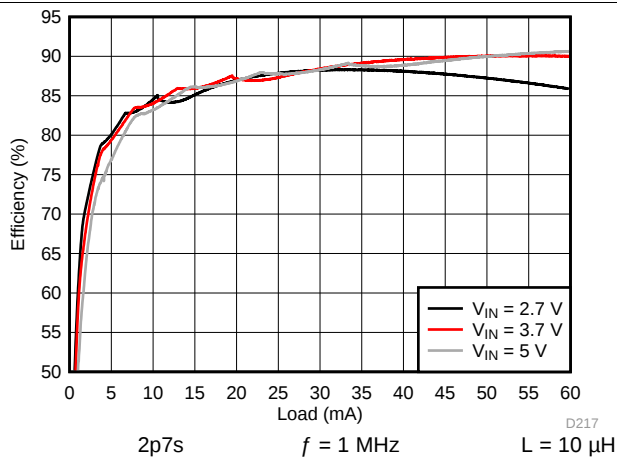


图 85. Backlight Boost Efficiency

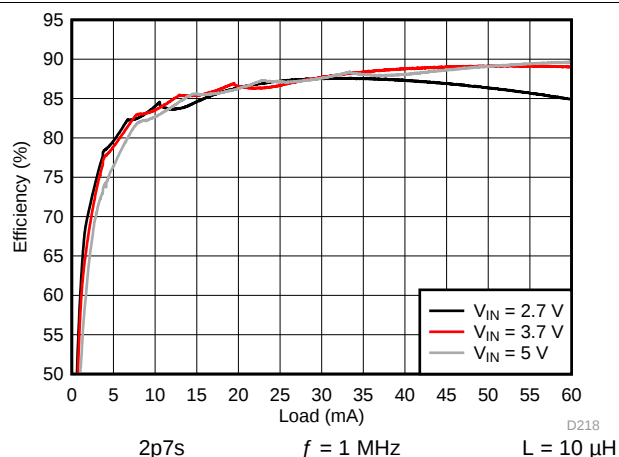


图 86. Backlight System Efficiency

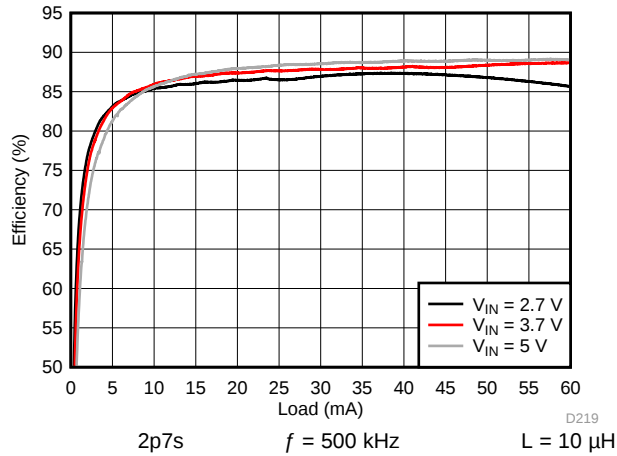


图 87. Backlight Boost Efficiency

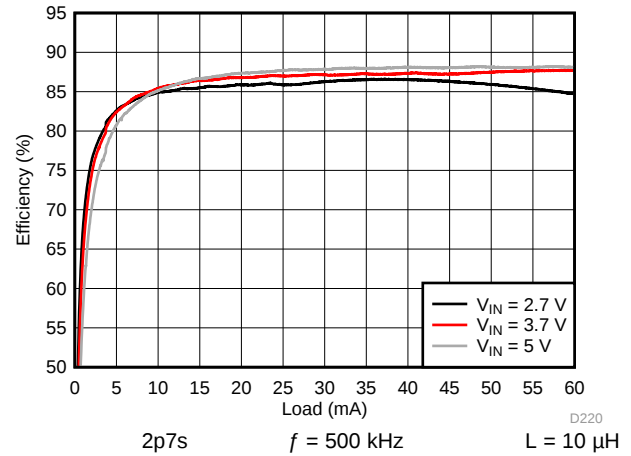


图 88. Backlight System Efficiency

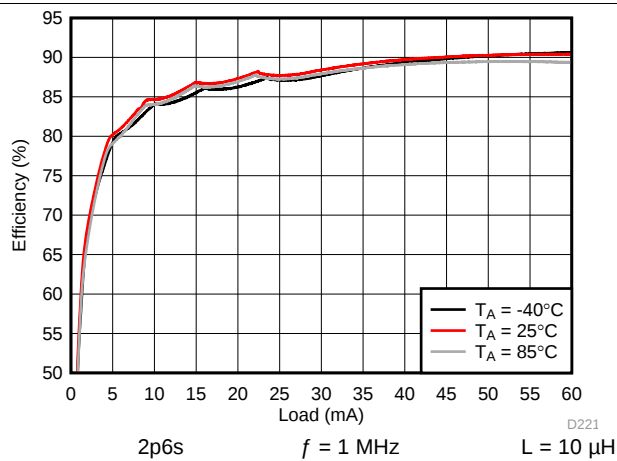


图 89. Backlight Boost Efficiency

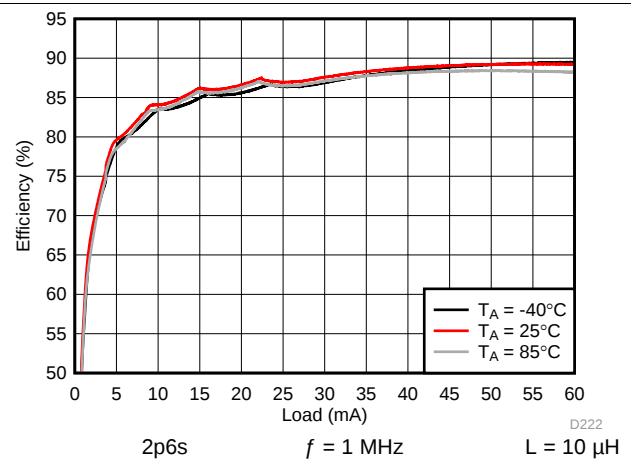


图 90. Backlight System Efficiency

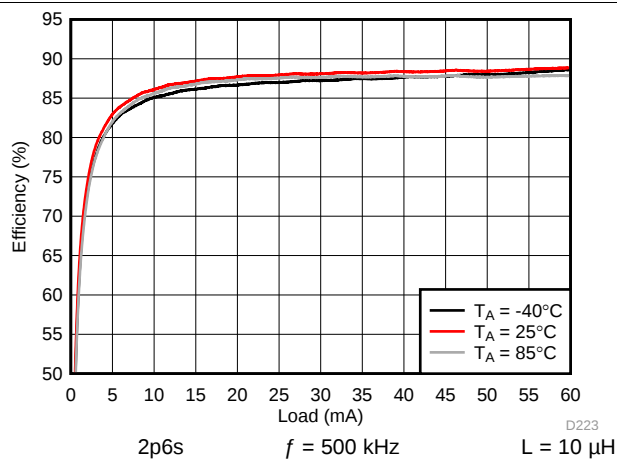


图 91. Backlight Boost Efficiency

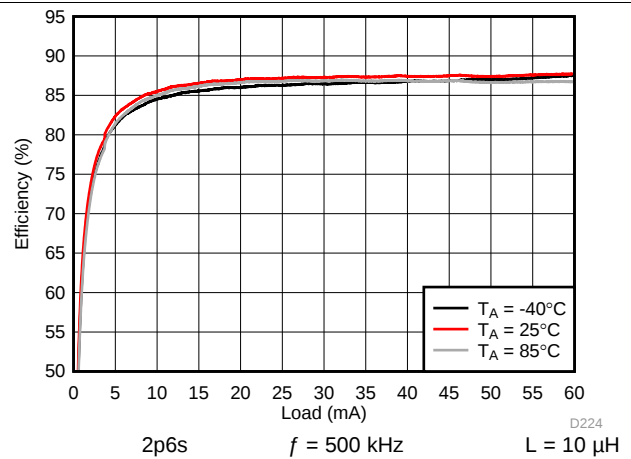


图 92. Backlight System Efficiency

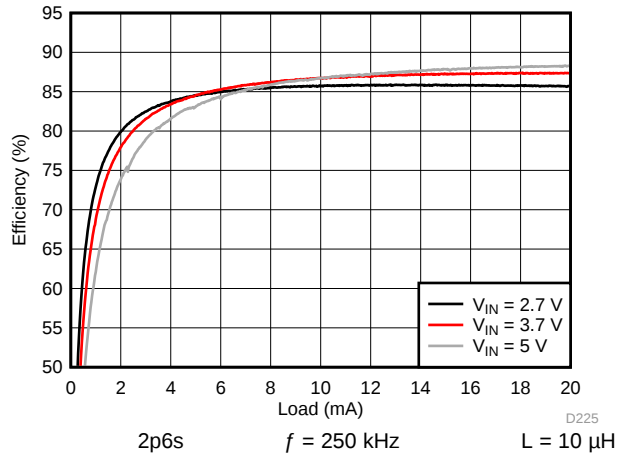


图 93. Backlight Boost Efficiency

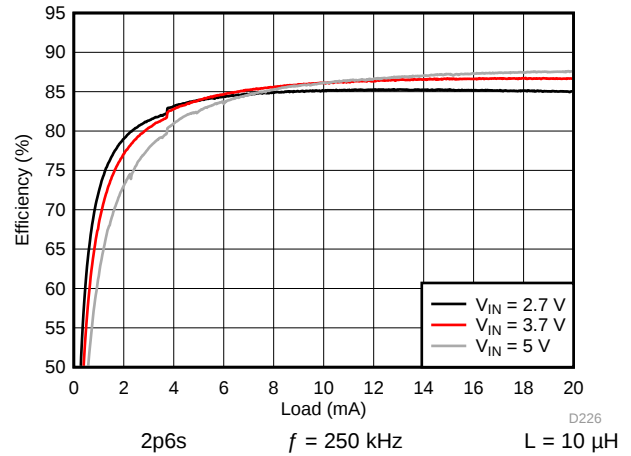


图 94. Backlight System Efficiency

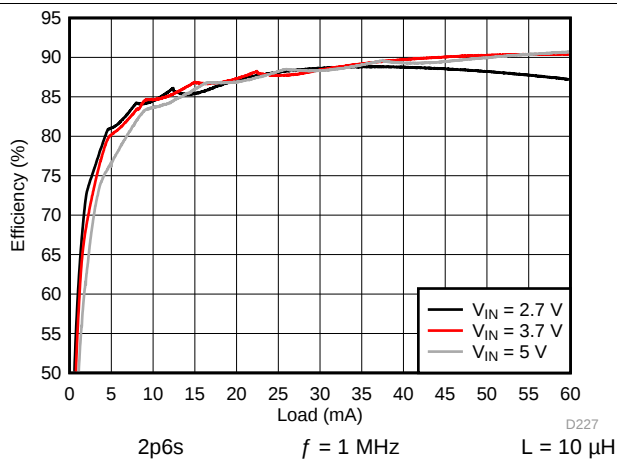


图 95. Backlight Boost Efficiency

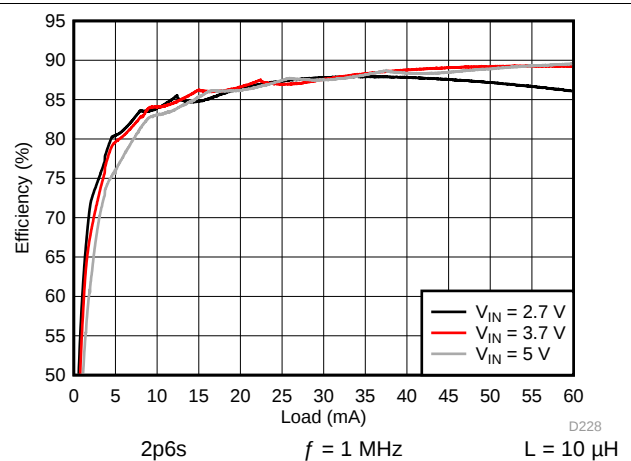


图 96. Backlight System Efficiency

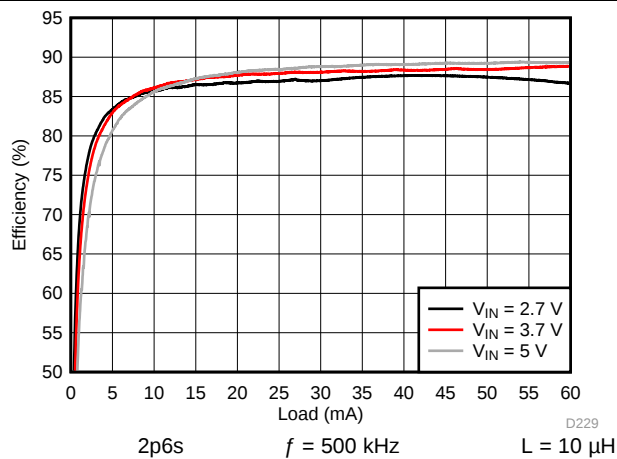


图 97. Backlight Boost Efficiency

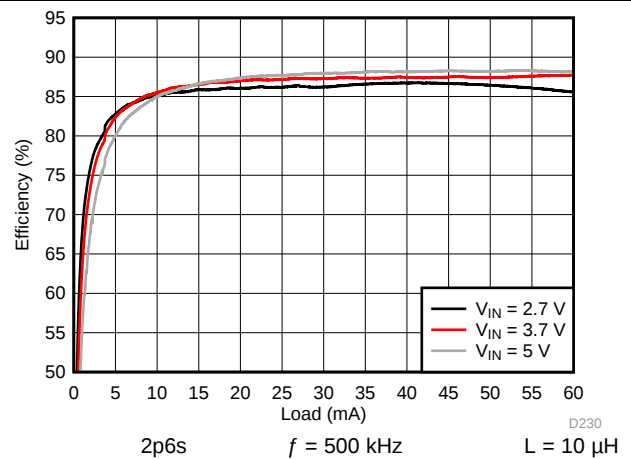


图 98. Backlight System Efficiency

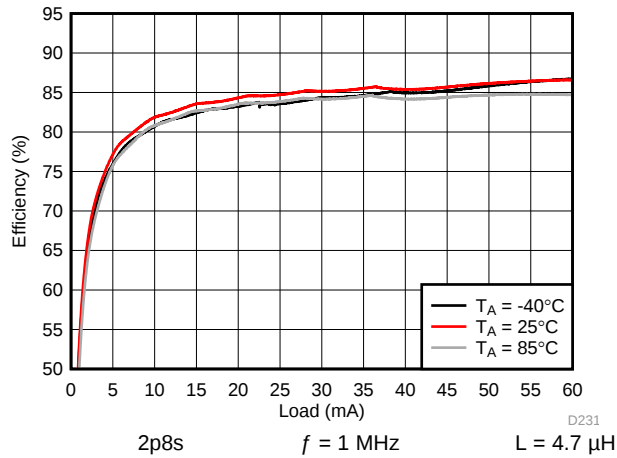


图 99. Backlight Boost Efficiency

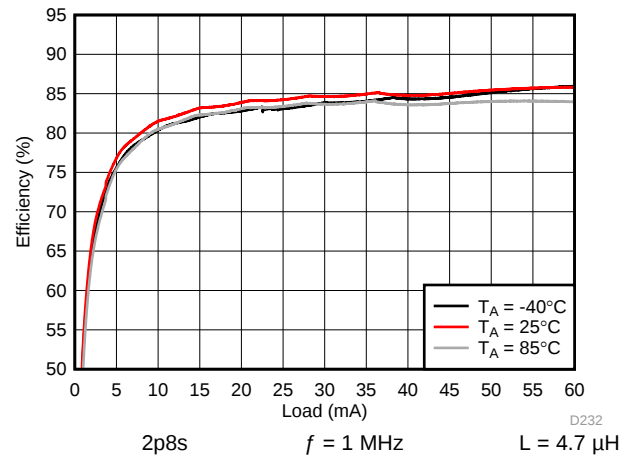


图 100. Backlight System Efficiency

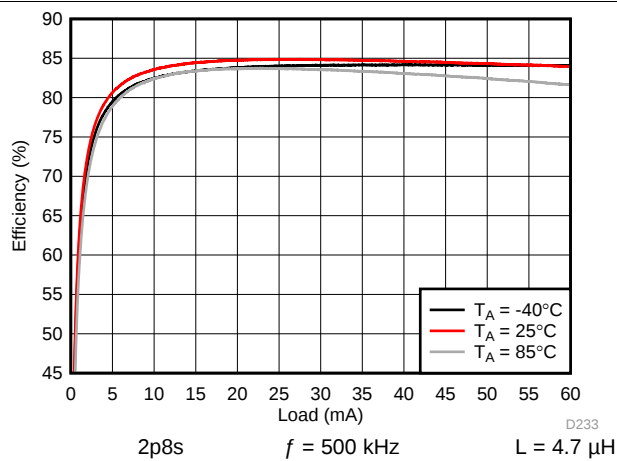


图 101. Backlight Boost Efficiency

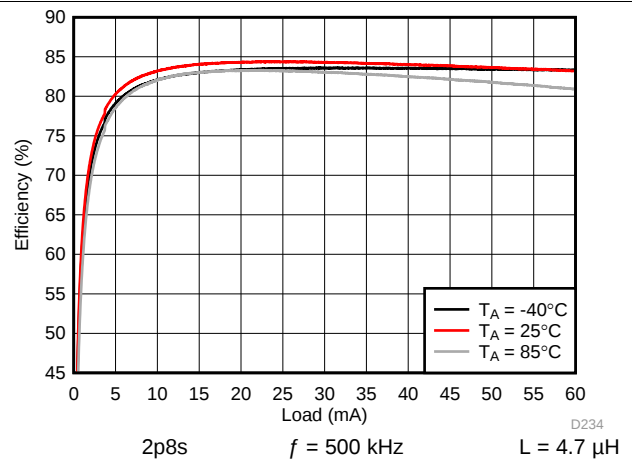


图 102. Backlight System Efficiency

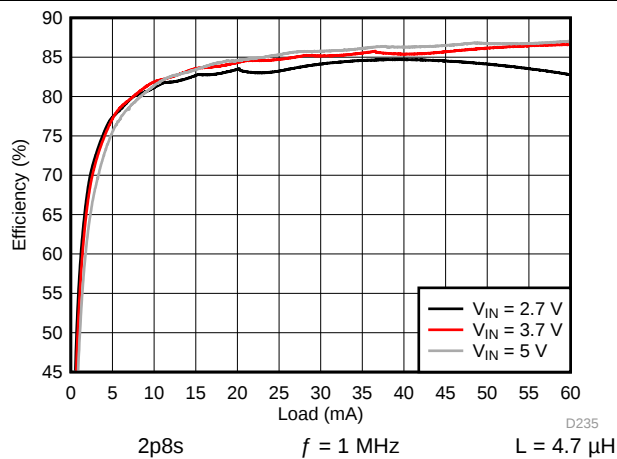


图 103. Backlight Boost Efficiency

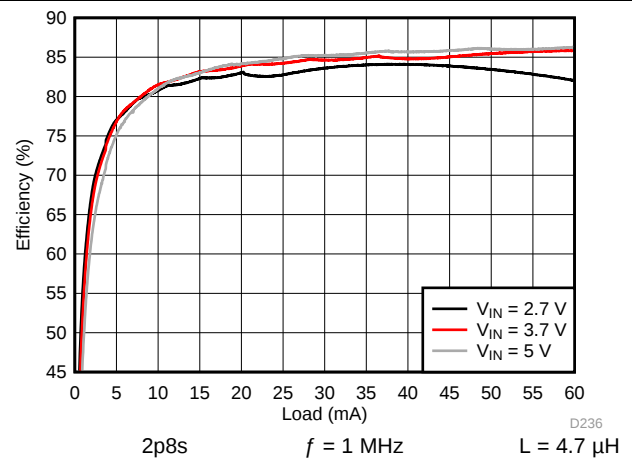


图 104. Backlight System Efficiency

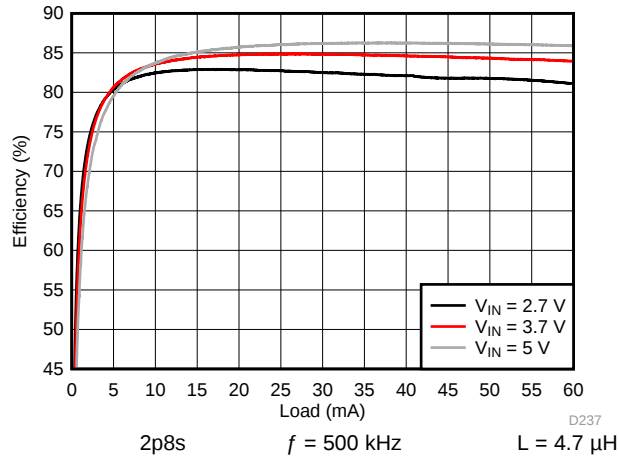


图 105. Backlight Boost Efficiency

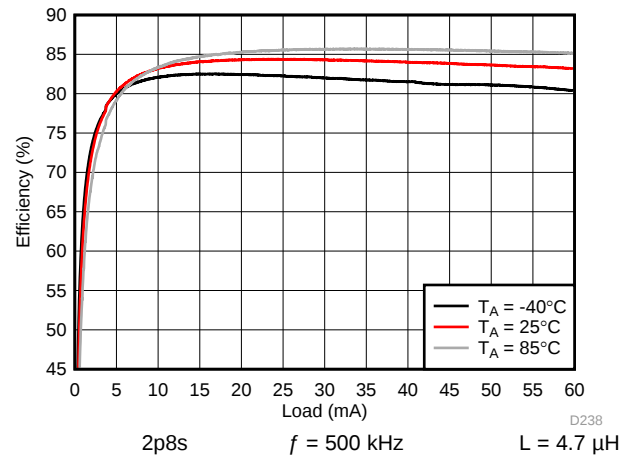


图 106. Backlight System Efficiency

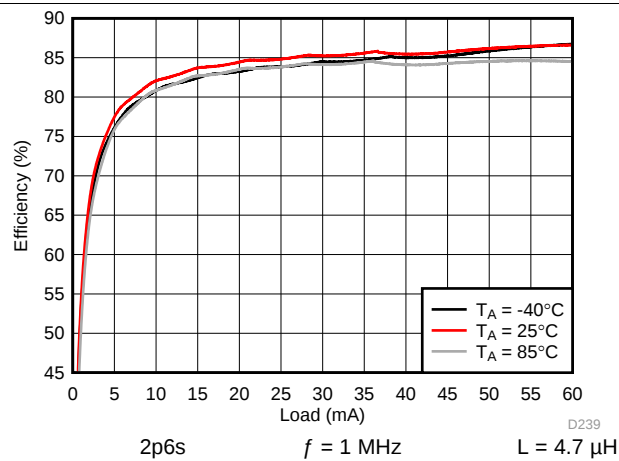


图 107. Backlight Boost Efficiency

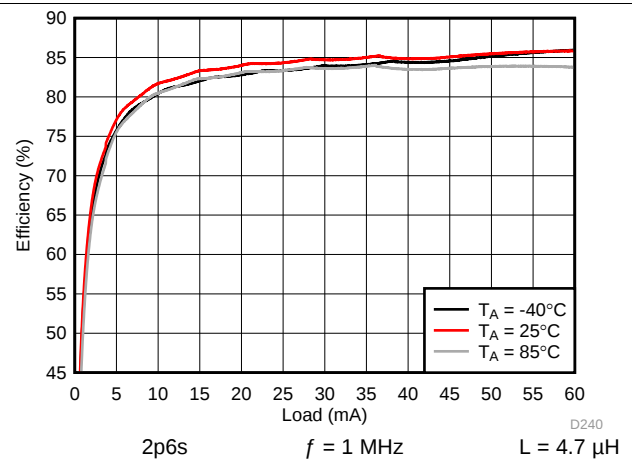


图 108. Backlight System Efficiency

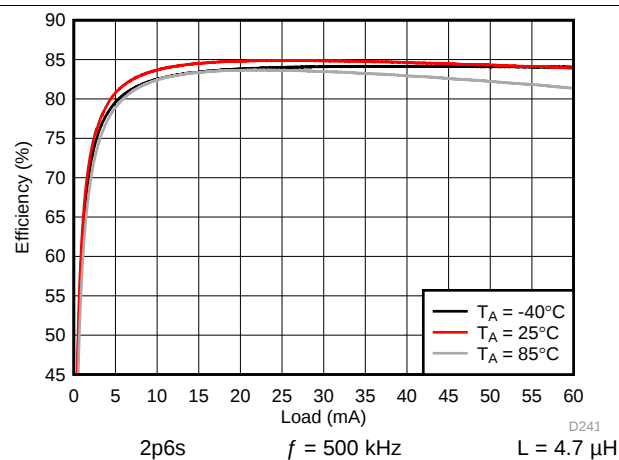


图 109. Backlight Boost Efficiency

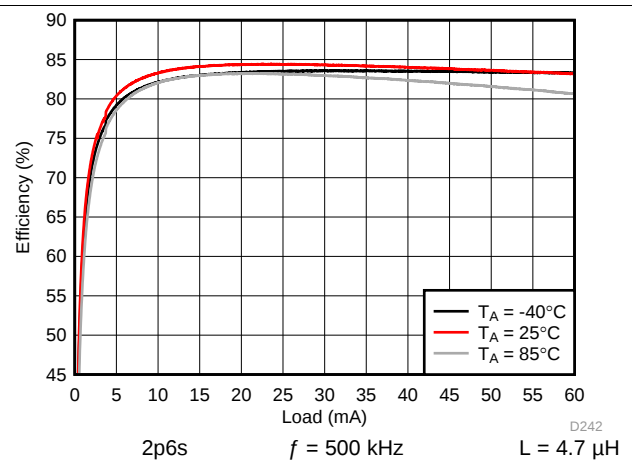


图 110. Backlight System Efficiency

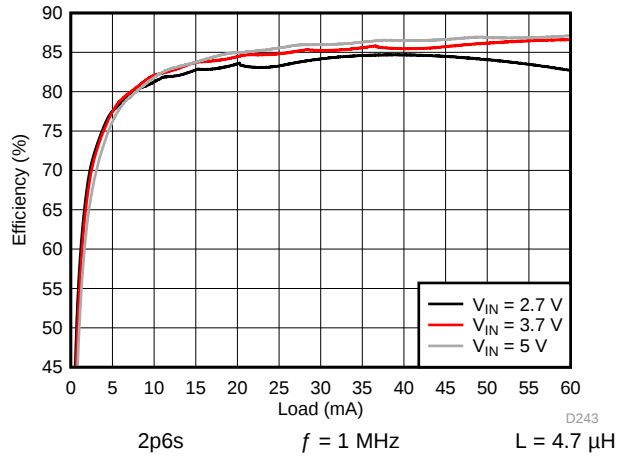


图 111. Backlight Boost Efficiency

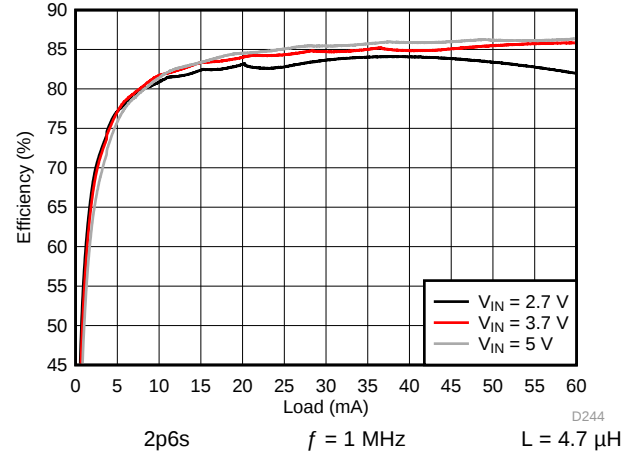


图 112. Backlight System Efficiency

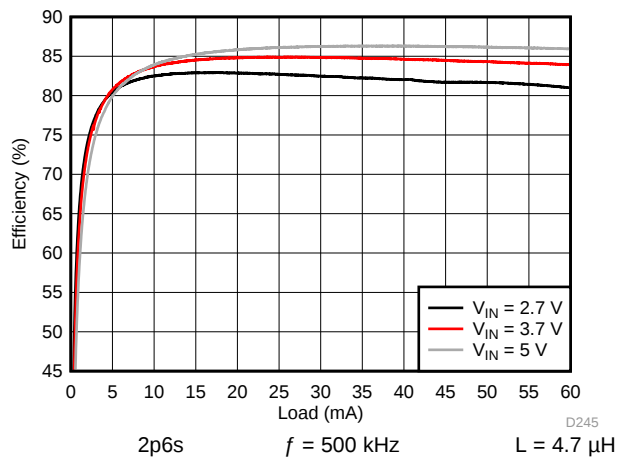


图 113. Backlight Boost Efficiency

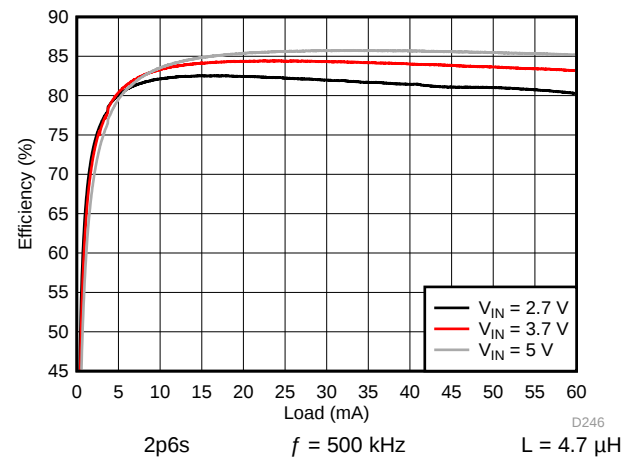


图 114. Backlight System Efficiency

### 8.2.3.2 LCM Bias Curves

Ambient temperature is 25°C and  $V_{IN}$  is 3.7 V unless otherwise noted.  $V_{POS}$ ,  $V_{NEG}$  and  $V_{POS}/V_{NEG}$  efficiency is defined as  $POUT / PIN$ , where  $POUT$  is actual power consumed in  $V_{POS}$ ,  $V_{NEG}$  and ( $V_{POS} + V_{NEG}$ ) outputs, respectively. External components are from 表 30.

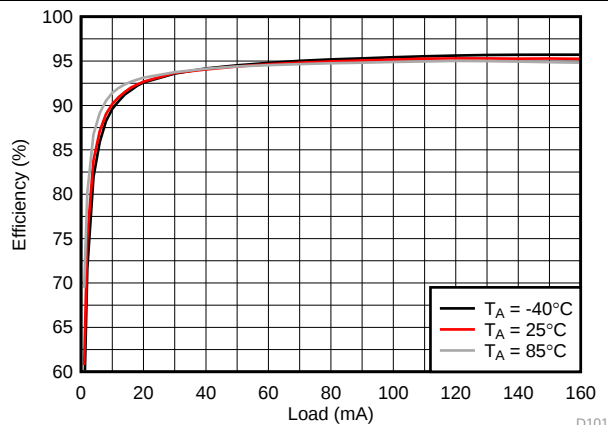


图 115. LCM Boost Efficiency

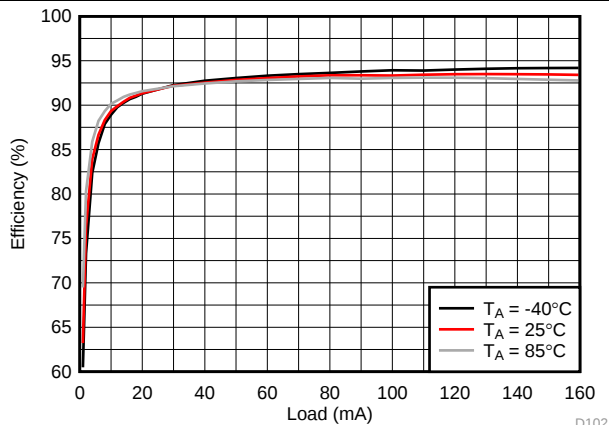


图 116. LCM Boost Efficiency

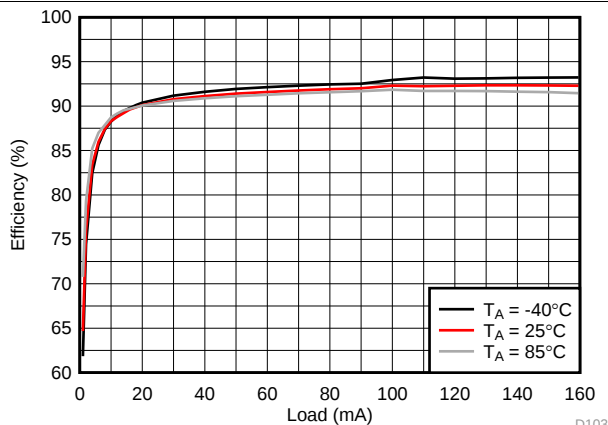


图 117. LCM Boost Efficiency

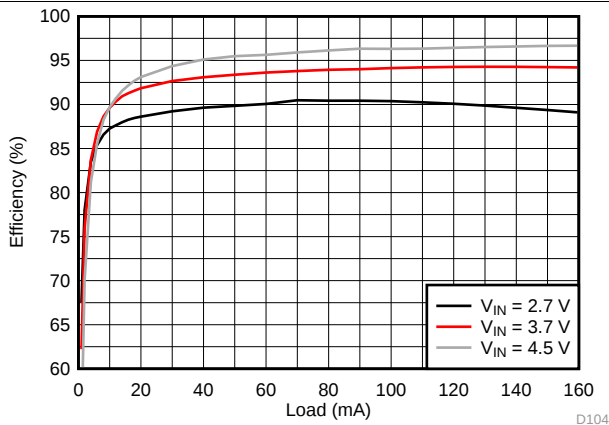


图 118. LCM Boost Efficiency

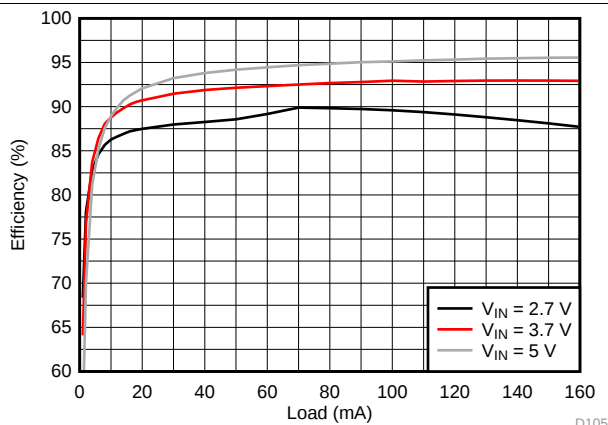


图 119. LCM Boost Efficiency

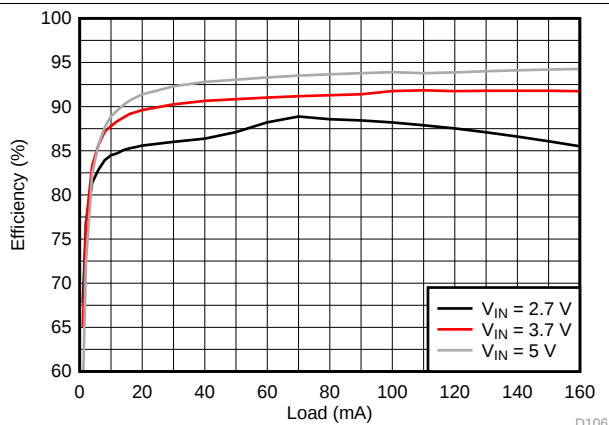


图 120. LCM Boost Efficiency

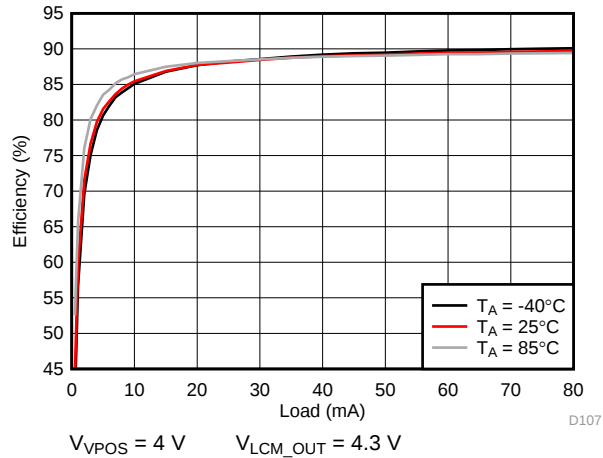


图 121. VPOS Efficiency

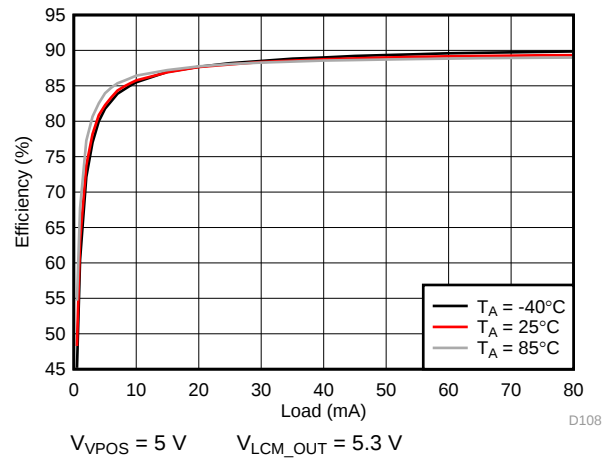


图 122. VPOS Efficiency

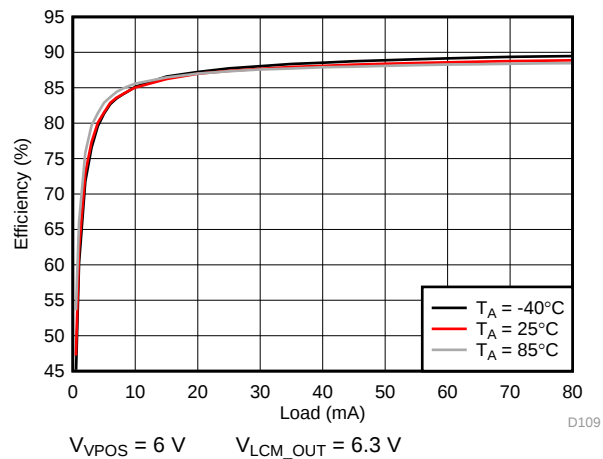


图 123. VPOS Efficiency

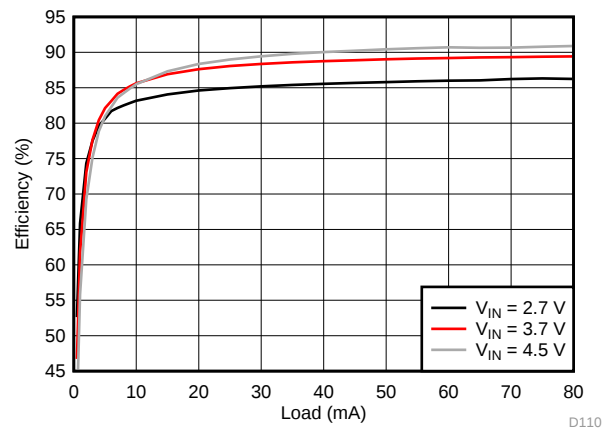


图 124. VPOS Efficiency

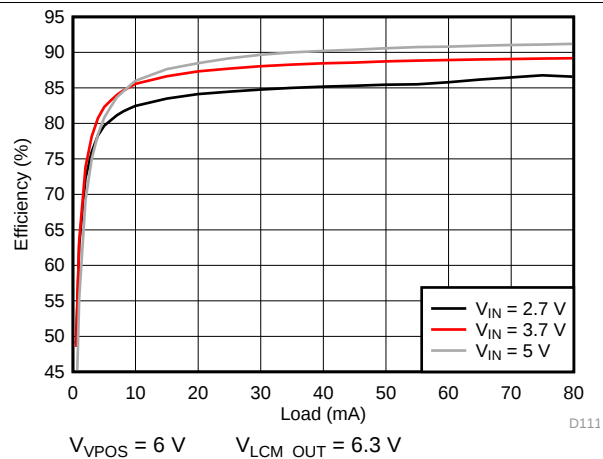


图 125. VPOS Efficiency

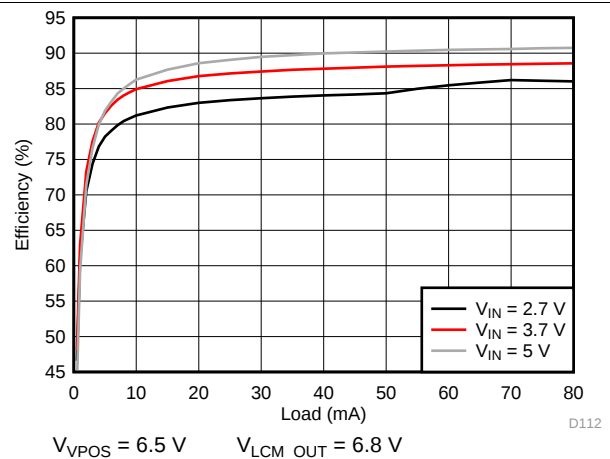


图 126. VPOS Efficiency

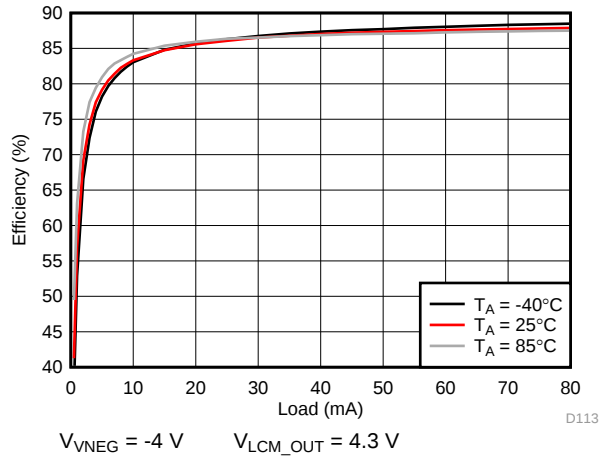


图 127. VNEG Efficiency

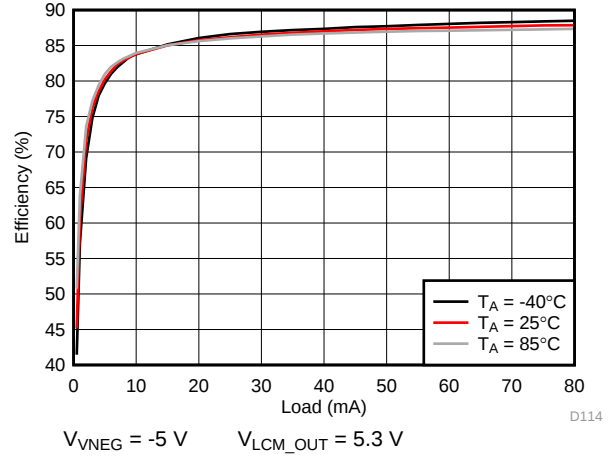


图 128. VNEG Efficiency

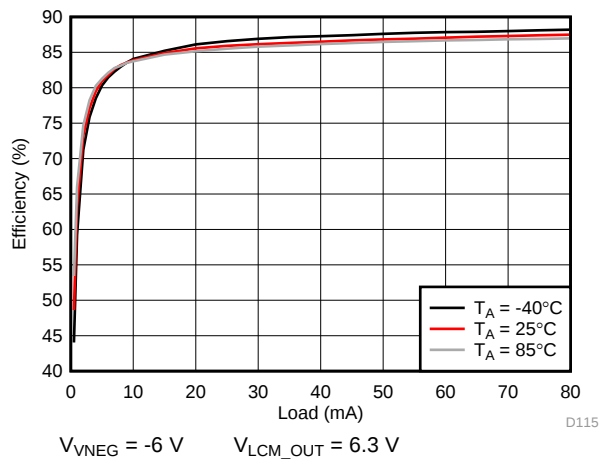


图 129. VNEG Efficiency

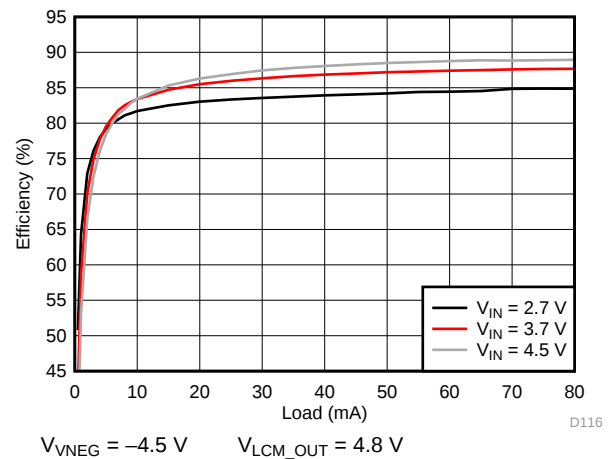


图 130. VNEG Efficiency

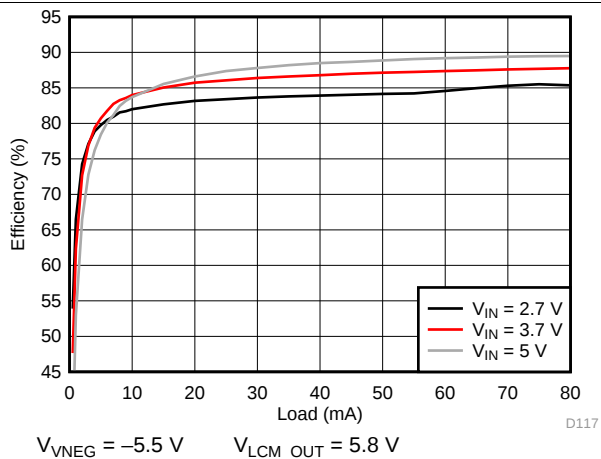


图 131. VNEG Efficiency

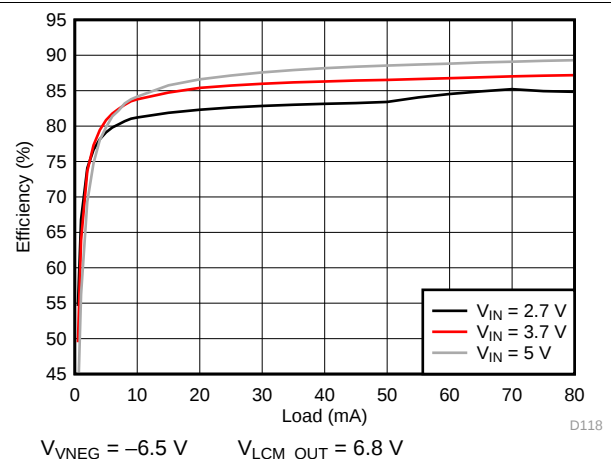


图 132. VNEG Efficiency

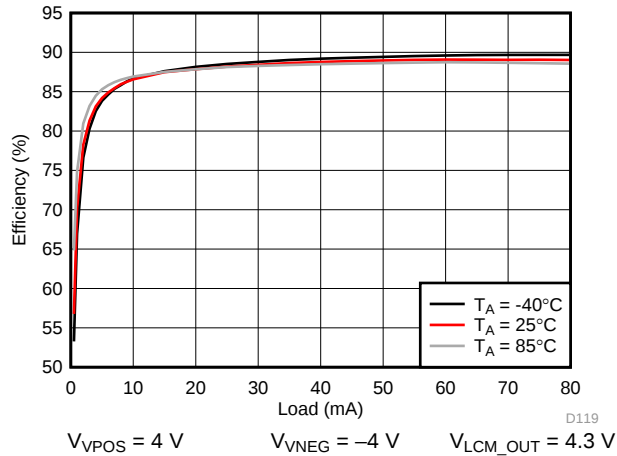


图 133. VPOS/VNEG Efficiency

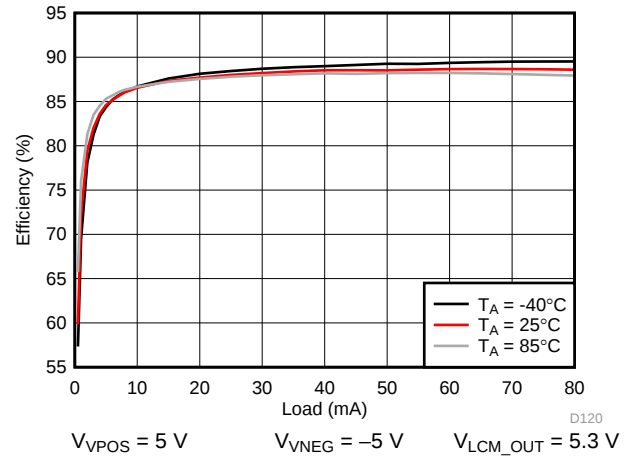


图 134. VPOS/VNEG Efficiency

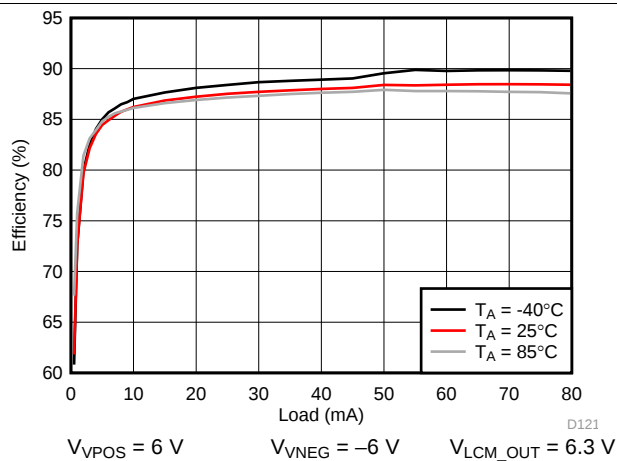


图 135. VPOS/VNEG Efficiency

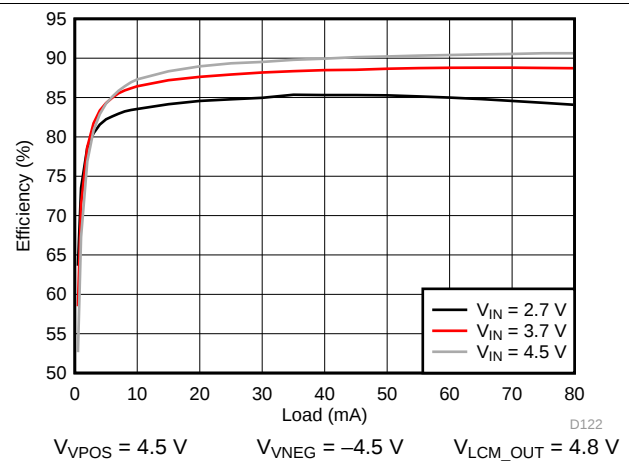


图 136. VPOS/VNEG Efficiency

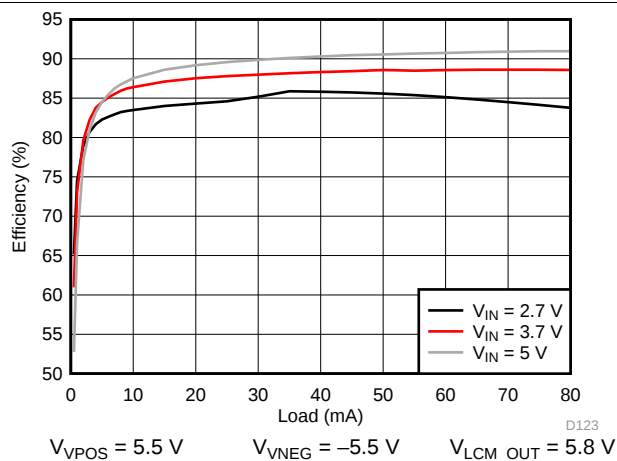


图 137. VPOS/VNEG Efficiency

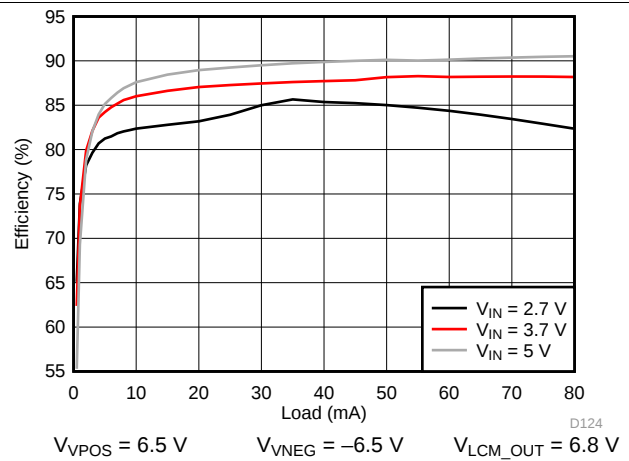


图 138. VPOS/VNEG Efficiency

## 9 Power Supply Recommendations

The LM36272 is designed to operate from an input voltage supply range from 2.7 V to 5 V. This input supply must be well regulated and capable to supply the required input current. If the input supply is located far from the LM36272 additional bulk capacitance may be required in addition to the ceramic bypass capacitors.

## 10 Layout

### 10.1 Layout Guidelines

- Place the boost converter output capacitors as close to the output voltage and GND pins as possible.
- Minimize the boost converter switching loops by placing the input capacitors and inductors close to GND and switch pins.
- If possible, route the switching loops on top layer only. For best efficiency, try to minimize copper on the switch node to minimize switch pin parasitic capacitance while preserving adequate routing width.
- VIN input voltage pin must be bypassed to ground with a low-ESR bypass capacitor. Place the capacitor as close as possible to VIN pin.
- Place the output capacitor of the LDO as close to the output pins as possible. Also place the charge pump flying capacitor and output capacitor close to their respective pins.
- Route the internal pins on the second layer. Use offset micro vias to go from top layer to mid-layer<sup>1</sup>. Avoid routing the signal traces directly under the switching loops of the boost converters.

## 10.2 Layout Example

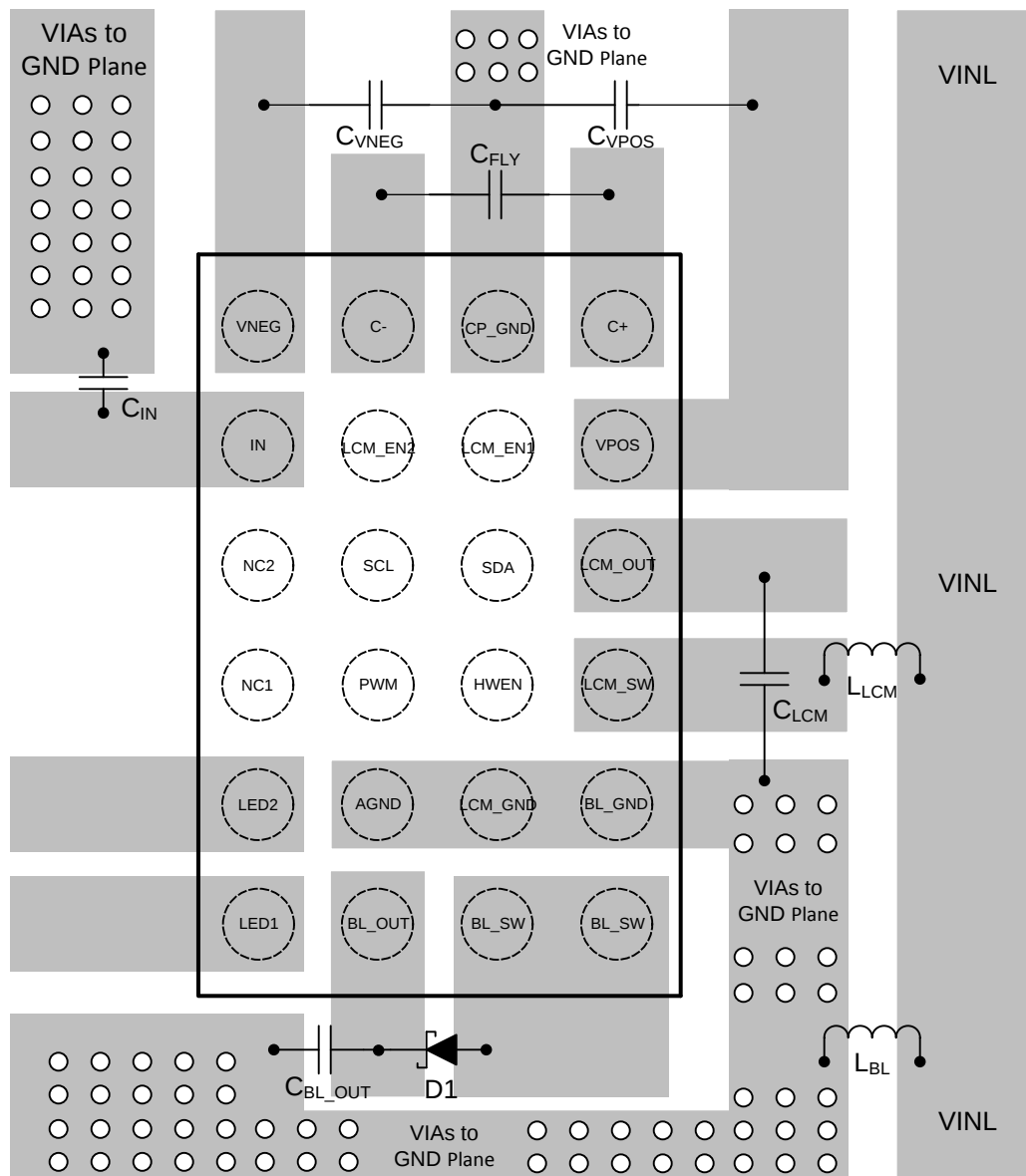


图 139. LM36272 Layout Example

## 11 器件和文档支持

### 11.1 器件支持

#### 11.1.1 第三方产品免责声明

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#### 11.1.2 开发支持

Power Stage Designer™ 工具可用于升压计算：<http://www.ti.com.cn/tool/cn/powerstage-designer>

### 11.2 文档支持

#### 11.2.1 相关文档

如需相关文档，请参阅：

- [《AN-1112 DSBGA 晶圆级芯片级封装》](#)
- [《了解开关模式电源中的升压功率级》](#)

### 11.3 接收文档更新通知

要接收文档更新通知，请导航至 TI.com 上的器件产品文件夹。请单击右上角的提醒我 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

### 11.4 社区资源

下列链接提供到 TI 社区资源的连接。链接的内容由各个分销商“按照原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的 [《使用条款》](#)。

**TI E2E™ 在线社区** **TI 的工程师对工程师 (E2E) 社区。**此社区的创建目的在于促进工程师之间的协作。在 e2e.ti.com 中，您可以咨询问题、分享知识、拓展思路并与同行工程师一道帮助解决问题。

**设计支持** **TI 参考设计支持** 可帮助您快速查找有帮助的 E2E 论坛、设计支持工具以及技术支持的联系信息。

### 11.5 商标

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 11.6 静电放电警告



ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 11.7 Glossary

**SLYZ022** — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。数据如有变更，恕不另行通知，也不会对此文档进行修订。如欲获取此数据表的浏览器版本，请参阅左侧的导航。

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| LM36272YFFR      | ACTIVE        | DSBGA        | YFF                | 24   | 3000           | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 85    | LM36272                 | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

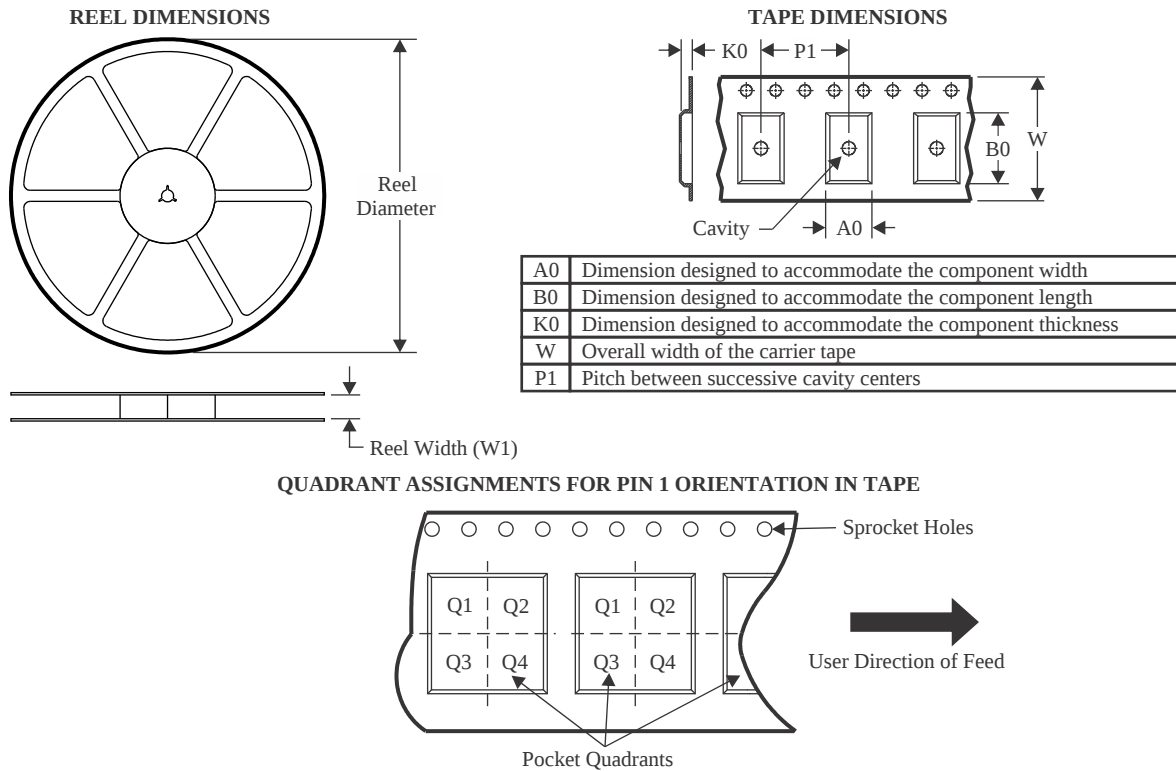
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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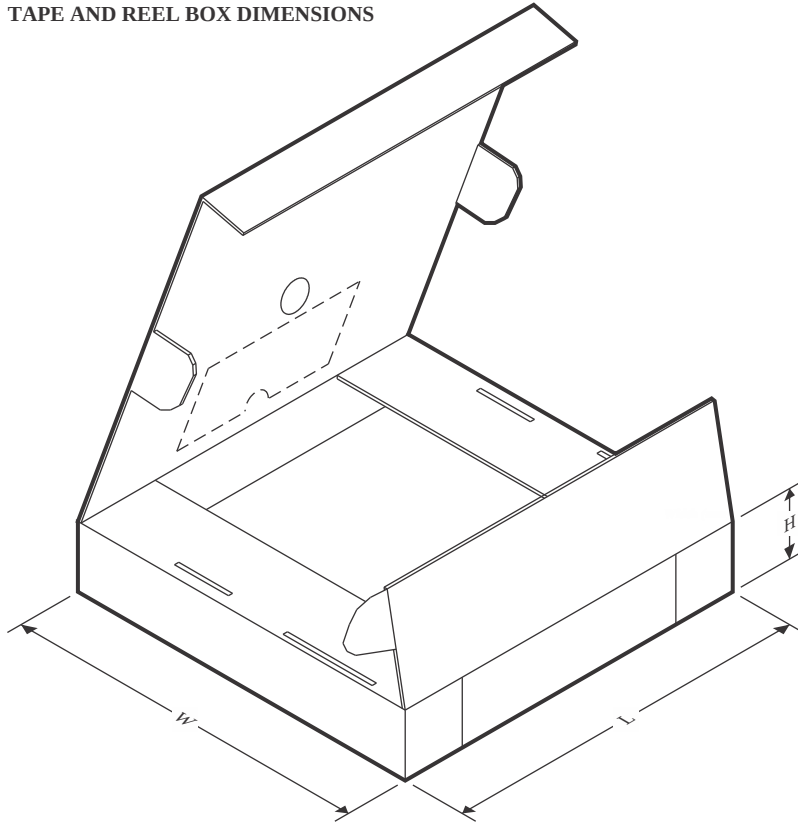
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM36272YFFR | DSBGA        | YFF             | 24   | 3000 | 180.0              | 8.4                | 1.72    | 2.51    | 0.69    | 4.0     | 8.0    | Q1            |
| LM36272YFFR | DSBGA        | YFF             | 24   | 3000 | 180.0              | 8.4                | 1.82    | 2.74    | 0.75    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS

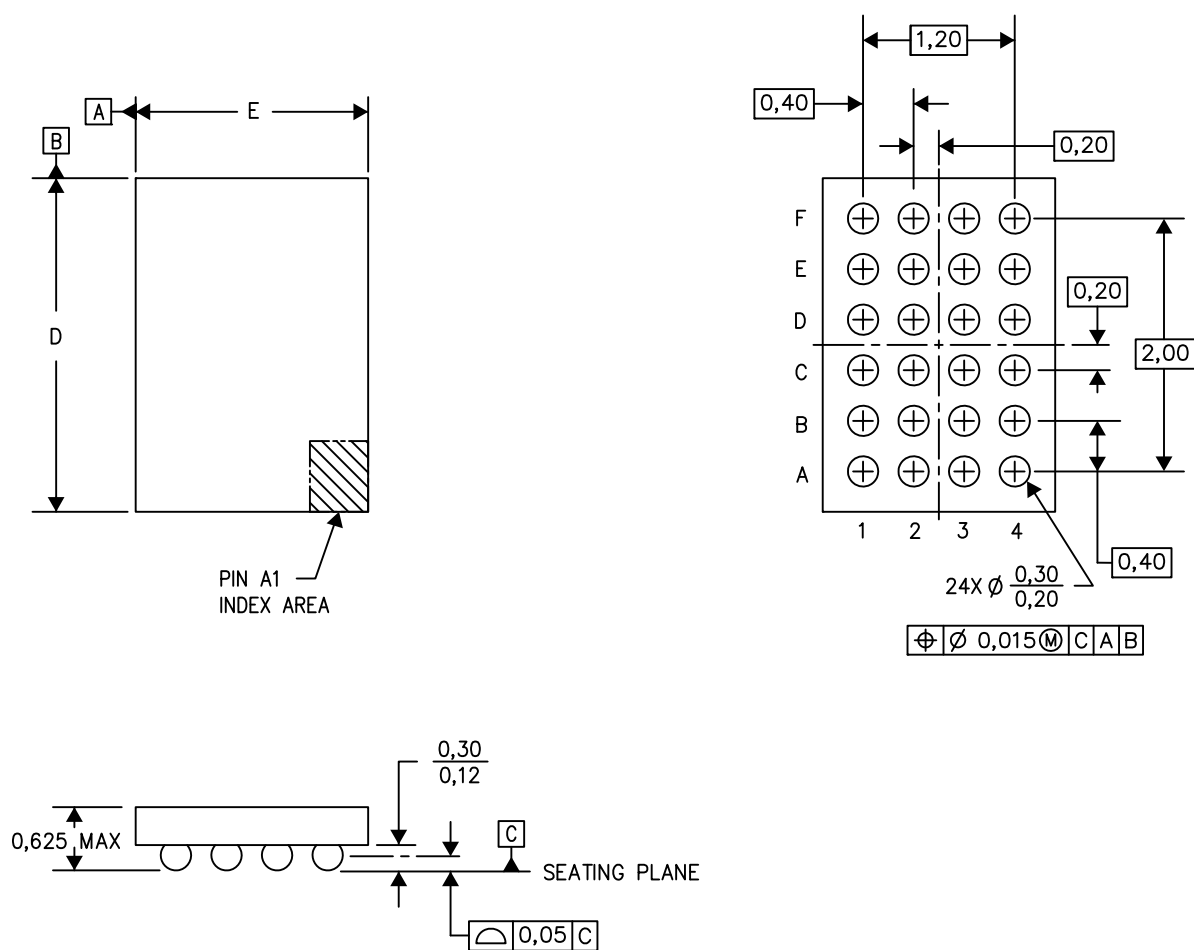


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM36272YFFR | DSBGA        | YFF             | 24   | 3000 | 182.0       | 182.0      | 20.0        |
| LM36272YFFR | DSBGA        | YFF             | 24   | 3000 | 182.0       | 182.0      | 20.0        |

YFF (R-XBGA-N24)

# DIE-SIZE BALL GRID ARRAY



D: Max = 2.44 mm, Min = 2.38 mm

E: Max = 1.671 mm, Min = 1.61 mm

4207625-29/AO 12/13

- NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.  
C. NanoFree™ package configuration.

## 重要声明和免责声明

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